## 32-MHz, 32-bit RX MCUs with up to 256-KB flash memory, 2 low-noise and low-drift 24-bit delta-sigma A/D converters, rail-to-rail programmable gain instrumentation amplifiers, a low-drift voltage reference, and on-chip excitation current sources

## Features

- 32-bit RXv2 CPU core
- Max. operating frequency: 32 MHz Capable of 64 DMIPS in operation at 32 MHz
- Enhanced DSP: 32-bit multiply-accumulate and 16-bit multiplysubtract instructions supported
- Built-in FPU: 32-bit single-precision floating point (compliant to IEEE754)
- Divider (fastest instruction execution takes two CPU clock cycles)
- Fast interrupt
- CISC Harvard architecture with 5-stage pipeline
- Variable-length instructions, ultra-compact code
- On-chip debugging circuit
- Memory protection unit (MPU) supported
- Low power design and architecture
- Operation from a single $1.8-\mathrm{V}$ to $5.5-\mathrm{V}$ supply
- Three low power consumption modes
- Low power timer (LPT) that operates during the software standby state


## - On-chip flash memory for code

- Read cycle of 31.25 ns in $32-\mathrm{MHz}$ operation
- No waiting time when the CPU is reading at full speed
- 128 -Kbyte to 256 -Kbyte capacities
- On-board or off-board user programming
- Programmable at 1.8 V
- For instructions and operands
- On-chip data flash memory
- 8 Kbytes (1,000,000 program/erase cycles (typ.))
- BGO (Background Operation)
- On-chip SRAM, no wait states
- 16- to 32-Kbyte size capacities
- Data transfer functions
- DMAC: Incorporates four channels
- DTC: Four transfer modes
- ELC
- Module operation can be initiated by event signals without using interrupts.
- Linked operation between modules is possible while the CPU is sleeping.
- Reset and supply management
- Seven types of reset, including the power-on reset (POR)
- Low voltage detection (LVD) with voltage settings

■ Clock functions

- Main clock oscillator frequency: 1 MHz to 20 MHz
- External clock input frequency: Up to 20 MHz
- PLL circuit input: 4 MHz to 8 MHz
- On-chip low- and high-speed oscillators, dedicated on-chip low-speed oscillator for the IWDT
- Clock frequency accuracy measurement circuit (CAC)
- Independent watchdog timer
- $15-\mathrm{kHz}$ on-chip oscillator produces a dedicated clock signal to drive IWDT operation.
- Useful functions for IEC60730 compliance
- Self-diagnostic and disconnect detection assistance functions for the A/ D converter, clock frequency accuracy measurement circuit, independent watchdog timer, RAM test assistance functions using the DOC, etc.


## - MPC

- Input/output functions selectable from multiple pins

■ Up to eight communication functions

- CAN (one channel) compliant to ISO11898-1: Transfer at up to 1 Mbps
- SCI with many useful functions (up to four channels), asynchronous mode, clock synchronous mode, smart card interface, reduction of errors in communications using the bit rate modulation function
- $\mathrm{I}^{2} \mathrm{C}$ bus interface: Transfer at up to 400 kbps , capable of SMBus operation (one channel)
- RSPI (one channel): Transfer at up to 16 Mbps


PLQP0048KB-B $\quad 7 \times 7 \mathrm{~mm}, 0.5 \mathrm{~mm}$ pitch


PWQN0040KC-A $6 \times 6 \mathrm{~mm}, 0.5 \mathrm{~mm}$ pitch

- Up to 12 extended-function timers
- 16-bit MTU: input capture, output compare, complementary PWM output, phase counting mode (six channels)
- 8-bit TMR (four channels)
- 16-bit compare-match timers (two channels)


## - Analog functions

- Two 24-bit delta-sigma A/D converters
- A/D converter with up to 23-bit effective resolution (gain = 1, output data rate = 7.6 SPS)
- High-precision programmable gain instrumentation amplifier, $30 \mathrm{nV}_{\text {RMS }}$ (gain $=128$, output data rate $=7.6$ SPS)
- Rail-to-rail programmable gain instrumentation amplifier (gain = 1 to 128)
- Two operating modes and programmable data rates, Normal mode: Output data rate of 7.6 SPS to 15625 SPS, Low power mode: Output data rate of 1.9 SPS to 3906 SPS
- Offset drift $10 \mathrm{nV} /{ }^{\circ} \mathrm{C}$ (gain = 128)
- Gain drift $1 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$ (gain = 1 (PGA), gain = 2 to 128 )
- Up to six differential inputs, 11 single-ended inputs
- Fourth-order sinc filter
- Simultaneous $50 \mathrm{~Hz} / 60 \mathrm{~Hz}$ rejection (output data rate $=10,54 \mathrm{SPS}$ )
- Offset error and gain error calibration
- Inter-unit A/D conversion synchronized start
- Delta-sigma A/D input disconnect detection assist
- Delta-sigma A/D reference voltage external input
- Voltage reference
output voltage: $2.5 \mathrm{~V} \pm 0.1 \%$,
temperature drift: $4 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$, output current: $\pm 10 \mathrm{~mA}$
- Excitation current sources: Up to four,

Output current: $50 \mu \mathrm{~A}$ to $1000 \mu \mathrm{~A}$, current matching: $\pm 0.2 \%$, drift matching: $5 \mathrm{ppm} /{ }^{\circ} \mathrm{C}$

- Bias voltage generator
output voltage: (AVCC0 + AVSS0)/2
- Temperature sensor: Accuracy $\pm 5^{\circ} \mathrm{C}$
- Low-side switch: $10 \Omega$ on-resistance
- Low power-supply-voltage detectors
- Delta-sigma A/D input voltage fault detectors
- Delta-sigma A/D reference voltage fault detectors and disconnect detectors
- Excitation current source disconnect detectors
- 12-bit A/D converter
- Capable of conversion within $1.4 \mu \mathrm{~s}$
- Six channels
- Sampling time can be set for each channel
- Self-diagnostic function and analog input disconnect detection assistance function
- General I/O ports
- 5-V tolerant, open drain, input pull-up, switching of driving capacity
- Operating temperature range
- $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
- $-40^{\circ} \mathrm{C}$ to $+105^{\circ} \mathrm{C}$


## - Applications

- General industrial and consumer equipment


## 1. Overview

### 1.1 Outline of Specifications

Table 1.1 lists the specifications, and Table 1.2 gives a comparison of the functions of the products in different packages.
Table 1.1 is for products with the greatest number of functions, so the number of peripheral modules and channels will differ in accordance with the package type. For details, see Table 1.2, Comparison of Functions for Different Packages.

Table 1.1 Outline of Specifications (1/4)

| Classification | Module/Function | Description |
| :---: | :---: | :---: |
| CPU | CPU | - Maximum operating frequency: 32 MHz <br> - 32-bit RX CPU (RX v2) <br> - Minimum instruction execution time: One instruction per clock cycle <br> - Address space: 4-Gbyte linear <br> - Register set General purpose: Sixteen 32-bit registers <br> Control: Ten 32-bit registers <br> Accumulator: Two 72-bit registers <br> - Basic instructions: 75 (variable-length instruction format) <br> - Floating-point instructions: 11 <br> - DSP instructions: 23 <br> - Addressing modes: 10 <br> - Data arrangement Instructions: Little endian <br> Data: Selectable as little endian or big endian <br> - On-chip 32-bit multiplier: 32-bit $\times 32$-bit $\rightarrow 64$-bit <br> - On-chip divider: 32-bit $\div 32$-bit $\rightarrow 32$ bits <br> - Barrel shifter: 32 bits <br> - Memory protection unit (MPU) |
|  | FPU | - Single precision (32-bit) floating point <br> - Data types and exceptions in conformance with the IEEE754 standard |
| Memory | ROM | - Capacity: 128/256 Kbytes <br> - 32 MHz : No-wait access <br> - Programming/erasing method: Serial programming (asynchronous serial communication), self-programming |
|  | RAM | - Capacity: $16 / 32$ Kbytes <br> - 32 MHz , no-wait memory access |
|  | E2 DataFlash | - Capacity: 8 Kbytes <br> - Number of erase/write cycles: 1,000,000 (typ) |
| MCU operating mode |  | Single-chip mode |
| Clock | Clock generation circuit | - Main clock oscillator, low-speed on-chip oscillator, high-speed on-chip oscillator, PLL frequency synthesizer, and IWDT-dedicated on-chip oscillator <br> - Oscillation stop detection: Available <br> - Clock frequency accuracy measurement circuit (CAC) <br> - Independent settings for the system clock (ICLK), peripheral module clock (PCLK), and FlashIF clock (FCLK) <br> The CPU and system sections such as other bus masters run in synchronization with the system clock (ICLK): 32 MHz (at max.) <br> MTU2a runs in synchronization with the PCLKA: 32 MHz (at max.) <br> The ADCLK for the S12AD runs in synchronization with the PCLKD: 32 MHz (at max.) Peripheral modules other than MTU2a and S12AD run in synchronization with the PCLKB: 32 MHz (at max.) <br> The flash peripheral circuit runs in synchronization with the FCLK: 32 MHz (at max.) |
| Resets |  | RES\# pin reset, power-on reset, voltage monitoring reset, independent watchdog timer reset, and software reset |
| Voltage detection | Voltage detection circuit (LVDAb) | - When the voltage on VCC falls below the voltage detection level, an internal reset or internal interrupt is generated. <br> Voltage detection circuit 0 is capable of selecting the detection voltage from 4 levels Voltage detection circuit 1 is capable of selecting the detection voltage from 14 levels Voltage detection circuit 2 is capable of selecting the detection voltage from 4 levels |

Table 1.1 Outline of Specifications (2/4)

| Classification | Module/Function | Description |
| :---: | :---: | :---: |
| Low power consumption | Low power consumption functions | - Module stop function <br> - Three low power consumption modes Sleep mode, deep sleep mode, and software standby mode <br> - Low power timer that operates during the software standby state |
|  | Function for lower operating power consumption | - Operating power control modes <br> High-speed operating mode and middle-speed operating mode |
| Interrupt | Interrupt controller (ICUb) | - Interrupt vectors: 256 <br> - External interrupts: 9 (NMI, IRQ0 to IRQ7 pins) <br> - Non-maskable interrupts: 5 (NMI pin, oscillation stop detection interrupt, voltage monitoring 1 interrupt, voltage monitoring 2 interrupt, and IWDT interrupt) <br> - 16 levels specifiable for the order of priority |
| DMA | DMA controller (DMACA) | - 4 channels <br> - Three transfer modes: Normal transfer, repeat transfer, and block transfer <br> - Activation sources: Software trigger, external interrupts, and interrupt requests from peripheral functions |
|  | Data transfer controller (DTCa) | - Transfer modes: Normal transfer, repeat transfer, and block transfer <br> - Activation sources: Interrupts <br> - Chain transfer function |
| I/O ports | General I/O ports | 48-pin/40-pin <br> I/O: 20/16 <br> - Input: 1/1 <br> Pull-up resistors: 20/16 <br> - Open-drain outputs: 20/16 <br> - 5-V tolerance: 2/2 |
| Event link controller (ELC) |  | - Event signals of 56 types can be directly connected to the module <br> - Operations of timer modules are selectable at event input <br> - Capable of event link operation for port B |
| Multi-function pin controller (MPC) |  | Capable of selecting the input/output function from multiple pins |
| Timers | Multi-function timer pulse unit 2 (MTU2a) | - (16 bits $\times 6$ channels $) \times 1$ unit <br> - Up to 16 pulse-input/output lines and three pulse-input lines are available based on the six 16-bit timer channels <br> - Select from among eight or seven counter-input clock signals for each channel (PCLK/1, PCLK/4, PCLK/16, PCLK/64, PCLK/256, PCLK/1024, MTCLKA, MTCLKB, MTCLKC, MTCLKD) other than channel 5 , for which only four signals are available. <br> - Input capture function <br> - 21 output compare/input capture registers <br> - Pulse output mode PWM/complementary PWM/reset synchronous PWM <br> - Phase-counting mode <br> - Capable of generating conversion start triggers for the A/D converter |
|  | Port output enable 2 (POE2a) | Controls the high-impedance state of the MTU's waveform output pins |
|  | Compare match timer (CMT) | - (16 bits $\times 2$ channels) $\times 1$ unit <br> - Select from among four clock signals (PCLK/8, PCLK/32, PCLK/128, PCLK/512) |
|  | Independent watchdog timer (IWDTa) | - 14 bits $\times 1$ channel <br> - Count clock: Dedicated low-speed on-chip oscillator for the IWDT Frequency divided by $1,16,32,64,128$, or 256 |
|  | Low power timer (LPT) | - 16 bits $\times 1$ channel <br> - Clock source: Dedicated low-speed on-chip oscillator for the IWDT Frequency divided by $2,4,8,16$, or 32 |
|  | 8-bit timer (TMR) | - (8 bits $\times 2$ channels) $\times 2$ units <br> - Seven internal clocks (PCLK/1, PCLK/2, PCLK/8, PCLK/32, PCLK/64, PCLK/1024, and PCLK/8192) and an external clock can be selected <br> - Pulse output and PWM output with any duty cycle are available <br> - Two channels can be cascaded and used as a 16-bit timer |

Table 1.1 Outline of Specifications (3/4)

| Classification | Module/Function | Description |
| :---: | :---: | :---: |
| Communication functions | Serial communications interfaces (SCIg, SClh) | - 4 channels (channel 1, 5, 6: SCIg, channel 12: SCIh) <br> - SClg <br> Serial communications modes: Asynchronous, clock synchronous, and smart-card interface <br> Multi-processor function <br> On-chip baud rate generator allows selection of the desired bit rate <br> Choice of LSB-first or MSB-first transfer <br> Average transfer rate clock can be input from TMR timers for SCI5, SCl6, and SCl12 <br> Start-bit detection: Level or edge detection is selectable. <br> Simple $I^{2} \mathrm{C}$ <br> Simple SPI <br> 9-bit transfer mode <br> Bit rate modulation <br> Event linking by the ELC (only on channel 5) <br> - SCIh (The following functions are added to SCIg) <br> Supports the serial communications protocol, which contains the start frame and information frame <br> Supports the LIN format |
|  | ${ }^{2}{ }^{2} \mathrm{C}$ bus interface (RIICa) | - 1 channel <br> - Communications formats: $\mathrm{I}^{2} \mathrm{C}$ bus format/SMBus format <br> - Master mode or slave mode selectable <br> - Supports fast mode |
|  | Serial peripheral interface (RSPIb) | - 1 channel <br> - Transfer facility Using the MOSI (master out, slave in), MISO (master in, slave out), SSL (slave select), and RSPCK (RSPI clock) enables serial transfer through SPI operation (four lines) or clock-synchronous operation (three lines) <br> - Capable of handling serial transfer as a master or slave <br> - Data formats <br> - Choice of LSB-first or MSB-first transfer The number of bits in each transfer can be changed to $8,9,10,11,12,13,14,15,16,20$, 24 , or 32 bits. <br> 128-bit buffers for transmission and reception <br> Up to four frames can be transmitted or received in a single transfer operation (with each frame having up to 32 bits) <br> - Double buffers for both transmission and reception |
|  | CAN module (RSCAN) | - 1 channel <br> - Compliance with the ISO11898-1 specification (standard frame and extended frame) <br> - 16 Message boxes |
| 24-bit delta-sigma A/D converter (DSAD) |  | - 24 bits ( 6 channels $\times 2$ units) <br> - Type of A/D conversion: delta-sigma <br> - Post filter: Fourth-order sinc filter <br> - 24-bit resolution <br> - Input types: Differential, pseudo-differential, or single-ended <br> - Operating modes Normal mode/low-power mode <br> - Modulator clock: 500 kHz (typ.; 125 kHz in low-power mode) <br> - Oversampling ratio: 32 to 65536 (only multiples of 16) <br> - Includes a programmable gain instrumentation amplifier (PGA) Gain settings: $\times 1, \times 2, \times 4, \times 8, \times 16, \times 32, \times 64, \times 128$ PGA bypass function: with or without an analog input buffer <br> - Configuration settings per channel <br> - Conditions for starting A/D conversion: software trigger or ELC <br> - Disconnect detection assist <br> - Selectable reference voltage |

Table 1.1 Outline of Specifications (4/4)

| Classification Module/Function | Description |
| :---: | :---: |
| Analog front end (AFE) | - Voltage reference (VREF) <br> Output voltage: 2.5 V <br> - Output from bias voltage source (VBIAS) <br> Output voltage: (AVCC0 + AVSSO)/2 <br> - Internal temperature sensor (TEMPS) <br> - Excitation current sources (IEXC) <br> Two channels (up to $1000 \mu \mathrm{~A}$ ) or four channels (up to $500 \mu \mathrm{~A}$ ) <br> Output current settings: $50 \mu \mathrm{~A}, 100 \mu \mathrm{~A}, 250 \mu \mathrm{~A}, 500 \mu \mathrm{~A}, 750 \mu \mathrm{~A}, 1000 \mu \mathrm{~A}$ <br> - Analog multiplexer (AMUX) <br> Select from among external pins, bias voltage sources, internal temperature sensor, or excitation current sources <br> - Low-side switch (LSW) <br> On-resistance: $10 \Omega$ (max.) <br> Allowable current: 30 mA (max.) <br> - Voltage detector (VDET) <br> Voltage monitoring of AVCC0 <br> Detection of abnormal voltages at analog inputs <br> Detection of abnormal reference voltages and assistance in detecting disconnection Assistance in detecting disconnection for excitation current source output |
| 12-bit A/D converter (S12ADE) | - 12 bits ( 6 channels $\times 1$ unit) <br> - 12-bit resolution <br> - Minimum conversion time: $1.4 \mu \mathrm{~s}$ per channel when the ADCLK is operating at 32 MHz <br> - Operating modes <br> Scan mode (single scan mode, continuous scan mode, and group scan mode) <br> Group A priority control (only for group scan mode) <br> - Sampling variable <br> Sampling time can be set up for each channel. <br> - Self-diagnostic function <br> - Double trigger mode (A/D conversion data duplicated) <br> - Detection of analog input disconnection <br> - A/D conversion start conditions <br> A software trigger, a trigger from a timer (MTU), an external trigger signal, or ELC <br> - Event linking by the ELC |
| CRC calculator (CRC) | - CRC code generation for arbitrary amounts of data in 8-bit units <br> - Select any of three generating polynomials: $x^{8}+x^{2}+x+1, x^{16}+x^{15}+x^{2}+1, \text { or } X^{16}+x^{12}+x^{5}+1$ <br> - Generation of CRC codes for use with LSB-first or MSB-first communications is selectable. |
| Data operation circuit (DOC) | Comparison, addition, and subtraction of 16-bit data |
| Power supply voltages/Operating frequencies | $\mathrm{VCC}=1.8$ to $2.4 \mathrm{~V}: 8 \mathrm{MHz}, \mathrm{VCC}=2.4$ to $2.7 \mathrm{~V}: 16 \mathrm{MHz}, \mathrm{VCC}=2.7$ to $5.5 \mathrm{~V}: 32 \mathrm{MHz}$ $\mathrm{AVCCO}=2.7$ to 5.5 V (1.8 to 5.5 V when only S12AD is operating) |
| Operating temperature range | D version: -40 to $+85^{\circ} \mathrm{C}, \mathrm{G}$ version: -40 to $+105^{\circ} \mathrm{C}$ |
| Packages | 48-pin LFQFP (PLQP0048KB-B) $7 \times 7 \mathrm{~mm}, 0.5 \mathrm{~mm}$ pitch 40-pin HWQFN (PWQN0040KC-A) $6 \times 6 \mathrm{~mm}, 0.5 \mathrm{~mm}$ pitch |
| Debugging interface | One-wire type FINE interface |

Table 1.2 Comparison of Functions for Different Packages

| Module/Functions |  | RX23E-A Group |  |
| :---: | :---: | :---: | :---: |
|  |  | 48 Pins | 40 Pins |
| Interrupts | External interrupts | NMI, IRQ0 to IRQ7 |  |
| DMA | DMA controller | 4 channels (DMAC0 to DMAC3) |  |
|  | Data transfer controller | Available |  |
| Timers | Multi-function timer pulse unit 2 | 6 channels (MTU0 to MTU5) |  |
|  | Port output enable 2 | POE0\# to POE3\#, POE8\# |  |
|  | 8-bit timer | 2 channels $\times 2$ units |  |
|  | Compare match timer | 2 channels $\times 1$ unit |  |
|  | Low power timer | 1 channel |  |
|  | Independent watchdog timer | Available |  |
| Communication functions | Serial communications interfaces (SCIg) | 3 channels (SCI1, 5, 6) | 2 channels (SCl1, 5) |
|  | Serial communications interfaces (SCIh) | 1 channel (SCI12) |  |
|  | ${ }^{2} \mathrm{C}$ bus interface | 1 channel |  |
|  | CAN module | 1 channel |  |
|  | Serial peripheral interface | 1 channel |  |
| 24-bit delta-sigma A/D converter |  | 6 channels $\times 2$ units |  |
| Analog front end | Voltage reference | Available |  |
|  | Excitation current sources | Available |  |
|  | Analog multiplexer | Available |  |
|  | Temperature sensor | Available |  |
|  | Voltage detector | Available |  |
| 12-bit A/D converter (including high-precision channels) |  | 6 channels (6 channels) | 4 channels (4 channels) |
| CRC calculator |  | Available |  |
| Event link controller |  | Available |  |
| Packages |  | 48-pin LFQFP | 40-pin HWQFN |

### 1.2 List of Products

Table 1.3 is a list of products, and Figure 1.1 shows how to read the product part no., memory capacity, and package type.

Table $1.3 \quad$ List of Products


Figure 1.1 How to Read the Product Part Number

### 1.3 Block Diagram

Figure 1.2 shows a block diagram.


| ICUb: | Interrupt controller | MTU2a: | Multi-function timer pulse unit 2 |
| :--- | :--- | :--- | :--- |
| DTCa: | Data transfer controller | POE2a: | Port output enable 2 |
| DMACA: | DMA controller | CMT: | Compare match timer |
| IWDTa: | Independent watchdog timer | DOC: | Data operation circuit |
| ELC: | Event link controller | CAC: | Clock frequency accuracy measurement circuit |
| CRC: | CRC (cyclic redundancy check) calculator | MPU: | Memory protection unit |
| SCIg/SCIh: | Serial communications interface | TMR: | 8-bit timer |
| RSPIb: | Serial peripheral interface | RSCAN: | CAN module |
| RIICa: | I $^{2}$ C bus interface | LPT: | Low power timer |
| LVDAb: | Voltage detection circuit |  |  |

Figure 1.2
Block Diagram

### 1.4 Pin Functions

Table 1.4 lists the pin functions.
Table 1.4 Pin Functions (1/3)

| Classifications | Pin Name | 1/0 | Description |
| :---: | :---: | :---: | :---: |
| Power supply | VCC | Input | Power supply pin. Connect it to the system power supply. |
|  | VCL | - | Connect this pin to the VSS pin via the $4.7 \mu \mathrm{~F}$ smoothing capacitor used to stabilize the internal power supply. Place the capacitor close to the pin. |
|  | VSS | Input | Ground pin. Connect it to the system power supply ( 0 V ). |
| Clock | XTAL | Output | Pins for connecting a crystal. An external clock can be input through the EXTAL pin. |
|  | EXTAL | Input |  |
|  | CLKOUT | Output | Clock output pin. |
| Operating mode control | MD | Input | Pin for setting the operating mode. The signal levels on this pin must not be changed during operation. |
| System control | RES\# | Input | Reset pin. This MCU enters the reset state when this signal goes low. |
| CAC | CACREF | Input | Input pin for the clock frequency accuracy measurement circuit. |
| On-chip emulator | FINED | I/O | FINE interface pin. |
| Interrupts | NMI | Input | Non-maskable interrupt request pin. |
|  | IRQ0 to IRQ7 | Input | Interrupt request pins. |
| Multi-function timer pulse unit 2 | MTIOCOA, MTIOCOB, MTIOCOC, MTIOCOD | I/O | The TGRA0 to TGRD0 input capture input/output compare output/PWM output pins. |
|  | MTIOC1A, MTIOC1B | I/O | The TGRA1 and TGRB1 input capture input/output compare output/PWM output pins. |
|  | MTIOC2A, MTIOC2B | I/O | The TGRA2 and TGRB2 input capture input/output compare output/PWM output pins. |
|  | MTIOC3A, MTIOC3B, MTIOC3C, MTIOC3D | I/O | The TGRA3 to TGRD3 input capture input/output compare output/PWM output pins. |
|  | MTIOC4A, MTIOC4B, MTIOC4C, MTIOC4D | I/O | The TGRA4 to TGRD4 input capture input/output compare output/PWM output pins. |
|  | MTIC5U, MTIC5V, MTIC5W | Input | The TGRU5, TGRV5, and TGRW5 input capture input/external pulse input pins. |
|  | MTCLKA, MTCLKB, MTCLKC, MTCLKD | Input | Input pins for the external clock. |
| Port output enable 2 | POE0\# to POE3\#, POE8\# | Input | Input pins for request signals to place the MTU pins in the high impedance state. |
| 8-bit timer | TMO0 to TMO3 | Output | Compare match output pins. |
|  | TMCIO to TMCI3 | Input | Input pins for the external clock to be input to the counter. |
|  | TMRI0 to TMRI3 | Input | Counter reset input pins. |
| Serial communications interface (SCIg) | - Asynchronous mode/clock synchronous mode |  |  |
|  | SCK1, SCK5, SCK6 | I/O | Input/output pins for the clock. |
|  | RXD1, RXD5, RXD6 | Input | Input pins for received data. |
|  | TXD1, TXD5, TXD6 | Output | Output pins for transmitted data. |
|  | CTS1\#, CTS5\#, CTS6\# | Input | Input pins for controlling the start of transmission and reception. |
|  | RTS1\#, RTS5\#, RTS6\# | Output | Output pins for controlling the start of transmission and reception. |
|  | - Simple R2C mode |  |  |
|  | SSCL1, SSCL5, SSCL6 | I/O | Input/output pins for the $\mathrm{I}^{2} \mathrm{C}$ clock. |
|  | SSDA1, SSDA5, SSDA6 | I/O | Input/output pins for the $\mathrm{I}^{2} \mathrm{C}$ data. |

Table 1.4 Pin Functions (2/3)

| Classifications | Pin Name | I/O | Description |
| :---: | :---: | :---: | :---: |
| Serial communications interface (SCIg) | - Simple SPI mode |  |  |
|  | SCK1, SCK5, SCK6 | I/O | Input/output pins for the clock. |
|  | SMISO1, SMISO5, SMISO6 | I/O | Input/output pins for slave transmit data. |
|  | SMOSI1, SMOSI5, SMOSI6 | I/O | Input/output pins for master transmit data. |
|  | SS1\#, SS5\#, SS6\# | Input | Slave-select input pins. |
| Serial communications interface (SCIh) | - Asynchronous mode/clock synchronous mode |  |  |
|  | SCK12 | I/O | Input/output pin for the clock. |
|  | RXD12 | Input | Input pin for receiving data. |
|  | TXD12 | Output | Output pin for transmitting data. |
|  | CTS12\# | Input | Input pin for controlling the start of transmission and reception. |
|  | RTS12\# | Output | Output pin for controlling the start of transmission and reception. |
|  | - Simple ${ }^{2} \mathrm{C}$ mode |  |  |
|  | SSCL12 | I/O | Input/output pin for the $\mathrm{I}^{2} \mathrm{C}$ clock. |
|  | SSDA12 | I/O | Input/output pin for the ${ }^{2} \mathrm{C}$ data. |
|  | - Simple SPI mode |  |  |
|  | SCK12 | I/O | Input/output pin for the clock. |
|  | SMISO12 | I/O | Input/output pin for slave transmit data. |
|  | SMOSI12 | I/O | Input/output pin for master transmit data. |
|  | SS12\# | Input | Slave-select input pin. |
|  | - Extended serial mode |  |  |
|  | RXDX12 | Input | Input pin for data reception by SCIh. |
|  | TXDX12 | Output | Output pin for data transmission by SClh. |
|  | SIOX12 | I/O | Input/output pin for data reception or transmission by SCIh. |
| ${ }^{2} \mathrm{C}$ c bus interface | SCL | I/O | Input/output pin for $I^{2} \mathrm{C}$ bus interface clocks. Bus can be directly driven by the N -channel open drain output. |
|  | SDA | I/O | Input/output pin for $\mathrm{I}^{2} \mathrm{C}$ bus interface data. Bus can be directly driven by the N -channel open drain output. |
| Serial peripheral interface | RSPCKA | I/O | Input/output pin for the RSPI clock. |
|  | MOSIA | I/O | Input/output pin for transmitting data from the RSPI master. |
|  | MISOA | I/O | Input/output pin for transmitting data from the RSPI slave. |
|  | SSLA0 | I/O | Input/output pin to select the slave for the RSPI. |
|  | SSLA1 to SSLA3 | Output | Output pins to select the slave for the RSPI. |
| CAN module | CRXD0 | Input | Input pin |
|  | CTXD0 | Output | Output pin |
| 12-bit A/D converter | AN000 to AN005 | Input | Analog input pins for the 12-bit A/D converter. |
|  | ADTRGO\# | Input | Input pin for the external trigger signal that start the A/D conversion. |
| Analog front end | REF0P, REF1P | Input | Positive input pins of the reference voltage for the 24-bit delta-sigma A/D converter. |
|  | REF0N, REF1N | Input | Negative input pins of the reference voltage for the 24-bit delta-sigma A/D converter. |
|  | REFOUT | Output | Internal reference voltage output pin. <br> Connect this to AVSS0 via a capacitor ( $0.47 \mu \mathrm{~F}$ ) for stabilizing the internal reference voltage. Place the capacitor close to the pin. |
|  | IEXC0 to IEXC3 | Output | Excitation current source output pins. |
|  | AIN0 to AIN11 | I/O | Analog input/output pins. |
|  | LSW | Output | Low-side-switch output pin. |

Table 1.4 Pin Functions (3/3)

| Classifications | Pin Name | I/O | Description |
| :--- | :--- | :--- | :--- |
| Analog power <br> supply | AVCC0 | Input | Analog voltage supply pin. Connect this pin to VCC when not using. |
|  | AVSSO | Input | Analog ground pin. Connect this pin to VSS when not using. |
|  | VREFH0 | Input | Analog reference voltage supply pin for the 12-bit A/D converter. |
|  | VREFL0 | Input | Analog reference ground pin for the 12-bit A/D converter. |
| I/O ports P14 to P17 I/O <br>  P26, P27 4-bit input/output pins. <br>  P30, P31, P35 to P37 I/O <br>  PB0, PB1 2-bit input/output pins. <br>  PC4 to PC7 I/O <br>  PH0 to PH3 2-bit input/output pins. |  |  |  |

### 1.5 Pin Assignments

### 1.5.1 48-Pin LFQFP



Note: This figure indicates the power supply pins and I/O port pins.
For the pin configuration, see the table "List of Pins and Pin Functions (48-Pin LFQFP)".

Figure 1.3 Pin Assignments of the 48-Pin LFQFP

### 1.5.2 40-Pin HWQFN



Note: $\quad$ This figure indicates the power supply pins and I/O port pins.
For the pin configuration, see the table "List of Pins and Pin Functions (40-Pin HWQFN)".
Note: It is recommended that the exposed die pad of HWQFN should be connected to VSS.

Figure 1.4 Pin Assignments of the 40-Pin HWQFN

### 1.6 List of Pins and Pin Functions

### 1.6.1 48-Pin LFQFP

Table 1.5 List of Pins and Pin Functions (48-Pin LFQFP) (1/2)

| Pin No. | Power Supply, Clock, System Control | I/O Port | Timers <br> (MTU, TMR, CMT, POE, CAC) | Communications (SCIg, SCIh, RSPI, RIIC, CAN) | Analog (S12AD, VREF, IEXC, DSAD, AMUX) | Others |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 |  |  |  |  | $\begin{aligned} & \text { AIN10/ANO04/ } \\ & \text { IEXC0 to IEXC3 } \end{aligned}$ |  |
| 2 |  |  |  |  | AIN11/AN005/ IEXC0 to IEXC3 |  |
| 3 | AVSS0 |  |  |  |  |  |
| 4 | AVCC0 |  |  |  |  |  |
| 5 | RES\# |  |  |  |  |  |
| 6 | XTAL | P37 |  |  |  |  |
| 7 | VSS |  |  |  |  |  |
| 8 | EXTAL | P36 |  |  |  |  |
| 9 | VCC |  |  |  |  |  |
| 10 | VCL |  |  |  |  |  |
| 11 | MD |  |  |  |  | FINED |
| 12 |  | P35 |  |  |  | NMI |
| 13 |  | P31 | MTIOC1A/MTIOC4D/TMO3 | CTS1\#/RTS1\#/SS1\# |  | IRQ1 |
| 14 |  | P30 | MTIOC0A/MTIOC4B/TMCI3/ POE8\# | RXD1/SMISO1/SSCL1 |  | IRQ0 |
| 15 |  | P27 | MTIOC2B/MTIOC4A/TMRI3 | SCK1 |  | IRQ3 |
| 16 |  | P26 | MTIOC2A/MTIOC4C/TMO0 | TXD1/SMOSI1/SSDA1 |  | IRQ2 |
| 17 |  | P17 | MTIOC3A/MTIOC3B/TMO1/ POE8\# | SCK1/MISOA/SDA |  | IRQ7 |
| 18 |  | P16 | MTIOC3C/MTIOC3D/TMO2 | TXD1/SMOSI1/SSDA1/MOSIA/ SCL |  | IRQ6/ADTRG0\# |
| 19 |  | P15 | MTIOCOB/MTCLKB/TMCI2 | ```RXD1/SMISO1/SSCL1/SSLA1/ CRXD0``` |  | IRQ5 |
| 20 |  | P14 | MTIOC3A/MTCLKA/TMRI2 | $\begin{aligned} & \text { CTS1\#/RTS1\#/SS1\#/SSLA3/ } \\ & \text { CTXD0 } \end{aligned}$ |  | IRQ4 |
| 21 |  | PH3 | MTIC5W/MTCLKB/TMCIO/POE2\# | CTS6\#/RTS6\#/SS6\#/RSPCKA |  |  |
| 22 |  | PH2 | MTIC5V/MTCLKA/TMRIO | SCK5/MOSIA |  | IRQ1 |
| 23 |  | PH1 | MTIC5U/MTCLKD/TMO0/POE2\# | TXD5/SMOSI5/SSDA5/SSLA0 |  | IRQO/CLKOUT |
| 24 |  | PH0 | MTIOCOD/MTCLKC/TMRIO/ CACREF | RXD5/SMISO5/SSCL5/SSLA2 |  |  |
| 25 |  | PC7 | MTIOC3A/MTCLKB/TMO2/ CACREF | TXD6/SMOSI6/SSDA6/MISOA |  |  |
| 26 |  | PC6 | MTIOC3C/MTCLKA/TMCI2 | RXD6/SMISO6/SSCL6/MOSIA |  |  |
| 27 |  | PC5 | MTIOC3B/MTCLKD/TMRI2 | SCK5/SCK6/SCK12/RSPCKA |  |  |
| 28 |  | PC4 | $\begin{aligned} & \text { MTIOC3D/MTCLKC/TMCI1/ } \\ & \text { POEO\# } \end{aligned}$ | $\begin{array}{\|l} \hline \text { CTS5\#/RTS5\#/SS5\#/CTS12\#I } \\ \text { RTS12\#/SS12\#/SSLA0 } \end{array}$ |  |  |
| 29 |  | PB1 | MTIOC1B/MTIOC2A/TMRI1/ POE1\# | $\begin{aligned} & \text { TXD12/TXDX12/SIOX12/ } \\ & \text { SMOSI12/SSDA12 } \end{aligned}$ |  |  |
| 30 | VCC |  |  |  |  |  |
| 31 |  | PB0 | MTIOCOC/TMCIO/POE3\# | $\begin{aligned} & \hline \text { RXD12/RXDX12/SMISO12/ } \\ & \text { SSCL12 } \end{aligned}$ |  | IRQ4 |
| 32 | VSS |  |  |  |  |  |
| 33 | AVCC0 |  |  |  |  |  |
| 34 | AVSS0 |  |  |  |  |  |
| 35 |  |  |  |  | REFOUT |  |
| 36 |  |  |  |  | LSW |  |
| 37 |  |  |  |  | REFON |  |
| 38 |  |  |  |  | REFOP |  |
| 39 |  |  |  |  | AINO/IEXC0 to IEXC3 |  |
| 40 |  |  |  |  | AIN1/IEXC0 to IEXC3 |  |
| 41 |  |  |  |  | AIN2/IEXC0 to IEXC3 |  |

Table 1.5 List of Pins and Pin Functions (48-Pin LFQFP) (2/2)

| Pin No. | Power Supply, Clock, System Control | I/O Port | Timers <br> (MTU, TMR, CMT, POE, CAC) | Communications (SCIg, SClh, RSPI, RIIC, CAN) | Analog (S12AD, VREF, IEXC, DSAD, AMUX) | Others |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 42 |  |  |  |  | AIN3/IEXC0 to IEXC3 |  |
| 43 |  |  |  |  | AIN4/IEXC0 to IEXC3/REF1N |  |
| 44 |  |  |  |  | AIN5/IEXC0 to IEXC3/REF1P |  |
| 45 |  |  |  |  | AIN6/ANOOO/ IEXC0 to IEXC3 |  |
| 46 |  |  |  |  | AIN7/AN001/ <br> IEXC0 to IEXC3 |  |
| 47 | VREFLO |  |  |  | AIN8/ANOO2/ IEXC0 to IEXC3 |  |
| 48 | VREFH0 |  |  |  | $\begin{array}{\|l} \text { AIN9/ANOO3/ } \\ \text { IEXC0 to IEXC3 } \end{array}$ |  |

### 1.6.2 40-Pin HWQFN

Table $1.6 \quad$ List of Pins and Pin Functions (40-Pin HWQFN)

| Pin No. | Power Supply, Clock, System Control | I/O Port | Timers <br> (MTU, TMR, CMT, POE, CAC) | Communications <br> (SCIg, SCIh, RSPI, RIIC, CAN) | Analog (S12AD, VREF, IEXC, DSAD, AMUX) | Others |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1 | AVSS0 |  |  |  |  |  |
| 2 | AVCCO |  |  |  |  |  |
| 3 | RES\# |  |  |  |  |  |
| 4 | XTAL | P37 |  |  |  |  |
| 5 | VSS |  |  |  |  |  |
| 6 | EXTAL | P36 |  |  |  |  |
| 7 | VCC |  |  |  |  |  |
| 8 | VCL |  |  |  |  |  |
| 9 | MD |  |  |  |  | FINED |
| 10 |  | P35 |  |  |  | NMI |
| 11 |  | P31 | MTIOC1A/MTIOC4D/TMO3 | CTS1\#/RTS1\#/SS1\# |  | IRQ1 |
| 12 |  | P30 | MTIOCOA/MTIOC4B/TMCI3/ POE8\# | RXD1/SMISO1/SSCL1 |  | IRQ0 |
| 13 |  | P27 | MTIOC2B/MTIOC4A/TMRI3 | SCK1 |  | IRQ3 |
| 14 |  | P26 | MTIOC2A/MTIOC4C/TMO0 | TXD1/SMOSI1/SSDA1 |  | IRQ2 |
| 15 |  | P17 | MTIOC3A/MTIOC3B/TMO1/ POE8\# | SCK1/MISOA/SDA |  | IRQ7 |
| 16 |  | P16 | MTIOC3C/MTIOC3D/TMO2 | TXD1/SMOSI1/SSDA1/MOSIA/ SCL |  | IRQ6/ADTRG0\# |
| 17 |  | P15 | MTIOCOB/MTCLKB/TMCI2 | $\begin{aligned} & \text { RXD1/SMISO1/SSCL1/SSLA1/ } \\ & \text { CRXD0 } \end{aligned}$ |  | IRQ5 |
| 18 |  | P14 | MTIOC3A/MTCLKA/TMRI2 | $\begin{aligned} & \text { CTS1\#/RTS1\#/SS1\#/SSLA3/ } \\ & \text { CTXD0 } \end{aligned}$ |  | IRQ4 |
| 19 |  | PH1 | MTCLKD/TMOO/POE2\# | TXD5/SMOSI5/SSDA5/SSLA0 |  | IRQO/CLKOUT |
| 20 |  | PH0 | MTIOCOD/MTCLKC/TMRIO/ CACREF | RXD5/SMISO5/SSCL5/SSLA2 |  |  |
| 21 |  | PC5 | MTIOC3B/MTCLKD/TMRI2 | SCK5/SCK12/RSPCKA |  |  |
| 22 |  | PC4 | ```MTIOC3D/MTCLKC/TMCI1/``` | $\begin{aligned} & \hline \text { CTS5\#/RTS5\#/SS5\#/CTS12\#/ } \\ & \text { RTS12\#/SS12\#/SSLA0 } \end{aligned}$ |  |  |
| 23 |  | PB1 | MTIOC1B/MTIOC2A/TMRI1/ POE1\# | $\begin{aligned} & \hline \text { TXD12/TXDX12/SIOX12/ } \\ & \text { SMOSI12/SSDA12 } \end{aligned}$ |  |  |
| 24 | VCC |  |  |  |  |  |
| 25 |  | PB0 | MTIOCOC/TMCIO/POE3\# | $\begin{aligned} & \text { RXD12/RXDX12/SMISO12/ } \\ & \text { SSCL12 } \end{aligned}$ |  | IRQ4 |
| 26 | VSS |  |  |  |  |  |
| 27 | AVCC0 |  |  |  |  |  |
| 28 | AVSS0 |  |  |  |  |  |
| 29 |  |  |  |  | REFOUT |  |
| 30 |  |  |  |  | LSW |  |
| 31 |  |  |  |  | REFON |  |
| 32 |  |  |  |  | REFOP |  |
| 33 |  |  |  |  | AINO/IEXC0 to IEXC3 |  |
| 34 |  |  |  |  | AIN1/IEXC0 to IEXC3 |  |
| 35 |  |  |  |  | AIN4/IEXC0 to IEXC3/REF1N |  |
| 36 |  |  |  |  | AIN5/IEXC0 to IEXC3/REF1P |  |
| 37 |  |  |  |  | AIN6/ANOOO/ IEXC0 to IEXC3 |  |
| 38 |  |  |  |  | $\begin{aligned} & \text { AIN7/AN001/ } \\ & \text { IEXC0 to IEXC3 } \end{aligned}$ |  |
| 39 | VREFLO |  |  |  | $\begin{aligned} & \text { AIN8/ANO02/ } \\ & \text { IEXC0 to IEXC3 } \end{aligned}$ |  |
| 40 | VREFH0 |  |  |  | $\begin{aligned} & \text { AIN9/ANO03/ } \\ & \text { IEXC0 to IEXC3 } \end{aligned}$ |  |

## 2. Electrical Characteristics

### 2.1 Absolute Maximum Ratings

Table 2.1 Absolute Maximum Ratings
Conditions: VSS $=\mathrm{AVSSO}=\mathrm{VREFLO}=0 \mathrm{~V}$

| Item |  |  | Symbol | Value | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Power supply voltage |  |  | VCC | -0.3 to +6.5 | V |
| Input voltage | P16 and P17 (5-V tolerant) |  | $V_{\text {in }}$ | -0.3 to +6.5 | V |
|  | Ports other than above |  |  | -0.3 to VCC + 0.3 |  |
| Reference power supply voltage |  |  | VREFH0 | -0.3 to AVCCO + 0.3 | V |
| Analog power supply voltage |  |  | AVCCO | -0.3 to +6.5 | V |
| Analog input voltage |  |  | $\mathrm{V}_{\text {AN }}$ | -0.3 to AVCCO + 0.3 | V |
| Reference voltage for 24-bit delta-sigma A/D converter |  |  | REF0P, REF1P | -0.3 to AVCCO + 0.3 | V |
|  |  |  | REF0N, REF1N | -0.3 to AVCCO + 0.3 |  |
| Junction temperature |  | D version | $\mathrm{T}_{\mathrm{j}}$ | -40 to +105 | ${ }^{\circ} \mathrm{C}$ |
|  |  | G version |  | -40 to +112 |  |
| Storage temperature |  |  | $\mathrm{T}_{\text {stg }}$ | -55 to +125 | ${ }^{\circ} \mathrm{C}$ |

Caution: Exceeding absolute maximum ratings may permanently damage the MCU.
To preclude malfunctions due to noise interference, insert capacitors with high frequency characteristics between the VCC and VSS pins, between the AVCCO and AVSSO pins, and between the VREFHO and VREFLO pins. Place capacitors with values of about $0.1 \mu \mathrm{~F}$ as close as possible to every power supply pin and use the shortest and widest possible traces.
Connect the VCL pin to a VSS pin via a $4.7-\mu \mathrm{F}$ capacitor. The capacitor must be placed close to the pin. For details, refer to section 2.12.1, Connecting VCL Capacitor and Bypass Capacitors.
Do not input signals to ports other than $5-\mathrm{V}$ tolerant ports while power is not being supplied to the MCU.
The current injection that results from the input of such a signal may lead to malfunctions and the abnormal current that passes through the MCU at such times may cause degradation of internal elements.
However, even if -0.3 to +6.5 V is input to a $5-\mathrm{V}$ tolerant port, this will not cause problems such as damage to the MCU .

### 2.2 Recommended Operating Conditions

Table 2.2 Recommended Operating Conditions (1)

| Item |  | Symbol | Min. | Typ. | Max. | $\frac{\text { Unit }}{} \frac{\mathrm{V}}{}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Power supply voltages |  | VCC*1, *2 | 1.8 | - | 5.5 |  |
|  |  | VSS | - | 0 | - |  |
| Analog power supply voltages |  | AVCC0*1, *2 | 1.8 | - | 5.5 | V |
|  |  | AVSS0 | - | 0 | - |  |
|  |  | VREFH0 | 1.8 | - | AVCC0 |  |
|  |  | VREFLO | - | 0 | - |  |
| Operating temperature | D version | $\mathrm{T}_{\text {opr }}$ | -40 | - | 85 | ${ }^{\circ} \mathrm{C}$ |
|  | G version |  | -40 | - | 105 |  |

Note 1. Use AVCCO and VCC under the following conditions:
While VCC > 2.4 V : AVCCO and VCC can be set independently when AVCCO $\geq 2.4 \mathrm{~V}$
While VCC $\leq 2.4 \mathrm{~V}$ : AVCCO and VCC can be set independently when AVCCO $\geq$ VCC
Note 2. When powering on the VCC and AVCCO pins, power them on at the same time or the VCC pin first and then the AVCCO pin.

Table 2.3 Recommended Operating Conditions (2)

| Item | Symbol | Value |
| :---: | :---: | :---: |
| VCL pin external capacitance | $\mathrm{C}_{\mathrm{VCL}}$ | $4.7 \mu \mathrm{~F} \pm 30 \% * 1$ |

Note 1. Use a multilayer ceramic capacitor whose nominal capacitance is $4.7 \mu \mathrm{~F}$ and a capacitance tolerance is $\pm 30 \%$ or better.

### 2.3 DC Characteristics

Table 2.4 DC Characteristics (1)
Conditions: $2.7 \mathrm{~V} \leq \mathrm{VCC} \leq 5.5 \mathrm{~V}, 2.7 \mathrm{~V} \leq \mathrm{AVCCO} \leq 5.5 \mathrm{~V}$, VSS $=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Schmitt trigger input voltage | RIIC input pin (except for SMBus, 5-V tolerant) | $\mathrm{V}_{\mathrm{IH}}$ | $0.7 \times$ VCC | - | 5.8 | V |  |
|  | P16 and P17 (5-V tolerant) |  | $0.8 \times \mathrm{VCC}$ | - | 5.8 |  |  |
|  | P14, P15, P26, P27, P30, P31, P35 to P37, PB0, PB1, PC4 to PC7, PH0 to PH3, and RES\# |  | $0.8 \times \mathrm{VCC}$ | - | VCC + 0.3 |  |  |
|  | RIIC input pin (except for SMBus) | $\mathrm{V}_{\mathrm{IL}}$ | -0.3 | - | $0.3 \times \mathrm{VCC}$ |  |  |
|  | Other than RIIC input pin |  | -0.3 | - | $0.2 \times \mathrm{VCC}$ |  |  |
| Hysteresis of Schmitt trigger input | RIIC input pin (except for SMBus) | $\Delta \mathrm{V}_{\mathrm{T}}$ | $0.05 \times \mathrm{VCC}$ | - | - |  |  |
|  | P16 and P17 |  | $0.05 \times \mathrm{VCC}$ | - | - |  |  |
|  | Other than RIIC input pin |  | $0.1 \times \mathrm{VCC}$ | - | - |  |  |
| High-level input voltage (except for Schmitt trigger input pins) | MD | $\mathrm{V}_{\mathrm{IH}}$ | $0.9 \times \mathrm{VCC}$ | - | $\mathrm{VCC}+0.3$ | V |  |
|  | EXTAL (external clock input) |  | $0.8 \times \mathrm{VCC}$ | - | $\mathrm{VCC}+0.3$ |  |  |
|  | RIIC input pin (SMBus) |  | 2.1 | - | VCC + 0.3 |  |  |
| Low-level input voltage (except for Schmitt trigger input pins) | MD | $\mathrm{V}_{\text {IL }}$ | -0.3 | - | $0.1 \times \mathrm{VCC}$ |  |  |
|  | EXTAL (external clock input) |  | -0.3 | - | $0.2 \times$ VCC |  |  |
|  | RIIC input pin (SMBus) |  | -0.3 | - | 0.8 |  |  |

Table 2.5 DC Characteristics (2)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}<2.7 \mathrm{~V}, 1.8 \mathrm{~V} \leq \mathrm{AVCCO}<2.7 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Schmitt trigger input voltage | P16 and P17 (5-V tolerant) | $\mathrm{V}_{\mathrm{IH}}$ | $0.8 \times$ VCC | - | 5.8 | V |  |
|  | P14, P15, P26, P27, P30, P31, P35 to P37, PB0, PB1, PC4 to PC7, PH0 to PH3, and RES\# |  | $0.8 \times$ VCC | - | VCC + 0.3 |  |  |
|  | P14 to P17, P26, P27, P30, P31, P35 to P37, PB0, PB1, PC4 to PC7, PH0 to PH3, and RES\# | $\mathrm{V}_{\text {IL }}$ | -0.3 | - | $0.2 \times \mathrm{VCC}$ |  |  |
| Hysteresis of Schmitt trigger input | P14 to P17, P26, P27, P30, P31, P35 to P37, PB0, PB1, PC4 to PC7, PH0 to PH3, and RES\# | $\Delta \mathrm{V}_{\mathrm{T}}$ | $0.01 \times$ VCC | - | - |  |  |
| High-level input voltage (except for Schmitt trigger input pins) | MD | $\mathrm{V}_{\mathrm{IH}}$ | $0.9 \times$ VCC | - | $\mathrm{VCC}+0.3$ | V |  |
|  | EXTAL (external clock input) |  | $0.8 \times \mathrm{VCC}$ | - | VCC + 0.3 |  |  |
| Low-level input voltage (except for Schmitt trigger input pins) | MD | $\mathrm{V}_{\text {IL }}$ | -0.3 | - | $0.1 \times \mathrm{VCC}$ |  |  |
|  | EXTAL (external clock input) |  | -0.3 | - | $0.2 \times \mathrm{VCC}$ |  |  |

Table 2.6 DC Characteristics (3)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Input leakage current | RES\#, MD, and P35 | $\left\|l_{\text {in }}\right\|$ | - | - | 1.0 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {in }}=0 \mathrm{~V}, \mathrm{VCC}$ |
| Three-state leakage current (off-state) | P16 and P17 | $\mid l_{\text {TSI }}$ | - | - | 1.0 | $\mu \mathrm{A}$ | $\mathrm{V}_{\text {in }}=0 \mathrm{~V}, 5.8 \mathrm{~V}$ |
|  | Ports other than P16 and P17 |  | - | - | 0.2 |  | $\mathrm{V}_{\text {in }}=0 \mathrm{~V}, \mathrm{VCC}$ |
| Input capacitance | P14 to P17, P26, P27, P30, P31, P36, P37, PB0, PB1, PC4 to PC7, PHO to PH3, MD, and RES\# | $\mathrm{C}_{\text {in }}$ | - | - | 15 | pF | $\begin{aligned} & \mathrm{V}_{\text {in }}=20 \mathrm{mV}, \\ & \mathrm{f}=1 \mathrm{MHz}, \\ & \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C} \end{aligned}$ |
|  | P35 |  | - | - | 30 |  |  |
| Output voltage of the VCL pin |  | $\mathrm{V}_{\mathrm{CL}}$ | - | 2.12 | - | V |  |

Table 2.7 DC Characteristics (4)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  |  | Symbol | Min. | Typ. | Max. | Unit |
| :--- | :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Input pull-up resistor | All ports (except for P35) | $\mathrm{R}_{\mathrm{U}}$ | 10 | 20 | 50 | $\mathrm{k} \Omega$ | $\mathrm{V}_{\text {in }}=0 \mathrm{~V}$ |

Table 2.8 DC Characteristics (5)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  |  |  |  | Symbol | Typ. | Max. | Unit | Test |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Supply current *1 | High-speed operating mode | Normal operating mode | No peripheral modules are operating.*2 | ICLK $=32 \mathrm{MHz}$ | $\mathrm{I}_{\mathrm{cc}}$ | 4.1 | - | mA |  |
|  |  |  |  | ICLK $=16 \mathrm{MHz}$ |  | 2.9 | - |  |  |
|  |  |  |  | ICLK $=8 \mathrm{MHz}$ |  | 2.2 | - |  |  |
|  |  |  |  | ICLK $=4 \mathrm{MHz}$ |  | 1.9 | - |  |  |
|  |  |  | All peripheral modules are in normal operation. | ICLK $=32 \mathrm{MHz*3}$ |  | 16.3 | - |  |  |
|  |  |  |  | ICLK $=16 \mathrm{MHz}^{* 3}$ |  | 9.1 | - |  |  |
|  |  |  |  | ICLK $=8 \mathrm{MHz}^{* 3}$ |  | 5.5 | - |  |  |
|  |  |  |  | ICLK $=4 \mathrm{MHz}^{* 3}$ |  | 3.7 | - |  |  |
|  |  |  | All peripheral modules are in full operation. | ICLK $=32 \mathrm{MHz*3}$ |  | - | 30.3 |  |  |
|  |  | Sleep mode | No peripheral modules are operating.*2 | ICLK $=32 \mathrm{MHz}$ |  | 2.4 | - |  |  |
|  |  |  |  | ICLK $=16 \mathrm{MHz}$ |  | 1.9 | - |  |  |
|  |  |  |  | ICLK $=8 \mathrm{MHz}$ |  | 1.6 | - |  |  |
|  |  |  |  | ICLK $=4 \mathrm{MHz}$ |  | 1.5 | - |  |  |
|  |  |  | All peripheral modules are in normal operation. | ICLK $=32 \mathrm{MHz}^{* 3}$ |  | 8.9 | - |  |  |
|  |  |  |  | ICLK $=16 \mathrm{MHz}^{* 3}$ |  | 5.4 | - |  |  |
|  |  |  |  | ICLK $=8 \mathrm{MHz}{ }^{*}$ |  | 3.5 | - |  |  |
|  |  |  |  | ICLK $=4 \mathrm{MHz}^{* 3}$ |  | 2.5 | - |  |  |
|  |  | Deep sleep mode | No peripheral modules are operating.*2 | ICLK $=32 \mathrm{MHz}$ |  | 1.5 | - |  |  |
|  |  |  |  | ICLK $=16 \mathrm{MHz}$ |  | 1.3 | - |  |  |
|  |  |  |  | ICLK $=8 \mathrm{MHz}$ |  | 1.2 | - |  |  |
|  |  |  |  | ICLK $=4 \mathrm{MHz}$ |  | 1.2 | - |  |  |
|  |  |  | All peripheral modules are in normal operation. | ICLK $=32 \mathrm{MHz*3}$ |  | 7.2 | - |  |  |
|  |  |  |  | ICLK $=16 \mathrm{MHz}^{* 3}$ |  | 4.4 | - |  |  |
|  |  |  |  | ICLK $=8 \mathrm{MHz}^{* 3}$ |  | 2.8 | - |  |  |
|  |  |  |  | ICLK $=4 \mathrm{MHz}^{* 3}$ |  | 2.1 | - |  |  |
|  |  | Increase during BGO operation*5 |  |  |  | 2.5 | - |  |  |


| Item |  |  |  |  | Symbol | Typ. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Supply current *1 | Middle-speed operating mode | Normal operating mode | No peripheral modules are operating.*6 | ICLK $=12 \mathrm{MHz}$ | $\mathrm{I}_{\mathrm{CC}}$ | 2.1 | - | mA |  |
|  |  |  |  | ICLK $=8 \mathrm{MHz}$ |  | 1.7 | - |  |  |
|  |  |  |  | ICLK $=4 \mathrm{MHz}$ |  | 1.4 | - |  |  |
|  |  |  |  | ICLK $=1 \mathrm{MHz}$ |  | 1.1 | - |  |  |
|  |  |  | All peripheral modules | ICLK $=12 \mathrm{MHz}$ |  | 6.8 | - |  |  |
|  |  |  | are in normal | ICLK $=8 \mathrm{MHz}$ |  | 5.0 | - |  |  |
|  |  |  |  | $\mathrm{ICLK}=4 \mathrm{MHz}$ |  | 3.1 | - |  |  |
|  |  |  |  | ICLK $=1 \mathrm{MHz}$ |  | 1.6 | - |  |  |
|  |  |  | All peripheral modules are in full operation.*7 | ICLK $=12 \mathrm{MHz}$ |  | - | 13.5 |  |  |
|  |  | Sleep mode | No peripheral modules | ICLK = 12 MHz |  | 1.4 | - |  |  |
|  |  |  | are operating.* ${ }^{*}$ | ICLK $=8 \mathrm{MHz}$ |  | 1.2 | - |  |  |
|  |  |  |  | ICLK $=4 \mathrm{MHz}$ |  | 1.1 | - |  |  |
|  |  |  |  | ICLK $=1 \mathrm{MHz}$ |  | 1.0 | - |  |  |
|  |  |  | All peripheral modules | ICLK $=12 \mathrm{MHz}$ |  | 4.0 | - |  |  |
|  |  |  | are in normal | ICLK $=8 \mathrm{MHz}$ |  | 3.0 | - |  |  |
|  |  |  |  | ICLK $=4 \mathrm{MHz}$ |  | 2.1 | - |  |  |
|  |  |  |  | ICLK $=1 \mathrm{MHz}$ |  | 1.3 | - |  |  |
|  |  | Deep sleep | No peripheral modules | ICLK $=12 \mathrm{MHz}$ |  | 1.0 | - |  |  |
|  |  | mode |  | ICLK $=8 \mathrm{MHz}$ |  | 0.9 | - |  |  |
|  |  |  |  | ICLK $=4 \mathrm{MHz}$ |  | 0.9 | - |  |  |
|  |  |  |  | ICLK $=1 \mathrm{MHz}$ |  | 0.8 | - |  |  |
|  |  |  | All peripheral modules | ICLK = 12 MHz |  | 3.3 | - |  |  |
|  |  |  |  | ICLK $=8 \mathrm{MHz}$ |  | 2.6 | - |  |  |
|  |  |  |  | ICLK $=4 \mathrm{MHz}$ |  | 1.8 | - |  |  |
|  |  |  |  | ICLK $=1 \mathrm{MHz}$ |  | 1.2 | - |  |  |
|  |  | Increase during BGO operation*5 |  |  |  | 2.5 | - |  |  |

Note 1. Supply current values do not include the output charge/discharge current from all pins. The values apply when internal pull-up resistors are disabled.
Note 2. Peripheral module clocks are stopped. This does not include BGO operation. The clock source is PLL. FCLK and PCLK are set to divided by 64.
Note 3. Peripheral module clocks are supplied. This does not include BGO operation. The clock source is PLL. FCLK and PCLK are the same frequency as that of ICLK.
Note 4. Conditions for typical values are at $\mathrm{VCC}=3.3 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$.
Note 5. The increase is caused by program/erase operation to the ROM or E2 DataFlash during the execution of a user program.
Note 6. Peripheral module clocks are stopped. The clock source is PLL when ICLK is 12 MHz and HOCO for other cases. FCLK and PCLK are set to divided by 64.
Note 7. Peripheral module clocks are supplied. The clock source is PLL when ICLK is 12 MHz and HOCO for other cases. FCLK and PCLK are the same frequency of that of the ICLK.


Note 1. This result applies when all peripheral modules are in normal operation but BGO is not in use. Indicates the average of the typical samples through actual measurement during product evaluation.
Note 2. This result applies when all peripheral modules are in full operation but BGO is not in use. Indicates the average of the upper-limit samples through actual measurement during product evaluation.

Figure 2.1 Voltage Dependence in High-Speed Operating Mode (Reference Data)


Note 1. This result applies when all peripheral modules are in normal operation but BGO is not in use. Indicates the average of the typical samples through actual measurement during product evaluation.
Note 2. This result applies when all peripheral modules are in full operation but BGO is not in use. Indicates the average of the upper-limit samples through actual measurement during product evaluation.

Figure 2.2 Voltage Dependence in Middle-Speed Operating Mode (Reference Data)

Table $2.9 \quad$ DC Characteristics (6)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  |  | Symbol | Typ.*3 | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Supply current*1 | Software standby mode*2 | $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ | $I_{C C}$ | 0.4 | 2.6 | $\mu \mathrm{A}$ |  |
|  |  | $\mathrm{T}_{\mathrm{a}}=55^{\circ} \mathrm{C}$ |  | 0.8 | 3.0 |  |  |
|  |  | $\mathrm{T}_{\mathrm{a}}=85^{\circ} \mathrm{C}$ |  | 2.5 | 12.6 |  |  |
|  |  | $\mathrm{T}_{\mathrm{a}}=105^{\circ} \mathrm{C}$ |  | 6.3 | 31.2 |  |  |
|  | Increment for IWDT operation |  |  | 0.4 | - |  |  |
|  | Increment for LPT operation |  |  | 0.4 | - |  | Use IWDT-Dedicated On-Chip Oscillator for clock source |

Note 1. Supply current values were obtained with no load on any output pin and all internal pull-up resistors disabled.
Note 2. The IWDT and LVD are stopped.
Note 3. Conditions for typical values are at VCC $=3.3 \mathrm{~V}$.


Note 1. Indicates the average of the typical samples through actual measurement during product evaluation
Note 2. Indicates the average of the upper-limit samples through actual measurement during product evaluation.

Figure $2.3 \quad$ Voltage Dependence in Software Standby Mode (Reference Data)


Figure 2.4 Temperature Dependence in Software Standby Mode (Reference Data)

Table 2.10 DC Characteristics (7)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | Min. | Typ.*1 | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| LVD | LVD0 | $\mathrm{I}_{\text {LVD }}$ | - | 0.10 | - | $\mu \mathrm{A}$ |  |
|  | LVD1 |  | - | 0.10 | - |  |  |
|  | LVD2 |  | - | 0.20 | - |  |  |

Note 1. Conditions for typical values are at $\mathrm{VCC}=\mathrm{AVCCO}=3.3 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$.
Table 2.11 DC Characteristics (8)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RAM standby voltage | $\mathrm{V}_{\text {RAM }}$ | 1.8 | - | - | V |  |

Table 2.12 DC Characteristics (9)
Conditions: $0 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| VCC ramp-up rate at power-on | At normal startup*1 | SrVCC | 0.02 | - | 20.00 | $\mathrm{ms} / \mathrm{V}$ |  |
|  | During fast startup time*2 |  | 0.02 | - | 2.00 |  |  |
|  | Voltage monitoring 0 reset enabled at startup*3, *4 |  | 0.02 | - | - |  |  |

Note 1. When the OFS1.LVDAS and OFS1.FASTSTUP bits are 1
Note 2. When the OFS1.LVDAS bit is 1 and the OFS1.FASTSTUP bit is 0
Note 3. When the OFS1.LVDAS bit is 0
Note 4. Turn on the power supply voltage according to the normal startup rising gradient because the settings in the OFS1 register are not read in boot mode.

Table 2.13 DC Characteristics (10)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$
The result of any ripple must be within the limit on allowable ripple frequency $f_{r}(\mathrm{VCC})$ where the ripple voltage is within the range between the VCC upper limit and lower limit. The result of any ripple must be within the limit on the allowable VCC ramp rate in power fluctuation (dt/dVCC) where the change in VCC exceeds VCC $\pm 10 \%$.

| Item | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Allowable ripple frequency | $\mathrm{fr}_{\mathrm{r}}(\mathrm{VCC})$ | - | - | 10 | kHz | Figure 2.5 $\mathrm{V}_{\mathrm{r}(\mathrm{VCC})} \leq 0.2 \times \mathrm{VCC}$ |
|  |  | - | - | 1 | MHz | Figure 2.5 $\mathrm{V}_{\mathrm{r}(\mathrm{VCC})} \leq 0.08 \times \mathrm{VCC}$ |
|  |  | - | - | 10 | MHz | Figure 2.5 $\mathrm{V}_{\mathrm{r}(\mathrm{VCC})} \leq 0.06 \times \mathrm{VCC}$ |
| Allowable VCC ramp rate at power fluctuation | dt/dVCC | 1.0 | - | - | ms/V | When VCC change exceeds VCC $\pm 10 \%$ |



Figure 2.5 Ripple Waveform

Table 2.14 DC Characteristics (11)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC} \leq 5.5 \mathrm{~V}, 2.7 \mathrm{~V} \leq \mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$


Note 1. Conditions for this value is at $\mathrm{AVCCO}=5.0 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$.
Note 2. Conditions for this value is at $\mathrm{AVCCO}=3.3 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$.


Figure 2.6 Temperature Dependence of Operating Current of 24-Bit Delta-Sigma AID Converter (AVCC0 = 5.0 V , Normal Mode, OPCR.DSADLVM bit $=0$ )


Figure 2.8 Temperature Dependence of Operating Current of 24-Bit Delta-Sigma A/D Converter (AVCCO = 5.0 V , Normal Mode, OPCR.DSADLVM bit = 1)


Figure 2.10 Temperature Dependence of Operating Current of 24-Bit Delta-Sigma AID Converter (AVCC0 = 5.0 V, Low Power Mode, OPCR.DSADLVM bit = 0)


Figure 2.7 Power-Supply Voltage Dependence of Operating Current of 24-Bit Delta-Sigma A/D Converter ( $\mathrm{T}_{\mathrm{a}}=\mathbf{2 5 ^ { \circ }} \mathrm{C}$, Normal Mode, OPCR.DSADLVM bit $=0$ )


Figure 2.9 Power-Supply Voltage Dependence of Operating Current of 24-Bit Delta-Sigma A/D Converter ( $\mathrm{T}_{\mathrm{a}}=\mathbf{2 5}{ }^{\circ} \mathrm{C}$, Normal Mode, OPCR.DSADLVM bit = 1)


Figure 2.11 Power-Supply Voltage Dependence of Operating Current of 24-Bit Delta-Sigma A/D Converter ( $\mathrm{T}_{\mathrm{a}}=\mathbf{2 5}{ }^{\circ} \mathrm{C}$, Low Power Mode, OPCR.DSADLVM bit $=0$ )


Figure 2.12 Temperature Dependence of Operating Current of 24-Bit Delta-Sigma A/D Converter (AVCC0 = 5.0 V, Low Power Mode, OPCR.DSADLVM bit = 1)


Figure 2.14 Temperature Dependence of Operating Current of Analog Input Buffer (Normal Mode)


Figure 2.16 Temperature Dependence of Operating Current of Reference Buffer (Normal Mode)


Figure 2.13 Power-Supply Voltage Dependence of Operating Current of 24-Bit Delta-Sigma A/D Converter ( $\mathrm{T}_{\mathrm{a}}=\mathbf{2 5 ^ { \circ }} \mathrm{C}$, Low Power Mode, OPCR.DSADLVM bit =1)


Figure 2.15 Temperature Dependence of Operating Current of Analog Input Buffer (Low Power Mode)


Figure 2.17 Temperature Dependence of Operating Current of Reference Buffer
(Low Power Mode)


Figure 2.18 Temperature Dependence of Operating Current of Voltage Reference


Figure 2.20 Temperature Dependence of Operating Current of Bias Voltage Generator


Figure 2.19 Temperature Dependence of Operating Current of Temperature Sensor


Figure 2.21 Temperature Dependence of Operating Current of Excitation Current Source

Table 2.15 DC Characteristics (12)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC} \leq 5.5 \mathrm{~V}, 1.8 \mathrm{~V} \leq \mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | Min. | Typ.*1 | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 12-bit A/D converter operating current | During A/D conversion (in high-speed conversion) | $\mathrm{I}_{\mathrm{AVCCO}}$ (S12AD) | - | 1.1 | 1.8 | mA |  |
|  | During A/D conversion (in low-current mode) |  | - | 0.6 | 1.1 |  |  |
| Reference power supply current | During A/D conversion (in high-speed conversion) | $\mathrm{I}_{\text {REFH0 }}$ | - | 71 | 122 | $\mu \mathrm{A}$ |  |
|  | Current while waiting for A/D conversion (all units) |  | - | - | 60 | nA |  |
| AVCC0 power down current |  | $\mathrm{I}_{\text {STBY }}$ | - | - | 2.2 | $\mu \mathrm{A}$ |  |

Note 1. Conditions for typical values are at $\mathrm{AVCCO}=5.0 \mathrm{~V}$ and $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$.

Table 2.16 Permissible Output Currents (1)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+85^{\circ} \mathrm{C}$

| Item |  |  | Symbol | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Permissible low-level output current (average value per pin) | P36 and P37 |  | $\mathrm{I}_{\text {OL }}$ | 4.0 | mA |
|  | Ports other than above | Normal drive output mode |  | 4.0 |  |
|  |  | High-drive output mode |  | 8.0 |  |
| Permissible low-level output current (maximum value per pin) | P36 and P37 |  |  | 4.0 |  |
|  | Ports other than above | Normal drive output mode |  | 4.0 |  |
|  |  | High-drive output mode |  | 8.0 |  |
| Permissible low-level output current | Total of P14 to P17, P26, P27, P30, P31, P36, and P37 |  | $\Sigma \mathrm{I}_{\mathrm{OL}}$ | 40 |  |
|  | Total of PB0, PB1, PC4 to PC7, and PH0 to PH3 |  |  | 40 |  |
|  | Total of all output pins |  |  | 80 |  |
| Permissible high-level output current (average value per pin) | P36 and P37 |  | IOH | -4.0 |  |
|  | Ports other than above | Normal drive output mode |  | -4.0 |  |
|  |  | High-drive output mode |  | -8.0 |  |
| Permissible high-level output current (maximum value per pin) | P36 and P37 |  |  | -4.0 |  |
|  | Ports other than above | Normal drive output mode |  | -4.0 |  |
|  |  | High-drive output mode |  | -8.0 |  |
| Permissible high-level output current | Total of P14 to P17, P26, P27, P30, P31, P36, and P37 |  | $\Sigma \mathrm{I}_{\mathrm{OH}}$ | -40 |  |
|  | Total of PB0, PB1, PC4 to PC7, and PH0 to PH3 |  |  | -40 |  |
|  | Total of all output pins |  |  | -80 |  |

Table 2.17 Permissible Output Currents (2)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  |  | Symbol | Max. | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Permissible low-level output current (average value per pin) | P36 and P37 |  | $\mathrm{IOL}^{\text {l }}$ | 4.0 | mA |
|  | Ports other than above | Normal drive output mode |  | 4.0 |  |
|  |  | High-drive output mode |  | 8.0 |  |
| Permissible low-level output current (maximum value per pin) | P36 and P37 |  |  | 4.0 |  |
|  | Ports other than above | Normal drive output mode |  | 4.0 |  |
|  |  | High-drive output mode |  | 8.0 |  |
| Permissible low-level output current | Total of P14 to P17, P26, P27, P30, P31, P36, and P37 |  | $\Sigma \mathrm{I}_{\mathrm{OL}}$ | 30 |  |
|  | Total of PB0, PB1, PC4 to PC7, and PH0 to PH3 |  |  | 30 |  |
|  | Total of all output pins |  |  | 60 |  |
| Permissible high-level output current (average value per pin) | P36 and P37 |  | $\mathrm{IOH}^{\text {a }}$ | -4.0 |  |
|  | Ports other than above | Normal drive output mode |  | -4.0 |  |
|  |  | High-drive output mode |  | -8.0 |  |
| Permissible high-level output current (maximum value per pin) | P36 and P37 |  |  | -4.0 |  |
|  | Ports other than above | Normal drive output mode |  | -4.0 |  |
|  |  | High-drive output mode |  | -8.0 |  |
| Permissible high-level output current | Total of P14 to P17, P26, P27, P30, P31, P36, and P37 |  | $\Sigma^{\text {I OH}}$ | -30 |  |
|  | Total of PB0, PB1, PC4 to PC7, and PH0 to PH3 |  |  | -30 |  |
|  | Total of all output pins |  |  | -60 |  |

Table 2.18 Output Voltage (1)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO}<2.7 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  |  | Symbol | Min. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Low-level output voltage | All output ports | Normal drive output mode | $\mathrm{V}_{\mathrm{OL}}$ | - | 0.3 | V | $\mathrm{I}_{\mathrm{OL}}=0.5 \mathrm{~mA}$ |
|  |  | High-drive output mode |  | - | 0.3 |  | $\mathrm{I}_{\mathrm{OL}}=1.0 \mathrm{~mA}$ |
| High-level output voltage | All output ports | Normal drive output mode | $\mathrm{V}_{\mathrm{OH}}$ | VCC - 0.3 | - | V | $\mathrm{I}_{\mathrm{OH}}=-0.5 \mathrm{~mA}$ |
|  |  | High-drive output mode |  | VCC - 0.3 | - |  | $\mathrm{I}_{\mathrm{OH}}=-1.0 \mathrm{~mA}$ |

Table 2.19 Output Voltage (2)
Conditions: $2.7 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO}<4.0 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  |  | Symbol | Min. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Low-level output voltage | All output ports (except for RIIC pins) | Normal drive output mode | $\mathrm{V}_{\mathrm{OL}}$ | - | 0.5 | V | $\mathrm{I}_{\mathrm{OL}}=1.0 \mathrm{~mA}$ |
|  |  | High-drive output mode |  | - | 0.5 |  | $\mathrm{I}_{\mathrm{OL}}=2.0 \mathrm{~mA}$ |
|  | RIIC pins | Normal drive output mode |  | - | 0.4 |  | $\mathrm{I}_{\mathrm{OL}}=3.0 \mathrm{~mA}$ |
|  |  | High-drive output mode |  | - | 0.6 |  | $\mathrm{l}_{\mathrm{OL}}=6.0 \mathrm{~mA}$ |
| High-level output voltage | All output ports | Normal drive output mode | $\mathrm{V}_{\mathrm{OH}}$ | VCC - 0.5 | - | V | $\mathrm{l}_{\mathrm{OH}}=-1.0 \mathrm{~mA}$ |
|  |  | High-drive output mode |  | VCC - 0.5 | - |  | $\mathrm{I}_{\mathrm{OH}}=-2.0 \mathrm{~mA}$ |

Table 2.20 Output Voltage (3)
Conditions: $4.0 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  |  | Symbol | Min. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Low-level output voltage | All output ports (except for RIIC pins) | Normal drive output mode | $\mathrm{V}_{\mathrm{OL}}$ | - | 0.8 | V | $\mathrm{I}_{\mathrm{OL}}=2.0 \mathrm{~mA}$ |
|  |  | High-drive output mode |  | - | 0.8 |  | $\mathrm{I}_{\mathrm{OL}}=4.0 \mathrm{~mA}$ |
|  | RIIC pins | Normal drive output mode |  | - | 0.4 |  | $\mathrm{I}_{\mathrm{OL}}=3.0 \mathrm{~mA}$ |
|  |  | High-drive output mode |  | - | 0.6 |  | $\mathrm{l}_{\mathrm{OL}}=6.0 \mathrm{~mA}$ |
| High-level output voltage | All output ports | Normal drive output mode | $\mathrm{V}_{\mathrm{OH}}$ | VCC - 0.8 | - | V | $\mathrm{I}_{\mathrm{OH}}=-2.0 \mathrm{~mA}$ |
|  |  | High-drive output mode |  | VCC - 0.8 | - |  | $\mathrm{I}_{\mathrm{OH}}=-4.0 \mathrm{~mA}$ |

Table 2.21 Thermal Resistance Value (Reference)

| Item | Package | Symbol | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Thermal resistance | 48-pin LFQFP (PLQP0048KB-B) | $\theta_{\mathrm{ja}}$ | 50.7 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ | JESD51-2 and JESD51-7 compliant |
|  | 40-pin HWQFN (PWQN0040KC-A) |  | 18.8 |  |  |
|  | 48-pin LFQFP (PLQP0048KB-B) | $\Psi_{\text {jt }}$ | 1.07 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ | JESD51-2 and JESD51-7 compliant |
|  | 40-pin HWQFN (PWQN0040KC-A) |  | 0.07 |  |  |

Note: The values are reference values when the 4-layer board is used. Thermal resistance depends on the number of layers or size of the board. For details, refer to the JEDEC standards.

### 2.3.1 Typical I/O Pin Output Characteristics (1)

Figure 2.22 to Figure 2.26 show the characteristics when normal drive output is selected by the drive capacity control register.


Figure 2.22 $\quad \mathrm{V}_{\mathrm{OH}} / \mathrm{V}_{\mathrm{OL}}$ and $\mathrm{I}_{\mathrm{OH}} / \mathrm{I}_{\mathrm{OL}}$ Voltage Characteristics at $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ When Normal Drive Output is Selected (Reference Data)


Figure 2.23 $\quad \mathrm{V}_{\mathrm{OH}} / \mathrm{V}_{\mathrm{OL}}$ and $\mathrm{I}_{\mathrm{OH}} / \mathrm{I}_{\mathrm{OL}}$ Temperature Characteristics at $\mathrm{VCC}=1.8 \mathrm{~V}$ When Normal Drive Output is Selected (Reference Data)


Figure 2.24 $\quad \mathrm{V}_{\mathrm{OH}} / \mathrm{V}_{\mathrm{OL}}$ and $\mathrm{I}_{\mathrm{OH}} / \mathrm{I}_{\mathrm{OL}}$ Temperature Characteristics at $\mathrm{VCC}=2.7 \mathrm{~V}$ When Normal Drive Output is Selected (Reference Data)


Figure 2.25 $\quad \mathrm{V}_{\mathrm{OH}} / \mathrm{V}_{\mathrm{OL}}$ and $\mathrm{I}_{\mathrm{OH}} / \mathrm{I}_{\mathrm{OL}}$ Temperature Characteristics at $\mathrm{VCC}=3.3 \mathrm{~V}$ When Normal Drive Output is Selected (Reference Data)


Figure 2.26 $\quad \mathrm{V}_{\mathrm{OH}} / \mathrm{V}_{\mathrm{OL}}$ and $\mathrm{I}_{\mathrm{OH}} / \mathrm{I}_{\mathrm{OL}}$ Temperature Characteristics at $\mathrm{VCC}=5.5 \mathrm{~V}$ When Normal Drive Output is Selected (Reference Data)

### 2.3.2 Typical I/O Pin Output Characteristics (2)

Figure 2.27 to Figure 2.31 show the characteristics when high-drive output is selected by the drive capacity control register.


Figure 2.27 $\quad \mathrm{V}_{\mathrm{OH}} / \mathrm{V}_{\mathrm{OL}}$ and $\mathrm{I}_{\mathrm{OH}} / \mathrm{I}_{\mathrm{OL}}$ Voltage Characteristics at $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ When High-Drive Output is Selected (Reference Data)


Figure 2.28 $\quad \mathrm{V}_{\mathrm{OH}} / \mathrm{V}_{\mathrm{OL}}$ and $\mathrm{I}_{\mathrm{OH}} / \mathrm{I}_{\mathrm{OL}}$ Temperature Characteristics at $\mathrm{VCC}=1.8 \mathrm{~V}$ When High-Drive Output is Selected (Reference Data)


Figure 2.29 $\quad \mathrm{V}_{\mathrm{OH}} / \mathrm{V}_{\mathrm{OL}}$ and $\mathrm{I}_{\mathrm{OH}} / \mathrm{I}_{\mathrm{OL}}$ Temperature Characteristics at $\mathrm{VCC}=2.7 \mathrm{~V}$ When High-Drive Output is Selected (Reference Data)


Figure 2.30 $\quad \mathrm{V}_{\mathrm{OH}} / \mathrm{V}_{\mathrm{OL}}$ and $\mathrm{I}_{\mathrm{OH}} / \mathrm{I}_{\mathrm{OL}}$ Temperature Characteristics at $\mathrm{VCC}=3.3 \mathrm{~V}$ When High-Drive Output is Selected (Reference Data)


Figure 2.31 $\quad \mathrm{V}_{\mathrm{OH}} / \mathrm{V}_{\mathrm{OL}}$ and $\mathrm{I}_{\mathrm{OH}} / \mathrm{I}_{\mathrm{OL}}$ Temperature Characteristics at $\mathrm{VCC}=5.5 \mathrm{~V}$ When High-Drive Output is Selected (Reference Data)

### 2.3.3 Typical I/O Pin Output Characteristics (3)

Figure 2.32 to Figure 2.35 show the characteristics of the RIIC output pin.


Figure 2.32 $\quad \mathrm{V}_{\mathrm{OL}}$ and $\mathrm{I}_{\mathrm{OL}}$ Voltage Characteristics of RIIC Output Pin at $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ (Reference Data)


Figure 2.33 $\quad \mathrm{V}_{\mathrm{OL}}$ and $\mathrm{I}_{\mathrm{OL}}$ Temperature Characteristics of RIIC Output Pin at VCC = 2.7 V (Reference Data)


Figure 2.34 $\quad \mathrm{V}_{\mathrm{OL}}$ and $\mathrm{I}_{\mathrm{OL}}$ Temperature Characteristics of RIIC Output Pin at VCC $=3.3 \mathrm{~V}$ (Reference Data)


Figure 2.35 $\mathrm{V}_{\mathrm{OL}}$ and $\mathrm{I}_{\mathrm{OL}}$ Temperature Characteristics of RIIC Output Pin at VCC $=5.5 \mathrm{~V}$ (Reference Data)

### 2.4 AC Characteristics

### 2.4.1 Clock Timing

Table 2.22 Operating Frequency Value (High-Speed Operating Mode)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=\mathrm{VREFLO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | VCC |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\begin{gathered} 1.8 \mathrm{~V} \leq \mathrm{VCC} \\ <2.4 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 2.4 \mathrm{~V} \leq \mathrm{VCC} \\ <2.7 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 2.7 \mathrm{~V} \leq \mathrm{VCC} \\ \leq 5.5 \mathrm{~V} \end{gathered}$ |  |
| Maximum operating frequency*3 | System clock (ICLK) |  | $\mathrm{f}_{\text {max }}$ | 8 | 16 | 32 | MHz |
|  | FlashIF clock (FCLK)*1, *2 | 8 |  | 16 | 32 |  |  |
|  | Peripheral module clock (PCLKA) | 8 |  | 16 | 32 |  |  |
|  | Peripheral module clock (PCLKB) | 8 |  | 16 | 32 |  |  |
|  | Peripheral module clock (PCLKD) | 8 |  | 16 | 32 |  |  |

Note 1. The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When FCLK is in use at below 4 MHz , the frequency can be set to $1 \mathrm{MHz}, 2 \mathrm{MHz}$, or 3 MHz . A non-integer frequency such as 1.5 MHz cannot be set.
Note 2. The frequency accuracy of FCLK must be within $\pm 3.5 \%$.
Note 3. The maximum operating frequency listed above does not include errors of the external oscillator and internal oscillator. For details on the range for the guaranteed operation, see Table 2.24 , Clock Timing

Table 2.23 Operating Frequency Value (Middle-Speed Operating Mode)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=\mathrm{VREFLO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol |  | VCC |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | $\begin{gathered} 1.8 \mathrm{~V} \leq \mathrm{VCC} \\ <2.4 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 2.4 \mathrm{~V} \leq \mathrm{VCC} \\ <2.7 \mathrm{~V} \end{gathered}$ | $\begin{gathered} 2.7 \mathrm{~V} \leq \mathrm{VCC} \\ \leq 5.5 \mathrm{~V} \end{gathered}$ |  |
| Maximum operating frequency*3 | System clock (ICLK) |  | $\mathrm{f}_{\text {max }}$ | 8 | 12 | 12 | MHz |
|  | FlashIF clock (FCLK)*1, *2 | 8 |  | 12 | 12 |  |  |
|  | Peripheral module clock (PCLKA) | 8 |  | 12 | 12 |  |  |
|  | Peripheral module clock (PCLKB) | 8 |  | 12 | 12 |  |  |
|  | Peripheral module clock (PCLKD) | 8 |  | 12 | 12 |  |  |

Note 1. The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz , the frequency can be set to $1 \mathrm{MHz}, 2 \mathrm{MHz}$, or 3 MHz . A non-integer frequency such as 1.5 MHz cannot be set.
Note 2. The frequency accuracy of FCLK must be within $\pm 3.5 \%$.
Note 3. The maximum operating frequency listed above does not include errors of the external oscillator and internal oscillator. For details on the range for the guaranteed operation, see Table 2.24, Clock Timing.

Table 2.24 Clock Timing
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=\mathrm{VREFLO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| EXTAL external clock input cycle time |  | $\mathrm{t}_{\text {Xcyc }}$ | 50 | - | - | ns | Figure 2.36 |
| EXTAL external clock input high pulse width |  | $\mathrm{t}_{\mathrm{XH}}$ | 20 | - | - | ns |  |
| EXTAL external clock input low pulse width |  | ${ }^{\text {x }}$ L | 20 | - | - | ns |  |
| EXTAL external clock rise time |  | $t_{\text {xr }}$ | - | - | 5 | ns |  |
| EXTAL external clock fall time |  | $\mathrm{t}_{\mathrm{Xf}}$ | - | - | 5 | ns |  |
| EXTAL external clock input wait time*1 |  | $\mathrm{t}_{\mathrm{XWT}}$ | 0.5 | - | - | $\mu \mathrm{s}$ |  |
| Main clock oscillator oscillation frequency*2 | $2.4 \leq \mathrm{VCC} \leq 5.5$ | $\mathrm{f}_{\text {MAIN }}$ | 1 | - | 20 | MHz |  |
|  | $1.8 \leq$ VCC $<2.4$ |  | 1 | - | 8 |  |  |
| Main clock oscillation stabilization time (crystal)*2 |  | $\mathrm{t}_{\text {MAINOSC }}$ | - | 3 | - | ms | Figure 2.37 |
| Main clock oscillation stabilization time (ceramic resonator)*2 |  | $\mathrm{t}_{\text {MAINOSC }}$ | - | 50 | - | $\mu \mathrm{s}$ |  |
| LOCO clock oscillation frequency |  | $\mathrm{f}_{\text {LOCO }}$ | 3.44 | 4.00 | 4.56 | MHz |  |
| LOCO clock oscillation stabilization time |  | $\mathrm{t}_{\text {LOCO }}$ | - | - | 0.5 | $\mu \mathrm{s}$ | Figure 2.38 |
| IWDT-dedicated clock oscillation frequency |  | $\mathrm{f}_{\text {ILOCO }}$ | 12.75 | 15.00 | 17.25 | kHz |  |
| IWDT-dedicated clock oscillation stabilization time |  | $\mathrm{t}_{\text {ILOCO }}$ | - | - | 50 | $\mu \mathrm{s}$ | Figure 2.39 |
| HOCO clock oscillation frequency |  | $\mathrm{f}_{\mathrm{HOCO}}$ | 31.52 | 32.00 | 32.48 | MHz | $\mathrm{T}_{\mathrm{a}}=-40$ to $+85^{\circ} \mathrm{C}$ |
|  |  | 31.68 | 32.00 | 32.32 | $\mathrm{T}_{\mathrm{a}}=-20$ to $+85^{\circ} \mathrm{C}$ |  |
|  |  | 31.36 | 32.00 | 32.64 | $\mathrm{T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$ |  |
| HOCO clock oscillation stabilization time |  |  | $\mathrm{t}_{\mathrm{HOCO}}$ | - | - | 41.3 | $\mu \mathrm{s}$ | Figure 2.41 |
| PLL input frequency*3 |  |  | $\mathrm{f}_{\text {PLLIN }}$ | 4 | - | 8 | MHz |  |
| PLL circuit oscillation frequency*3 |  | $\mathrm{f}_{\text {PLL }}$ | 24 | - | 32 | MHz |  |
| PLL clock oscillation stabilization time |  | $\mathrm{t}_{\text {PLL }}$ | - | - | 74.4 | $\mu \mathrm{s}$ | Figure 2.42 |
| PLL free-running oscillation frequency |  | $\mathrm{f}_{\text {PLLFR }}$ | - | 8 | - | MHz |  |

Note 1. Time until the clock can be used after the main clock oscillator stop bit (MOSCCR.MOSTP) is set to 0 (operating).
Note 2. Reference values when an $8-\mathrm{MHz}$ resonator is used.
When specifying the main clock oscillator stabilization time, set the MOSCWTCR register with a stabilization time value that is equal to or greater than the resonator-manufacturer-recommended value.
After the MOSCCR.MOSTP bit is changed to enable the main clock oscillator, confirm that the OSCOVFSR.MOOVF flag has become 1, and then start using the main clock.
Note 3. The VCC range should be 2.4 to 5.5 V when the PLL is used.


Figure 2.36 EXTAL External Clock Input Timing


Figure 2.37 Main Clock Oscillation Start Timing


Figure 2.38 LOCO Clock Oscillation Start Timing


Figure 2.39 IWDT-Dedicated Clock Oscillation Start Timing


Figure 2.40 HOCO Clock Oscillation Start Timing
(After Release from a Reset by Setting OFS1.HOCOEN Bit to 0)


Figure 2.41 HOCO Clock Oscillation Start Timing (Oscillation is Started by Setting HOCOCR.HCSTP Bit)


Figure 2.42 PLL Clock Oscillation Start Timing (PLL is Operated after Main Clock Oscillation Has Been Stabled)

### 2.4.2 Reset Timing

Table 2.25 Reset Timing
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=\mathrm{VREFLO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RES\# pulse width | At power-on | $\mathrm{t}_{\text {RESWP }}$ | 3 | - | - | ms | Figure 2.43 |
|  | Other than above | $\mathrm{t}_{\text {RESW }}$ | 30 | - | - | $\mu \mathrm{s}$ | Figure 2.44 |
| Wait time after release from the RES\# pin reset (at power-on) | At normal startup*1 | $\mathrm{t}_{\text {RESWT }}$ | - | 8.5 | - | ms | Figure 2.43 |
|  | During fast startup time*2 | $\mathrm{t}_{\text {RESW }}$ | - | 650 | - | $\mu \mathrm{s}$ |  |
| Wait time after release from the RES\# pin reset (from a warm start) |  | $\mathrm{t}_{\text {RESW }}$ | - | 310 | - | $\mu \mathrm{s}$ | Figure 2.44 |
| Independent watchdog timer reset period |  | $\mathrm{t}_{\text {RESWIW }}$ | - | 1 | - | IWDT clock cycle | Figure 2.45 |
| Software reset period |  | $t_{\text {RESWSW }}$ | - | 1 | - | ICLK cycle |  |
| Wait time after release from the independent watchdog timer reset*3 |  | $\mathrm{t}_{\text {RESWT2 }}$ | - | 350 | - | $\mu \mathrm{s}$ |  |
| Wait time after release from the software reset |  | $\mathrm{t}_{\text {RESWT2 }}$ | - | 220 | - | $\mu \mathrm{s}$ |  |

Note 1. When the OFS1.LVDAS and OFS1.FASTSTUP bits are 1
Note 2. When the OFS1.LVDAS and/or OFS1.FASTSTUP bits are 0
Note 3. When the IWDTCR.CKS[3:0] bits are 0000b


Figure 2.43 Reset Input Timing at Power-On


Figure 2.44 Reset Input Timing (1)


Figure 2.45 Reset Input Timing (2)

### 2.4.3 Timing of Recovery from Low Power Consumption Modes

Table 2.26 Timing of Recovery from Low Power Consumption Modes (1)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}$, VSS $=\mathrm{AVSSO}=\mathrm{VREFLO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  |  |  | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Recovery time from software standby mode*1 | High-speed mode | Crystal connected to main clock oscillator | Main clock oscillator operating*2 | $\mathrm{t}_{\text {SBYMC }}$ | - | 2 | 3 | ms | Figure 2.46 |
|  |  | External clock input to main clock oscillator | Main clock oscillator operating*3 | ${ }^{\text {t SBYEX }}$ | - | 35 | 50 | $\mu \mathrm{s}$ |  |
|  |  | HOCO clock oscillator operating |  | $\mathrm{t}_{\text {SBYHO }}$ | - | 40 | 55 | $\mu \mathrm{s}$ |  |
|  |  | LOCO clock oscillator operating |  | $\mathrm{t}_{\text {SBYLO }}$ | - | 40 | 55 | $\mu \mathrm{s}$ |  |

Note 1. The recovery time varies depending on the state of each oscillator when the WAIT instruction is executed. When multiple oscillators are operating, the recovery time varies depending on the operating state of the oscillators that are not selected as the system clock source. The above table applies when only the corresponding clock is operating.
Note 2. When the frequency of the crystal is 20 MHz
When the main clock oscillator wait control register (MOSCWTCR) is set to 04 h
Note 3. When the frequency of the external clock is 20 MHz
When the main clock oscillator wait control register (MOSCWTCR) is set to 00h

Table 2.27 Timing of Recovery from Low Power Consumption Modes (2)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=\mathrm{VREFLO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  |  |  | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Recovery time from software standby mode*1 | Middle-speed mode | Crystal connected to main clock oscillator | Main clock oscillator operating*2 | $\mathrm{t}_{\text {SBYMC }}$ | - | 2 | 3 | ms | Figure 2.46 |
|  |  |  | Main clock oscillator and PLL circuit operating*3 | $\mathrm{t}_{\text {SBYPC }}$ | - | 2 | 3 | ms |  |
|  |  | External clock input to main clock oscillator | Main clock oscillator operating*4 | $\mathrm{t}_{\text {SBYEX }}$ | - | 3 | 4 | $\mu \mathrm{s}$ |  |
|  |  |  | Main clock oscillator and PLL circuit operating*5 | $\mathrm{t}_{\text {SBYPE }}$ | - | 65 | 85 | $\mu \mathrm{s}$ |  |
|  |  | HOCO clock oscillator operating*6 |  | $\mathrm{t}_{\text {SBYHO }}$ | - | 40 | 50 | $\mu \mathrm{s}$ |  |
|  |  | LOCO clock oscillator operating |  | $\mathrm{t}_{\text {SBYLO }}$ | - | 5 | 7 | $\mu \mathrm{s}$ |  |

Note 1. The recovery time varies depending on the state of each oscillator when the WAIT instruction is executed. When multiple oscillators are operating, the recovery time varies depending on the operating state of the oscillators that are not selected as the system clock source. The above table applies when only the corresponding clock is operating.
Note 2. When the frequency of the crystal is 12 MHz When the main clock oscillator wait control register (MOSCWTCR) is set to 04h
Note 3. This is the case when PLL is selected as the system clock and its frequency division is set to be 12 MHz . When the main clock oscillator wait control register (MOSCWTCR) is set to 04h
Note 4. When the frequency of the external clock is 12 MHz When the main clock oscillator wait control register (MOSCWTCR) is set to 00h
Note 5. This is the case when PLL is selected as the system clock and its frequency division is set to be 12 MHz . When the main clock oscillator wait control register (MOSCWTCR) is set to 00h
Note 6. This is the case when HOCO is selected as the system clock and its frequency division is set to be 8 MHz .


Figure 2.46
Software Standby Mode Recovery Timing

Table 2.28 Timing of Recovery from Low Power Consumption Modes (3)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=\mathrm{VREFLO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Recovery time from deep sleep mode*1 | High-speed mode*2 | $\mathrm{t}_{\text {DSLP }}$ | - | 2.0 | 3.5 | $\mu \mathrm{S}$ | Figure 2.47 |
|  | Middle-speed mode*3 | $\mathrm{t}_{\text {DSLP }}$ | - | 3.0 | 4.0 | $\mu \mathrm{s}$ |  |

Note 1. Oscillators continue oscillating in deep sleep mode.
Note 2. When the frequency of the system clock is 32 MHz
Note 3. When the frequency of the system clock is 12 MHz


Figure 2.47 Deep Sleep Mode Recovery Timing

Table 2.29 Operating Mode Transition Time
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=\mathrm{VREFLO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Mode before Transition | Mode after Transition | ICLK Frequency | Transition Time |  | Unit |  |
| :--- | :--- | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. |  |  |
| High-speed operating mode | Middle-speed operating modes | 8 MHz | - | 10.0 | - | $\mu \mathrm{s}$ |
| Middle-speed operating modes | High-speed operating mode | 8 MHz | - | 37.5 | - | $\mu \mathrm{s}$ |

Note: Values when the frequencies of PCLKA, PCLKB, PCLKD, and FCLK are not divided.

### 2.4.4 Control Signal Timing

Table 2.30 Control Signal Timing
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| NMI pulse width | $\mathrm{t}_{\text {NMIW }}$ | 200 | - | - | ns | NMI digital filter is disabled (NMIFLTE.NFLTEN = 0) | $2 \times \mathrm{t}_{\text {Pcyc }} \leq 200 \mathrm{~ns}$ |
|  |  | $2 \times t_{\text {Pcyc }}{ }^{* 1}$ | - | - |  |  | $2 \times \mathrm{t}_{\text {Pcyc }}>200 \mathrm{~ns}$ |
|  |  | 200 | - | - |  | NMI digital filter is enabled | $3 \times \mathrm{t}_{\text {NMICK }} \leq 200 \mathrm{~ns}$ |
|  |  | $3.5 \times \mathrm{t}_{\text {NMICK }}{ }^{* 2}$ | - | - |  | (NMIFLTE.NFLTEN = 1) | $3 \times \mathrm{t}_{\text {NMICK }}>200 \mathrm{~ns}$ |
| IRQ pulse width | $\mathrm{t}_{\text {IRQW }}$ | 200 | - | - | ns | IRQ digital filter is disabled (IRQFLTEO.FLTENi $=0$ ) | $2 \times \mathrm{t}_{\text {Pcyc }} \leq 200 \mathrm{~ns}$ |
|  |  | $2 \times \mathrm{t}_{\text {Pcyc }}{ }^{* 1}$ | - | - |  |  | $2 \times \mathrm{t}_{\text {Pcyc }}>200 \mathrm{~ns}$ |
|  |  | 200 | - | - |  | IRQ digital filter is enabled (IRQFLTEO.FLTENi $=1$ ) | $3 \times \mathrm{t}_{\text {IRQCK }} \leq 200 \mathrm{~ns}$ |
|  |  | $3.5 \times \mathrm{t}_{\text {IRQCK }}{ }^{* 3}$ | - | - |  |  | $3 \times \mathrm{t}_{\text {IRQCK }}>200 \mathrm{~ns}$ |

Note: 200 ns minimum in software standby mode.
Note 1. $\mathrm{t}_{\text {Pcyc }}$ indicates the cycle of PCLKB.
Note 2. $\mathrm{t}_{\text {NMICK }}$ indicates the cycle of the NMI digital filter sampling clock.
Note 3. $\mathrm{t}_{\mathrm{IRQCK}}$ indicates the cycle of the IRQi digital filter sampling clock ( $\mathrm{i}=0$ to 7 ).


Figure 2.48
NMI Interrupt Input Timing


Figure 2.49 IRQ Interrupt Input Timing

### 2.4.5 Timing of On-Chip Peripheral Modules

### 2.4.5.1 I/O ports

Table 2.31 Timing of I/O ports
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | Min. | Typ. | Max. | Unit $^{* 11}$ | Test Conditions |
| :--- | :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| I/O ports | Input data pulse width | $\mathrm{t}_{\text {PRW }}$ | 1.5 | - | - | $\mathrm{t}_{\text {Pcyc }}$ | Figure 2.50 |

Note 1. $t_{\text {Pcyc }}$ : PCLK cycle


Port


Figure $2.50 \quad$ I/O Port Input Timing

### 2.4.5.2 MTU

Table 2.32 Timing of MTU
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  |  | Symbol | Min. | Typ. | Max. | Unit*1 | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| MTU | Input capture input pulse width | Single-edge setting | $\mathrm{t}_{\text {TICW }}$ | 1.5 | - | - | $\mathrm{t}_{\text {Pcyc }}$ | Figure 2.51 |
|  |  | Both-edge setting |  | 2.5 | - | - |  |  |
|  | Input capture input rise/fall time |  | $\mathrm{t}_{\mathrm{TICr}}$, <br> $\mathrm{t}_{\text {TICf }}$ | - | - | 0.1 | $\mu \mathrm{s} / \mathrm{V}$ |  |
|  | Timer clock pulse width | Single-edge setting | $\mathrm{t}_{\text {TскW }}$, <br> ${ }^{\text {t TCKWL }}$ | 1.5 | - | - | $\mathrm{t}_{\text {Pcyc }}$ | Figure 2.52 |
|  |  | Both-edge setting |  | 2.5 | - | - |  |  |
|  |  | Phase counting mode |  | 2.5 | - | - |  |  |
|  | Timer clock rise/fall time |  | $\mathrm{t}_{\mathrm{TCK}}$, <br> $t_{\text {TCKf }}$ | - | - | 0.1 | $\mu \mathrm{s} / \mathrm{V}$ |  |

Note 1. $\mathrm{t}_{\text {Pcyc }}$ : PCLK cycle


Figure 2.51 MTU Input/Output Timing


Figure 2.52
MTU Clock Input Timing

### 2.4.5.3 POE

Table 2.33 Timing of POE
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}$, VSS $=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  |  | Symbol | Min. | Typ. | Max. | Unit ${ }^{* 1}$ | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| POE | POE\# input pulse width |  | $t_{\text {POEW }}$ | 1.5 | - | - | $\mathrm{t}_{\text {Pcyc }}$ | Figure 2.53 |
|  | POE\# input rise/fall time |  | $t_{\text {POEr }}$, <br> $t_{\text {POEf }}$ | - | - | 0.1 | $\mu \mathrm{s} / \mathrm{V}$ |  |
|  | Output disable time | Transition of the POE\# signal level | $\mathrm{t}_{\text {POEDI }}$ | - | - | $\begin{gathered} 5 \text { PCLKB + } \\ 0.24 \end{gathered}$ | $\mu \mathrm{s}$ | Figure 2.54 <br> When detecting falling edges (ICSRm.POEnM[1:0] $=00(\mathrm{~m}=1,2 ; \mathrm{n}=0$ to 3,8$)$ ) |
|  |  | Simultaneous conduction of output pins | $\mathrm{t}_{\text {poedo }}$ | - | - | $\begin{array}{\|c} \hline 3 \text { PCLKB + } \\ 0.2 \end{array}$ | $\mu \mathrm{s}$ | Figure 2.55 |
|  |  | Register setting | $\mathrm{t}_{\text {POEDS }}$ | - | - | $\begin{array}{\|c} \hline 1 \text { PCLKB + } \\ 0.2 \end{array}$ | $\mu \mathrm{s}$ | Figure 2.56 Time for access to the register is not included. |
|  |  | Oscillation stop detection | tpoedos | - | - | 21 | $\mu \mathrm{s}$ | Figure 2.57 |

Note 1. $\mathrm{t}_{\text {Pcyc }}$ : PCLK cycle


Figure 2.53 POE Input Timing ( $\mathrm{n}=0$ to 3,8 )


Figure 2.54 Output Disable Time for POE in Response to Transition of the POEn\# Signal Level


Figure 2.55 Output Disable Time for POE in Response to the Simultaneous Conduction of Output Pins


Figure 2.56 Output Disable Time for POE in Response to the Register Setting


Figure 2.57

### 2.4.5.4 TMR

Table 2.34 Timing of TMR
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  |  | Symbol | Min. | Typ. | Max. | Unit ${ }^{\star 1}$ | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| TMR | Timer clock pulse width | Single-edge setting | $\mathrm{t}_{\text {тмсан }}$, <br> $\mathrm{t}_{\mathrm{TMCWL}}$ | 1.5 | - | - | $\mathrm{t}_{\text {Pcyc }}$ | Figure 2.58 |
|  |  | Both-edge setting |  | 2.5 | - | - |  |  |
|  | Timer clock rise/fall time |  | ${ }^{\mathrm{t}} \mathrm{TMCr}$, <br> $\mathrm{t}_{\text {TMCf }}$ | - | - | 0.1 | $\mu \mathrm{s} / \mathrm{V}$ |  |

Note 1. $\mathrm{t}_{\text {Pcyc }}$ : PCLK cycle


Figure 2.58 TMR Clock Input Timing

### 2.4.5.5 SCI

Table 2.35 Timing of SCI
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  |  |  | Symbol | Min. | Typ. | Max. | Unit ${ }^{* 1}$ | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| SCI | Input clock cycle time |  | Asynchronous | ${ }^{\text {Scyc }}$ | 4 | - | - | $\mathrm{t}_{\text {Pcyc }}$ | Figure 2.59 |
|  |  |  | Clock synchronous |  | 6 | - | - |  |  |
|  | Input clock pulse width |  |  | tsckw | 0.4 | - | 0.6 | $\mathrm{t}_{\text {Scyc }}$ |  |
|  | Input clock rise time |  |  | $\mathrm{t}_{\text {SCKr }}$ | - | - | 20 | ns |  |
|  | Input clock fall time |  |  | $\mathrm{t}_{\text {SCKf }}$ | - | - | 20 | ns |  |
|  | Output clock cycle time |  | Asynchronous | ${ }^{\text {tscyc }}$ | 16 | - | - | $t_{\text {Pcyc }}$ |  |
|  |  |  | Clock synchronous |  | 4 | - | - |  |  |
|  | Output clock pulse width |  |  | tsckw | 0.4 | - | 0.6 | $\mathrm{t}_{\text {scyc }}$ |  |
|  | Output clock rise time |  |  | $\mathrm{t}_{\text {SCKr }}$ | - | - | 20 | ns |  |
|  | Output clock fall time |  |  | $\mathrm{t}_{\text {SCKf }}$ | - | - | 20 | ns |  |
|  | Transmit data delay time (master) | Clock synchronous |  | $\mathrm{t}_{\text {TXD }}$ | - | - | 40 | ns | Figure 2.60 |
|  | Transmit data delay time (slave) | Clock synchronous | $\mathrm{VCC} \geq 2.7 \mathrm{~V}$ |  | - | - | 65 | ns |  |
|  |  |  | $\mathrm{VCC}<2.7 \mathrm{~V}$ |  | - | - | 100 | ns |  |
|  | Receive data setup time (master) | Clock synchronous | $\mathrm{VCC} \geq 2.7 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{RXS}}$ | 65 | - | - | ns |  |
|  |  |  | $\mathrm{VCC}<2.7 \mathrm{~V}$ |  | 90 | - | - | ns |  |
|  | Receive data setup time (slave) | Clock synchronous |  |  | 40 | - | - | ns |  |
|  | Receive data hold time | Clock synchronous |  | $\mathrm{t}_{\mathrm{RXH}}$ | 40 | - | - | ns |  |

[^0]Table 2.36 Timing of Simple $I^{2} \mathrm{C}$
Conditions: $2.7 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | Min.*1 | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Simple $\mathrm{I}^{2} \mathrm{C}$ (Standard mode) | SDA rise time | $\mathrm{t}_{\mathrm{Sr}}$ | - | 1000 | ns | Figure 2.61 |
|  | SDA fall time | $\mathrm{t}_{\text {sf }}$ | - | 300 | ns |  |
|  | SDA spike pulse removal time | $\mathrm{t}_{\text {SP }}$ | 0 | $4 \times \mathrm{t}_{\text {Pcyc }}$ | ns |  |
|  | Data setup time | $t_{\text {SDAS }}$ | 250 | - | ns |  |
|  | Data hold time | $t_{\text {SDAH }}$ | 0 | - | ns |  |
|  | SCL, SDA capacitive load | $\mathrm{C}_{\mathrm{b}}$ | - | 400 | pF |  |
| Simple ${ }^{2} \mathrm{C}$ <br> (Fast mode) | SDA rise time | $\mathrm{t}_{\mathrm{Sr}}$ | - | 300 | ns | Figure 2.61 |
|  | SDA fall time | $\mathrm{t}_{\text {Sf }}$ | - | 300 | ns |  |
|  | SDA spike pulse removal time | $\mathrm{t}_{\mathrm{SP}}$ | 0 | $4 \times \mathrm{t}_{\text {Pcyc }}$ | ns |  |
|  | Data setup time | $t_{\text {SDAS }}$ | 100 | - | ns |  |
|  | Data hold time | $t_{\text {SDAH }}$ | 0 | - | ns |  |
|  | SCL, SDA capacitive load | $\mathrm{C}_{\mathrm{b}}$ | - | 400 | pF |  |

Note: $\quad \quad_{\text {Pcyc }}$ : PCLK cycle
Note 1. $\mathrm{C}_{\mathrm{b}}$ is the total capacitance of the bus lines.

Table 2.37 Timing of Simple SPI
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  |  | Symbol | Min. | Max. | Unit*1 | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Simple | SCK clock cycle output (master) |  | ${ }_{\text {t }}$ Pcyc | 4 | 65536 | $\mathrm{t}_{\text {Pcyc }}$ | Figure 2.62 |
| SPI | SCK clock cycle input (slave) |  |  | 6 | - | $t_{\text {Pcyc }}$ |  |
|  | SCK clock high pulse width |  | $\mathrm{t}_{\text {SPCKWH }}$ | 0.4 | 0.6 | $\mathrm{t}_{\text {SPcyc }}$ |  |
|  | SCK clock low pulse width |  | $t_{\text {SPCKWL }}$ | 0.4 | 0.6 | $\mathrm{t}_{\text {SPcyc }}$ |  |
|  | SCK clock rise/fall time |  | $\mathrm{t}_{\text {SPCKr }}, \mathrm{t}_{\text {SPCKf }}$ | - | 20 | ns |  |
|  | Data input setup time (master) | $\mathrm{VCC} \geq 2.7 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{SU}}$ | 65 | - | ns | Figure 2.63, <br> Figure 2.64 |
|  |  | $\mathrm{VCC}<2.7 \mathrm{~V}$ |  | 95 | - |  |  |
|  | Data input setup time (slave) |  |  | 40 | - |  |  |
|  | Data input hold time |  | $\mathrm{t}_{\mathrm{H}}$ | 40 | - | ns |  |
|  | SSL input setup time |  | $\mathrm{t}_{\text {LEAD }}$ | 3 | - | $\mathrm{t}_{\text {SPcyc }}$ |  |
|  | SSL input hold time |  | $t_{\text {LAG }}$ | 3 | - | $\mathrm{t}_{\text {SPcyc }}$ |  |
|  | Data output delay time (master) |  | $\mathrm{t}_{\mathrm{OD}}$ | - | 40 | ns |  |
|  | Data output delay time (slave) | $\mathrm{VCC} \geq 2.7 \mathrm{~V}$ |  | - | 65 |  |  |
|  |  | $\mathrm{VCC}<2.7 \mathrm{~V}$ |  | - | 100 |  |  |
|  | Data output hold time (master) | $\mathrm{VCC} \geq 2.7 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{OH}}$ | -10 | - | ns |  |
|  |  | VCC < 2.7 V |  | -20 | - |  |  |
|  | Data output hold time (slave) |  |  | -10 | - |  |  |
|  | Data rise/fall time |  | $\mathrm{t}_{\mathrm{Dr}}, \mathrm{t}_{\mathrm{Df}}$ | - | 20 | ns |  |
|  | SSL input rise/fall time |  | $\mathrm{t}_{\text {SSLr }}, \mathrm{t}_{\text {SSLf }}$ | - | 20 | ns |  |
|  | Slave access time |  | $t_{\text {SA }}$ | - | 6 | $t_{\text {Pcyc }}$ | Figure 2.65, Figure 2.66 |
|  | Slave output release time |  | $t_{\text {REL }}$ | - | 6 | $\mathrm{t}_{\text {Pcyc }}$ |  |

Note 1. $\mathrm{t}_{\text {Pcyc }}$ : PCLK cycle

### 2.4.5.6 RIIC

Table 2.38 Timing of RIIC
Conditions: $2.7 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

|  | Item | Symbol | Min.*1, *2 | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RIIC <br> (Standard mode, SMBus) | SCL cycle time | $\mathrm{t}_{\text {SCL }}$ | $6(12) \times t_{I I C c y c}+1300$ | - | ns | Figure 2.61 |
|  | SCL high pulse width | $\mathrm{t}_{\text {SCLH }}$ | $3(6) \times t_{\text {IIcсус }}+300$ | - | ns |  |
|  | SCL low pulse width | $\mathrm{t}_{\text {SCLL }}$ | $3(6) \times t_{\text {IICcyc }}+300$ | - | ns |  |
|  | SCL, SDA rise time | $\mathrm{t}_{\mathrm{Sr}}$ | - | 1000 | ns |  |
|  | SCL, SDA fall time | $\mathrm{t}_{\text {Sf }}$ | - | 300 | ns |  |
|  | SCL, SDA spike pulse removal time | $\mathrm{t}_{\mathrm{SP}}$ | 0 | $1(4) \times t_{l I C c y c}$ | ns |  |
|  | SDA bus free time | $\mathrm{t}_{\text {BUF }}$ | $3(6) \times t_{1 I C c y c}+300$ | - | ns |  |
|  | START condition hold time | $\mathrm{t}_{\text {Stah }}$ | $\mathrm{t}_{\text {IIccyc }}+300$ | - | ns |  |
|  | Repeated START condition setup time | $\mathrm{t}_{\text {STAS }}$ | 1000 | - | ns |  |
|  | STOP condition setup time | ${ }_{\text {t }}$ tos | 1000 | - | ns |  |
|  | Data setup time | $t_{\text {SDAS }}$ | $\mathrm{t}_{\text {IICcyc }}+50$ | - | ns |  |
|  | Data hold time | $t_{\text {SDAH }}$ | 0 | - | ns |  |
|  | SCL, SDA capacitive load | $\mathrm{C}_{\mathrm{b}}$ | - | 400 | pF |  |
| RIIC | SCL cycle time | $\mathrm{t}_{\text {SCL }}$ | $6(12) \times \mathrm{t}_{\text {IICcyc }}+600$ | - | ns | Figure 2.61 |
| (Fast mode) | SCL high pulse width | $\mathrm{t}_{\text {SCLH }}$ | $3(6) \times \mathrm{t}_{\text {IIcıyc }}+300$ | - | ns |  |
|  | SCL low pulse width | ${ }^{\text {tSCLL }}$ | $3(6) \times \mathrm{t}_{\text {IICcyc }}+300$ | - | ns |  |
|  | SCL, SDA rise time | $\mathrm{t}_{\mathrm{Sr}}$ | - | 300 | ns |  |
|  | SCL, SDA fall time | $\mathrm{t}_{\mathrm{Sf}}$ | - | 300 | ns |  |
|  | SCL, SDA spike pulse removal time | $\mathrm{t}_{\mathrm{SP}}$ | 0 | $1(4) \times t_{\text {IICcyc }}$ | ns |  |
|  | SDA bus free time | $\mathrm{t}_{\text {BUF }}$ | $3(6) \times t_{1 I \text { ccyc }}+300$ | - | ns |  |
|  | START condition hold time | $\mathrm{t}_{\text {StA }}$ | $\mathrm{t}_{\text {IIccyc }}+300$ | - | ns |  |
|  | Repeated START condition setup time | $t_{\text {Stas }}$ | 300 | - | ns |  |
|  | STOP condition setup time | $\mathrm{t}_{\text {Stos }}$ | 300 | - | ns |  |
|  | Data setup time | $t_{\text {SDAS }}$ | $\mathrm{t}_{\text {IICcyc }}+50$ | - | ns |  |
|  | Data hold time | $\mathrm{t}_{\text {SDAH }}$ | 0 | - | ns |  |
|  | SCL, SDA capacitive load | $\mathrm{C}_{\mathrm{b}}$ | - | 400 | pF |  |

Note: $\quad t_{I I C c y c}$ : RIIC internal reference clock (IIC $\varphi$ ) cycle
Note 1. The value in parentheses is used when the ICMR3.NF[1:0] bits are set to 11 b while a digital filter is enabled with the ICFER.NFE bit $=1$.
Note 2. $\quad C_{b}$ is the total capacitance of the bus lines.

### 2.4.5.7 RSPI

Table 2.39 Timing of RSPI
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}, \mathrm{C}=30 \mathrm{pF}$, when high-drive output is selected by the drive capacity control register

| Item |  |  |  | Symbol | Min. | Max. | Unit*1 | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| RSPI | RSPCK clock cycle | Master |  | ${ }^{\text {SPcyc }}$ | 2 | 4096 | $\mathrm{t}_{\text {Pcyc }}$ | Figure 2.62 |
|  |  | Slave |  |  | 6 | - |  |  |
|  | RSPCK clock high pulse width | Master |  | $\mathrm{t}_{\text {SPCKWH }}$ | $\begin{gathered} \left(\mathrm{t}_{\mathrm{SPcyc}}-\mathrm{t}_{\mathrm{SPCKr}}-\right. \\ \left.\mathrm{t}_{\mathrm{SPCKf}}\right) / 2-3 \end{gathered}$ | - | ns |  |
|  |  | Slave |  |  | $\begin{gathered} \left(\mathrm{t}_{\mathrm{SPcyc}}-\mathrm{t}_{\mathrm{SPCKr}}-\right. \\ \left.\mathrm{t}_{\mathrm{SPCKf}}\right) / 2 \end{gathered}$ | - |  |  |
|  | RSPCK clock low pulse width | Master |  | $\mathrm{t}_{\text {SPCKWL }}$ | $\begin{gathered} \left(\mathrm{t}_{\mathrm{SPcyc}}-\mathrm{t}_{\mathrm{SPCKr}}-\right. \\ \left.\mathrm{t}_{\mathrm{SPCKf}}\right) / 2-3 \end{gathered}$ | - | ns |  |
|  |  | Slave |  |  | $\begin{gathered} \left(\mathrm{t}_{\mathrm{SPcyc}}-\mathrm{t}_{\mathrm{SPCKr}}-\right. \\ \left.\mathrm{t}_{\mathrm{SPCKf}}\right) / 2 \end{gathered}$ | - |  |  |
|  | RSPCK clock rise/fall time | Output | $\mathrm{VCC} \geq 2.7 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{SPCKr}}$, ${ }^{\text {t }}$ SPCKf | - | 10 | ns |  |
|  |  |  | $\mathrm{VCC}<2.7 \mathrm{~V}$ |  | - | 15 |  |  |
|  |  | Input |  |  | - | 0.1 | $\mu \mathrm{s} / \mathrm{V}$ |  |
|  | Data input setup time | Master | $\mathrm{VCC} \geq 2.7 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{SU}}$ | 10 | - | ns | Figure 2.63 |
|  |  |  | $\mathrm{VCC}<2.7 \mathrm{~V}$ |  | 30 | - |  |  |
|  |  | Slave |  |  | 25 | - |  |  |
|  | Data input hold time | Master | RSPCK set to a division ratio other than PCLKB divided by 2 | $\mathrm{t}_{\mathrm{H}}$ | $\mathrm{t}_{\text {Pcyc }}$ | - | ns |  |
|  |  |  | RSPCK set to PCLKB divided by 2 | $\mathrm{t}_{\mathrm{HF}}$ | 0 | - |  |  |
|  |  | Slave |  | $\mathrm{t}_{\mathrm{H}}$ | 20 | - |  |  |
|  | SSL setup time | Master |  | $t_{\text {LEAD }}$ | $-30+{ }^{* 2} \times \mathrm{t}_{\text {SPcyc }}$ | - | ns |  |
|  |  | Slave |  |  | 6 | - | $\mathrm{t}_{\text {Pcyc }}$ |  |
|  | SSL hold time | Master |  | $t_{\text {LAG }}$ | $-30+{ }^{* 3} \times \mathrm{t}_{\text {SPcyc }}$ | - | ns |  |
|  |  | Slave |  |  | 6 | - | $\mathrm{t}_{\text {Pcyc }}$ |  |
|  | Data output delay time | Master | $\mathrm{VCC} \geq 2.7 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{OD}}$ | - | 14 | ns |  |
|  |  |  | VCC < 2.7 V |  | - | 30 |  |  |
|  |  | Slave | $\mathrm{VCC} \geq 2.7 \mathrm{~V}$ |  | - | 65 |  |  |
|  |  |  | $\mathrm{VCC}<2.7 \mathrm{~V}$ |  | - | 105 |  |  |
|  | Data output hold time | Master |  | ${ }^{\mathrm{OH}}$ | 0 | - | ns |  |
|  |  | Slave |  |  | 0 | - |  |  |
|  | Successive transmission delay time | Master |  | $\mathrm{t}_{\text {TD }}$ | $\mathrm{t}_{\text {SPcyc }}+2 \times \mathrm{t}_{\text {Pcyc }}$ | $8 \times \mathrm{t}_{\mathrm{t}_{\text {Pcyc }}}+2 \times$ | ns |  |
|  |  | Slave |  |  | $6 \times \mathrm{t}_{\text {Pcyc }}$ | - |  |  |
|  | MOSI and MISO rise/fall time | Output | $\mathrm{VCC} \geq 2.7 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{Dr}}, \mathrm{t}_{\mathrm{Df}}$ | - | 10 | ns |  |
|  |  |  | VCC < 2.7 V |  | - | 15 |  |  |
|  |  | Input |  |  | - | 1 | $\mu \mathrm{s}$ |  |
|  | SSL rise/fall time | Output | $\mathrm{VCC} \geq 2.7 \mathrm{~V}$ | $\begin{aligned} & \mathrm{t}_{\mathrm{SSLr}}, \\ & \mathrm{t}_{\mathrm{SSLf}} \end{aligned}$ | - | 10 | ns |  |
|  |  |  | $\mathrm{VCC}<2.7 \mathrm{~V}$ |  | - | 15 | ns |  |
|  |  | Input |  |  | - | 1 | $\mu \mathrm{s}$ |  |
|  | Slave access time |  | $\mathrm{VCC} \geq 2.7 \mathrm{~V}$ | $\mathrm{t}_{\text {SA }}$ | - | 6 | $\mathrm{t}_{\text {Pcyc }}$ | Figure 2.65, |
|  |  |  | VCC < 2.7 V |  | - | 7 |  | Figure 2.66 |
|  | Slave output release time |  | $\mathrm{VCC} \geq 2.7 \mathrm{~V}$ | $\mathrm{t}_{\text {REL }}$ | - | 5 | $\mathrm{t}_{\text {Pcyc }}$ |  |
|  |  |  | $\mathrm{VCC}<2.7 \mathrm{~V}$ |  | - | 6 |  |  |

Note 1. $t_{\text {Pcyc }}$ : PCLK cycle
Note 2. N : An integer from 1 to 8 that can be set by the RSPI clock delay register (SPCKD)

Note 3. N : An integer from 1 to 8 that can be set by the RSPI slave select negation delay register (SSLND)


Figure $2.59 \quad$ SCK Clock Input Timing ( $n=1,5,6,12$ )


Figure 2.60
SCI Input/Output Timing: Clock Synchronous Mode (n=1, 5, 6, 12)


Figure 2.61 RIIC Bus Interface Input/Output Timing and Simple $I^{2}$ C Bus Interface Input/Output Timing

$\mathrm{V}_{\mathrm{OH}}=0.7 \times \mathrm{VCC}, \mathrm{V}_{\mathrm{OL}}=0.3 \times \mathrm{VCC}, \mathrm{V}_{\mathrm{IH}}=0.7 \times \mathrm{VCC}, \mathrm{V}_{\mathrm{IL}}=0.3 \times \mathrm{VCC}$

Figure 2.62
RSPI Clock Timing and Simple SPI Clock Timing ( $n=1,5,6,12$ )


Figure 2.63
RSPI Timing (Master, CPHA = 0) and Simple SPI Clock Timing (Master, CKPH =1) $(\mathrm{n}=1,5,6,12)$


Figure 2.64
RSPI Timing (Master, CPHA = 1) and Simple SPI Clock Timing (Master, CKPH = 0) ( $\mathrm{n}=1,5,6,12$ )


Figure 2.65
RSPI Timing (Slave, CPHA = 0) and Simple SPI Clock Timing (Slave, CKPH = 1) $(\mathrm{n}=1,5,6,12)$


Figure 2.66
RSPI Timing (Slave, CPHA = 1) and Simple SPI Clock Timing (Slave, CKPH = 0) $(\mathrm{n}=1,5,6,12)$

### 2.4.5.8 A/D converter Trigger

Table 2.40 Timing of AID converter Trigger)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | Min. | Typ. | Max. | Unit ${ }^{\star 11}$ | Test Conditions |
| :--- | :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| A/D <br> converter | Trigger input pulse width | $\mathrm{t}_{\text {TRGW }}$ | 1.5 | - | - | t $_{\text {Pcyc }}$ | Figure 2.67 |

Note 1. $\mathrm{t}_{\text {Pcyc }}$ : PCLK cycle


Figure 2.67 A/D Converter External Trigger Input Timing

### 2.4.5.9 CAC

Table 2.41 Timing of CAC
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  |  | Symbol | Min. | Typ. | Max. | Unit ${ }^{\star 1}$ | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CAC | CACREF input pulse width | $\mathrm{t}_{\text {Pcyc }} \leq \mathrm{t}_{\text {cac }}{ }^{* 2}$ | $t_{\text {CACREF }}$ | $\begin{gathered} 4.5 \mathrm{t}_{\mathrm{cac}}+ \\ 3 \mathrm{t}_{\mathrm{Pcyc}} \end{gathered}$ | - | - | ns |  |
|  |  | $\mathrm{t}_{\text {Pcyc }}>\mathrm{t}_{\text {cac }}{ }^{* 2}$ |  | $\begin{aligned} & 5 \mathrm{t}_{\mathrm{cac}}+ \\ & 6.5 \mathrm{t}_{\mathrm{Pcyc}} \end{aligned}$ | - |  |  |  |
|  | CACREF input rise/fall time |  | $\mathrm{t}_{\text {CACREFF }}$, tcaCREFf | - | - | 0.1 | $\mu \mathrm{s} / \mathrm{V}$ |  |

Note 1. $\mathrm{t}_{\text {Pcyc }}$ : PCLK cycle
Note 2. $\quad t_{\text {cac }}$ : CAC count clock source cycle

### 2.4.5.10 CLKOUT

Table 2.42 Timing of CLKOUT
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  |  | Symbol | Min. | Typ. | Max. | Unit ${ }^{\star 1}$ | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| CLKOUT | CLKOUT pin output cycle*3 | $\mathrm{VCC} \geq 2.7 \mathrm{~V}$ | ${ }_{\text {tcyc }}$ | 62.5 | - | - | ns | Figure 2.68 |
|  |  | $\mathrm{VCC}<2.7 \mathrm{~V}$ |  | 125 | - |  |  |  |
|  | CLKOUT pin high pulse width*2 | $\mathrm{VCC} \geq 2.7 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{CH}}$ | 15 | - | - | ns |  |
|  |  | $\mathrm{VCC}<2.7 \mathrm{~V}$ |  | 30 | - |  |  |  |
|  | CLKOUT pin low pulse width*2 | $\mathrm{VCC} \geq 2.7 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{CL}}$ | 15 | - | - | ns |  |
|  |  | $\mathrm{VCC}<2.7 \mathrm{~V}$ |  | 30 | - |  |  |  |
|  | CLKOUT pin output rise time | $\mathrm{VCC} \geq 2.7 \mathrm{~V}$ | $\mathrm{t}_{\mathrm{Cr}}$ | - | - | 12 | ns |  |
|  |  | $\mathrm{VCC}<2.7 \mathrm{~V}$ |  |  | - | 25 |  |  |
|  | CLKOUT pin output fall time | $\mathrm{VCC} \geq 2.7 \mathrm{~V}$ | $\mathrm{t}_{\text {Cf }}$ | - | - | 12 | ns |  |
|  |  | $\mathrm{VCC}<2.7 \mathrm{~V}$ |  |  | - | 25 |  |  |

Note 1. $\mathrm{t}_{\text {Pcyc }}$ : PCLK cycle
Note 2. When the LOCO is selected as the clock output source (the CKOCR.CKOSEL[2:0] bits are 000b), set the clock output division ratio selection to divided by 2 (the CKOCR.CKODIV[2:0] bits are 001b).
Note 3. When the EXTAL external clock input or an oscillator is used with divided by 1 (the CKOCR.CKOSEL[2:0] bits are 010b and the CKOCR.CKODIV[2:0] bits are 000b) to output from CLKOUT, the above should be satisfied with an input duty cycle of 45 to $55 \%$

CLKOUT pin output


Test conditions: $\mathrm{V}_{\mathrm{OH}}=0.7 \times \mathrm{VCC}, \mathrm{V}_{\mathrm{OL}}=0.3 \times \mathrm{VCC}, \mathrm{I}_{\mathrm{OH}}=-1.0 \mathrm{~mA}, \mathrm{l}_{\mathrm{OL}}=1.0 \mathrm{~mA}, \mathrm{C}=30 \mathrm{pF}$

Figure 2.68
CLKOUT Output Timing

### 2.5 Characteristics of Power-On Reset Circuit and Voltage Detection Circuit

Table 2.43 Characteristics of Power-On Reset Circuit and Voltage Detection Circuit (1)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Voltage detection level | Power-on reset (POR) | $V_{\text {POR }}$ | 1.35 | 1.50 | 1.65 | V | Figure 2.69, Figure 2.70 |
|  | Voltage detection circuit (LVDO) ${ }^{* 1}$ | $\mathrm{V}_{\text {det0_0 }}$ | 3.67 | 3.84 | 3.97 | V | Figure 2.71 <br> At falling edge VCC |
|  |  | $\mathrm{V}_{\text {det0_1 }}$ | 2.70 | 2.82 | 3.00 |  |  |
|  |  | $\mathrm{V}_{\text {det0_2 }}$ | 2.37 | 2.51 | 2.67 |  |  |
|  |  | $\mathrm{V}_{\text {det0_3 }}$ | 1.80 | 1.90 | 1.99 |  |  |
|  | Voltage detection circuit (LVD1)*2 | $\mathrm{V}_{\text {det1_0 }}$ | 4.12 | 4.29 | 4.42 | V |  |
|  |  | $\mathrm{V}_{\text {det1_1 }}$ | 3.98 | 4.14 | 4.28 |  |  |
|  |  | $\mathrm{V}_{\text {det1_2 }}$ | 3.86 | 4.02 | 4.16 |  |  |
|  |  | $\mathrm{V}_{\text {det1_3 }}$ | 3.68 | 3.84 | 3.98 |  |  |
|  |  | $\mathrm{V}_{\text {det1_4 }}$ | 2.99 | 3.10 | 3.29 |  |  |
|  |  | $\mathrm{V}_{\text {det1_5 }}$ | 2.89 | 3.00 | 3.19 |  |  |
|  |  | $\mathrm{V}_{\text {det1_6 }}$ | 2.79 | 2.90 | 3.09 |  |  |
|  |  | $\mathrm{V}_{\text {det1_7 }}$ | 2.68 | 2.79 | 2.98 |  |  |
|  |  | $\mathrm{V}_{\text {det1_8 }}$ | 2.57 | 2.68 | 2.87 |  |  |
|  |  | $\mathrm{V}_{\text {det1_9 }}$ | 2.47 | 2.58 | 2.67 |  |  |
|  |  | $\mathrm{V}_{\text {det1_A }}$ | 2.37 | 2.48 | 2.57 |  |  |
|  |  | $V_{\text {det1_B }}$ | 2.10 | 2.20 | 2.30 |  |  |
|  |  | $V_{\text {det1_C }}$ | 1.86 | 1.96 | 2.06 |  |  |
|  |  | $V_{\text {det1_D }}$ | 1.80 | 1.86 | 1.96 |  |  |
|  | Voltage detection circuit (LVD2)*3 | $\mathrm{V}_{\text {det2_0 }}$ | 4.08 | 4.29 | 4.48 | V | Figure 2.72 <br> At falling edge VCC <br> Figure 2.73 <br> At falling edge VCC |
|  |  | $\mathrm{V}_{\text {det2_1 }}$ | 3.95 | 4.14 | 4.35 |  |  |
|  |  | $\mathrm{V}_{\text {det2_2 }}$ | 3.82 | 4.02 | 4.22 |  |  |
|  |  | $\mathrm{V}_{\text {det2_3 }}$ | 3.62 | 3.84 | 4.02 |  |  |

Note: These characteristics apply when noise is not superimposed on the power supply. When a setting is made so that the voltage detection level overlaps with that of the voltage detection circuit (LVD2), it cannot be specified which of LVD1 and LVD2 is used for voltage detection.
Note 1. n in the symbol Vdet0_n denotes the value of the OFS1.VDSEL[1:0] bits.
Note 2. n in the symbol Vdet1_n denotes the value of the LVDLVLR.LVD1LVL[3:0] bits.
Note 3. $n$ in the symbol Vdet2_n denotes the value of the LVDLVLR.LVD2LVL[1:0] bits.

Table 2.44 Characteristics of Power-On Reset Circuit and Voltage Detection Circuit (2)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Wait time after release from the power-on reset | At normal startup | $\mathrm{t}_{\text {POR }}$ | - | 9.1 | - | ms | Figure 2.70 |
|  | During fast startup time | $\mathrm{t}_{\mathrm{POR}}$ | - | 1.6 | - |  |  |
| Wait time after release from voltage monitoring 0 reset |  | $\mathrm{t}_{\text {LVDO }}$ | - | 600 | - | $\mu \mathrm{s}$ | Figure 2.71 |
| Wait time after release from voltage monitoring 1 reset |  | $t_{\text {LVD1 }}$ | - | 150 | - | $\mu \mathrm{s}$ | Figure 2.72 |
| Wait time after release from voltage monitoring 2 reset |  | $t_{\text {LVD2 }}$ | - | 150 | - | $\mu \mathrm{s}$ | Figure 2.73 |
| Response delay time |  | $\mathrm{t}_{\text {det }}$ | - | - | 350 | $\mu \mathrm{s}$ | Figure 2.69 |
| Minimum VCC down time*1 |  | $\mathrm{t}_{\text {VOFF }}$ | 350 | - | - | $\mu \mathrm{s}$ | Figure 2.69, VCC $=1.0 \mathrm{~V}$ or above |
| Power-on reset enable time |  | ${ }^{\text {W }}$ (POR) | 1 | - | - | ms | Figure 2.70, VCC = below 1.0 V |
| LVD operation stabilization time (after LVD is enabled) |  | $\mathrm{Td}_{(\mathrm{E}-\mathrm{A})}$ | - | - | 300 | $\mu \mathrm{s}$ | Figure 2.72, Figure 2.73 |
| Hysteresis width (power-on rest (POR)) |  | $\mathrm{V}_{\text {PORH }}$ | - | 110 | - | mV |  |
| Hysteresis width (voltage detection circuit: LVDO, LVD1 and LVD2) |  | $\mathrm{V}_{\text {LVH }}$ | - | 70 | - | mV | When Vdet1_0 to Vdet1_4 is selected |
|  |  | - | 60 | - | When Vdet1_5 to Vdet1_9 is selected |  |  |
|  |  | - | 50 | - | When Vdet1_A or Vdet1_B is selected |  |  |
|  |  | - | 40 | - | When Vdet1_C or Vdet1_D is selected |  |  |
|  |  | - | 60 | - | When LVD0 or LVD2 is selected |  |  |

Note: These characteristics apply when noise is not superimposed on the power supply. When a setting is made so that the voltage detection level overlaps with that of the voltage detection circuit (LVD1), it cannot be specified which of LVD1 and LVD2 is used for voltage detection.
Note 1. The minimum VCC down time indicates the time when VCC is below the minimum value of voltage detection levels $\mathrm{V}_{\mathrm{POR}}, \mathrm{V}_{\text {deto }}$, $V_{\text {det1 }}$, and $V_{\text {det2 }}$ for the POR/LVD.


Figure 2.69 Voltage Detection Reset Timing


Note 1. $t_{w(P O R)}$ is the time required for a power-on reset to be enabled while the external power VCC is being held below the valid voltage (1.0 V)
When turning the VCC on, maintain a voltage below 1.0 V for at least 1.0 ms .

Figure 2.70
Power-On Reset Timing


Figure 2.71
Voltage Detection Circuit Timing (Vdet0)


Figure 2.72
Voltage Detection Circuit Timing ( $\mathrm{V}_{\text {det1 }}$ )


Figure 2.73 Voltage Detection Circuit Timing ( $\mathrm{V}_{\text {det2 }}$ )

### 2.6 Oscillation Stop Detection Timing

Table 2.45 Oscillation Stop Detection Timing
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=\mathrm{VREFLO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

|  | Item | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Detection time | $\mathrm{t}_{\mathrm{dr}}$ | - | - | 1 | ms | Figure 2.74 |  |



Figure 2.74 Oscillation Stop Detection Timing

### 2.7 ROM (Code Flash Memory) Characteristics

Table 2.46 ROM (Code Flash Memory) Characteristics (1)

| Item |  | Symbol | Min. | Typ. | Max. | Unit | Conditions |
| :--- | :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Program/erase cycles*1 | $\mathrm{N}_{\text {PEC }}$ | 1000 | - | - | Times |  |  |
| Data retention | After 1000 times of erase | $\mathrm{t}_{\text {DRP }}$ | $20^{* 2, * 3}$ | - | - | Year | $\mathrm{T}_{\mathrm{a}}=85^{\circ} \mathrm{C}$ |

Note 1. Definition of program/erase cycle:
The program/erase cycle is the number of erasing for each block. When the number of program/erase cycles is n , each block can be erased $n$ times. For instance, when 4-byte program is performed 256 times for different addresses in a 1-Kbyte block and then the block is erased, the program/erase cycle is counted as one. However, the same address cannot be programmed more than once before the next erase cycle (overwriting is prohibited).
Note 2. Characteristic when using the flash programmer and the self-programming library provided from Renesas Electronics.
Note 3. This result is obtained from reliability testing.

Table 2.47 ROM (Code Flash Memory) Characteristics (2) (High-Speed Operating Mode)
Conditions: $2.7 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}$, VSS $=\mathrm{AVSSO}=0 \mathrm{~V}$
Temperature range for the programming/erasure operation: $\mathrm{T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | FCLK = 1 MHz |  |  | FCLK $=32 \mathrm{MHz}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. | Min. | Typ. | Max. |  |
| Program time | 8-byte |  | $\mathrm{t}_{\mathrm{P} 8}$ | - | 112.0 | 967.0 | - | 52.3 | 490.5 | $\mu \mathrm{s}$ |
| Erase time | 2-Kbyte | $\mathrm{t}_{\mathrm{E} 2 \mathrm{~K}}$ | - | 8.7 | 278.1 | - | 5.5 | 214.6 | ms |
|  | 256-Kbyte <br> (when block erase command is used) | $\mathrm{t}_{\mathrm{E} 256 \mathrm{~K}}$ | - | 469.1 | 9813.6 | - | 41.2 | 1049.2 | ms |
|  | 256-Kbyte <br> (when all-block erase command is used) | $\mathrm{t}_{\text {EA256K }}$ | - | 463.9 | 9609.0 | - | 36.0 | 839.5 | ms |
| Blank check time | 8-byte | $\mathrm{t}_{\mathrm{BC} 8}$ | - | - | 55.0 | - | - | 16.1 | $\mu \mathrm{s}$ |
|  | 2-Kbyte | $\mathrm{t}_{\mathrm{BC} 2 \mathrm{~K}}$ | - | - | 1840.0 | - | - | 135.7 | $\mu \mathrm{s}$ |
| Erase operation forced stop time |  | $\mathrm{t}_{\text {SED }}$ | - | - | 18.0 | - | - | 10.7 | $\mu \mathrm{s}$ |
| Start-up area switching time |  | $\mathrm{t}_{\text {SAS }}$ | - | 12.3 | 566.5 | - | 6.2 | 433.5 | ms |
| Access window setting time |  | $\mathrm{t}_{\text {AWS }}$ | - | 12.3 | 566.5 | - | 6.2 | 433.5 | ms |
| ROM mode transition wait time 1 |  | $t_{\text {DIS }}$ | 2.0 | - | - | 2.0 | - | - | $\mu \mathrm{s}$ |
| ROM mode transition wait time 2 |  | $\mathrm{t}_{\mathrm{MS}}$ | 5.0 | - | - | 5.0 | - | - | $\mu \mathrm{s}$ |

Note: $\quad$ The time until each operation of the flash memory is started after instructions are executed by software is not included.
Note: The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz , the frequency can be set to $1 \mathrm{MHz}, 2 \mathrm{MHz}$, or 3 MHz . A non-integer frequency such as 1.5 MHz cannot be set.
Note: The frequency accuracy of FCLK must be within $\pm 3.5 \%$.

Table 2.48 ROM (Code Flash Memory) Characteristics (3) (Middle-Speed Operating Mode)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}$, VSS $=\mathrm{AVSSO}=0 \mathrm{~V}$
Temperature range for the programming/erasure operation: $\mathrm{T}_{\mathrm{a}}=-40$ to $+85^{\circ} \mathrm{C}$

| Item |  | Symbol | FCLK $=1 \mathrm{MHz}$ |  |  | FCLK $=8 \mathrm{MHz}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. | Min. | Typ. | Max. |  |
| Program time | 8-byte |  | $\mathrm{t}_{\text {P8 }}$ | - | 152.0 | 1367.0 | - | 97.9 | 936.0 | $\mu \mathrm{s}$ |
| Erase time | 2-Kbyte | $\mathrm{t}_{\mathrm{E} 2 \mathrm{~K}}$ | - | 8.8 | 279.7 | - | 5.9 | 220.8 | ms |
|  | 256-Kbyte (when block erase command is used) | $\mathrm{t}_{\text {E256K }}$ | - | 469.2 | 9816.9 | - | 100.5 | 2260.1 | ms |
|  | 256-Kbyte (when all-block erase command is used) | $\mathrm{t}_{\text {EA256K }}$ | - | 464.0 | 9610.7 | - | 95.3 | 2053.7 | ms |
| Blank check time | 8 -byte | $\mathrm{t}_{\mathrm{BC} 8}$ | - | - | 85.0 | - | - | 50.9 | $\mu \mathrm{s}$ |
|  | 2-Kbyte | $\mathrm{t}_{\mathrm{BC} 2 \mathrm{~K}}$ | - | - | 1870.0 | - | - | 401.5 | $\mu \mathrm{s}$ |
| Erase operation forced stop time |  | $\mathrm{t}_{\text {SED }}$ | - | - | 28.0 | - | - | 21.3 | $\mu \mathrm{s}$ |
| Start-up area switching time |  | $\mathrm{t}_{\text {SAS }}$ | - | 13.0 | 573.3 | - | 7.7 | 450.1 | ms |
| Access window setting time |  | $\mathrm{t}_{\text {AWS }}$ | - | 13.0 | 573.3 | - | 7.7 | 450.1 | ms |
| ROM mode transition wait time 1 |  | $\mathrm{t}_{\text {DIS }}$ | 2.0 | - | - | 2.0 | - | - | $\mu \mathrm{s}$ |
| ROM mode transition wait time 2 |  | $\mathrm{t}_{\text {MS }}$ | 3.0 | - | - | 3.0 | - | - | $\mu \mathrm{s}$ |

Note: The time until each operation of the flash memory is started after instructions are executed by software is not included.
Note: The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz , the frequency can be set to $1 \mathrm{MHz}, 2 \mathrm{MHz}$, or 3 MHz . A non-integer frequency such as 1.5 MHz cannot be set.
Note: The frequency accuracy of FCLK must be within $\pm 3.5 \%$.

## $2.8 \quad$ E2 DataFlash (Data Flash Memory) Characteristics

Table 2.49 E2 DataFlash Characteristics (1)

| Item |  | Symbol | Min. | Typ. | Max. | Unit | Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Program/erase cycles*1 |  | $\mathrm{N}_{\text {DPEC }}$ | 100000 | 1000000 | - | Times |  |
| Data retention | After 10000 times of erase | $\mathrm{t}_{\text {DDRP }}$ | $20 * 2$, *3 | - | - | Year | $\mathrm{T}_{\mathrm{a}}=85^{\circ} \mathrm{C}$ |
|  | After 100000 times of erase |  | 5*2, *3 | - | - | Year |  |
|  | After 1000000 times of erase |  | - | $1 * 2, * 3$ | - | Year | $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ |

Note 1. Definition of program/erase cycle:
The program/erase cycle is the number of erasing for each block. When the number of program/erase cycle is n , each block can be erased $n$ times. For instance, when 1-byte program is performed 1000 times for different addresses in a 1-Kbyte block and then the block is erased, the program/erase cycle is counted as one. However, the same address cannot be programmed more than once before the next erase cycle (overwriting is prohibited).
Note 2. Characteristic when the flash programmer is used and the self-programming library is provided from Renesas Electronics.
Note 3. These results are obtained from reliability testing.

Table 2.50 E2 DataFlash Characteristics (2) (High-Speed Operating Mode)
Conditions: $2.7 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}$
Temperature range for the programming/erasure operation: $T_{a}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | FCLK = 1 MHz |  |  | FCLK $=32 \mathrm{MHz}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. | Min. | Typ. | Max. |  |
| Program time | 1 byte |  | $\mathrm{t}_{\mathrm{DP} 1}$ | - | 95.0 | 797.0 | - | 40.8 | 375.5 | $\mu \mathrm{s}$ |
| Erase time | 1 Kbyte | $t_{\text {DE1K }}$ | - | 19.5 | 498.5 | - | 6.2 | 229.4 | ms |
|  | 8 Kbyte | $\mathrm{t}_{\text {DE8K }}$ | - | 119.8 | 2555.7 | - | 12.9 | 367.2 | ms |
| Blank check time | 1 byte | $\mathrm{t}_{\mathrm{DBC} 1}$ | - | - | 55.0 | - | - | 16.1 | $\mu \mathrm{s}$ |
|  | 1 Kbyte | $\mathrm{t}_{\text {DBC1K }}$ | - | - | 7216.0 | - | - | 495.7 | $\mu \mathrm{s}$ |
| Erase operation forced stop time |  | $\mathrm{t}_{\text {DSED }}$ | - | - | 16.0 | - | - | 10.7 | $\mu \mathrm{s}$ |
| DataFlash STOP | y time | $t_{\text {DSTOP }}$ | 5.0 | - | - | 5.0 | - | - | $\mu \mathrm{s}$ |

Note: The time until each operation of the flash memory is started after instructions are executed by software is not included.
Note: The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz , the frequency can be set to $1 \mathrm{MHz}, 2 \mathrm{MHz}$, or 3 MHz . A non-integer frequency such as 1.5 MHz cannot be set.
Note: The frequency accuracy of FCLK must be within $\pm 3.5 \%$.

Table 2.51 E2 DataFlash Characteristics (3) (Middle-Speed Operating Mode)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC}=\mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}$
Temperature range for the programming/erasure operation: $\mathrm{T}_{\mathrm{a}}=-40$ to $+85^{\circ} \mathrm{C}$

| Item |  | Symbol | FCLK $=1 \mathrm{MHz}$ |  |  | FCLK $=8 \mathrm{MHz}$ |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  | Min. | Typ. | Max. | Min. | Typ. | Max. |  |
| Programming time | 1 byte |  | $\mathrm{t}_{\text {DP1 }}$ | - | 135.0 | 1197.0 | - | 86.5 | 822.5 | $\mu \mathrm{s}$ |
| Erasure time | 1 Kbyte | $t_{\text {DE1K }}$ | - | 19.6 | 500.1 | - | 8.0 | 264.1 | ms |
|  | 8 Kbyte | $\mathrm{t}_{\text {DE8K }}$ | - | 119.9 | 2557.4 | - | 27.7 | 668.2 | ms |
| Blank check time | 1 byte | $\mathrm{t}_{\text {DBC1 }}$ | - | - | 85.0 | - | - | 50.9 | $\mu \mathrm{s}$ |
|  | 1 Kbyte | $\mathrm{t}_{\text {DBC1K }}$ | - | - | 7246.0 | - | - | 1457.5 | $\mu \mathrm{s}$ |
| Erase operation forced stop time |  | $t_{\text {dSED }}$ | - | - | 28.0 | - | - | 21.3 | $\mu \mathrm{s}$ |
| DataFlash STOP re | ry time | $\mathrm{t}_{\text {DSTOP }}$ | 0.72 | - | - | 0.72 | - | - | $\mu \mathrm{s}$ |

Note: The time until each operation of the flash memory is started after instructions are executed by software is not included.
Note: The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz , the frequency can be set to $1 \mathrm{MHz}, 2 \mathrm{MHz}$, or 3 MHz . A non-integer frequency such as 1.5 MHz cannot be set.
Note: The frequency accuracy of FCLK must be within $\pm 3.5 \%$.

### 2.9 24-Bit Delta-Sigma A/D Converter Characteristics

Table 2.52 24-Bit Delta-Sigma A/D Converter Characteristics
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC} \leq 5.5 \mathrm{~V}, 2.7 \mathrm{~V} \leq \mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=2.5 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Gain |  | Gain | 1, 2, 4, 8, 16, 32, 64, 128 |  |  | - |  |
| Output data rate | Normal mode | $\mathrm{f}_{\mathrm{DR}}$ | 7.6 | - | 15625 | SPS |  |
|  | Low power mode |  | 1.9 | - | 3906 |  |  |
| Resolution (no missing codes) |  | - | 24 | - | - | Bits |  |
| RMS noise |  | $\mathrm{V}_{\mathrm{N}}$ | - | Table 2.53, Table 2.55 | - | - | Figure 2.75 to Figure 2.91 |
| Integral nonlinearity | Gain = 1 (PGA enabled), Normal/low power mode, OPCR.DSADLVM bit = 0 | INL | - | $\pm 7$ | $\pm 15$ | ppmFSR | Figure 2.92, Figure 2.93 AVCCO $=3.6$ to 5.5 V |
|  | $\text { Gain }=2 \text { to } 64,$ <br> Normal/low power mode, OPCR.DSADLVM bit = 0 |  | - | $\pm 4$ | $\pm 15$ |  |  |
|  | Gain = 128, <br> Normal mode, OPCR.DSADLVM bit $=0$ |  | - | $\pm 5$ | $\pm 15$ |  |  |
|  | Gain = 128, <br> Low power mode, OPCR.DSADLVM bit = 0 |  | - | $\pm 7$ | $\pm 20$ |  |  |
|  | Gain = 1 to 128 <br> (PGA enabled), <br> Normal/low power mode, OPCR.DSADLVM bit = 1 |  | - | $\pm 7$ | $\pm 30$ |  | AVCC0 $=2.7$ to 5.5 V |
|  | $\text { Gain = } 1$ <br> (PGA disabled, BUF disabled) |  | - | $\pm 7$ | $\pm 20$ |  | $\begin{aligned} & \text { AVCCO }=2.7 \text { to } 5.5 \mathrm{~V}, \\ & \mathrm{~V}_{1}<2.6 \mathrm{~V} \end{aligned}$ |
|  | $\text { Gain = } 1$ <br> (PGA disabled, BUF enabled) |  | - | $\pm 7$ | - |  |  |
| Offset error | Before calibration | $\mathrm{E}_{\mathrm{O}}$ | - | - | $\pm 10$ | $\mu \mathrm{V}$ | Figure 2.94 <br> $\mathrm{AVCCO}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$, <br> Normal mode, Gain $=2$ |
|  | After calibration |  | - | Less than or equal to the RMS noise | - |  |  |
| Offset drift | Gain = 1 or 2 (PGA enabled) | $\mathrm{dE}_{\mathrm{O}}$ | - | 60 | 220 | $\mathrm{nV} /{ }^{\circ} \mathrm{C}$ | Figure 2.94 |
|  | Gain $=4$ to 8 |  | - | 40 | 140 |  |  |
|  | Gain = 16 to 32 |  | - | 15 | 40 |  |  |
|  | Gain $=64$ to 128 |  | - | 10 | 25 |  |  |
|  | $\text { Gain = } 1$ <br> (PGA disabled, BUF disabled) |  | - | 50 | 140 |  |  |
| Gain error | $\begin{aligned} & \text { Gain = } 1 \text { to } 64 \\ & \text { (PGA enabled) } \end{aligned}$ | $\mathrm{E}_{G}$ | - | $\pm 0.01$ | $\pm 0.03$ | \% | Figure 2.95$\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ |
|  | Gain = 128 |  | - | $\pm 0.01$ | $\pm 0.04$ |  |  |
|  | $\text { Gain = } 1$ <br> (PGA disabled, BUF disabled) |  | - | $\pm 0.015$ | $\pm 0.04$ |  |  |
|  | $\text { Gain = } 1$ <br> (PGA disabled, BUF enabled) |  | - | $\pm 0.03$ | - |  |  |
|  | After calibration of gain errors |  | - | Less than or equal to the RMS noise | - |  |  |


| Item |  | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Gain drift | $\begin{aligned} & \text { Gain = } 1 \text { to } 128 \\ & \text { (PGA enabled), } \\ & \text { OPCR.DSADLVM bit }=0 \end{aligned}$ | $\mathrm{dE}_{\mathrm{G}}$ | - | 1 | 3 | ppm/ ${ }^{\circ} \mathrm{C}$ | Figure 2.95 |
|  | $\begin{aligned} & \text { Gain = } 1 \text { to } 128 \\ & \text { (PGA enabled), } \\ & \text { OPCR.DSADLVM bit }=1 \end{aligned}$ |  | - | 1 | 5 |  | AVCCO $=3.0$ to 5.5 V |
|  |  |  | - | - | 10 |  | AVCC0 < 3.0 V |
|  | Gain $=1$ (PGA disabled) |  | - | 1.4 | - |  | Figure 2.95 $V_{1}<2.6 \mathrm{~V}$ |
| Power supply rejection ratio | Gain = 1 (PGA enabled) | PSRR | 80 | 88 | - | dB | $\mathrm{V}_{\text {ID }}=1 \mathrm{~V} /$ Gain (DC) |
|  | Gain $=2$ to 16 |  | 89 | 95 | - |  |  |
|  | Gain $=32$ to 128 |  | 102 | 115 | - |  |  |
|  | $\text { Gain = } 1$ <br> (PGA disabled, BUF disabled) |  | 68 | 88 | - |  | $\mathrm{V}_{\text {ID }}=1 \mathrm{~V}(\mathrm{DC})$ |
|  | $\text { Gain = } 1$ <br> (PGA disabled, BUF enabled) |  | - | 78 | - |  |  |
| Common mode rejection ratio | Gain = 1 to 8 (PGA enabled), OPCR.DSADLVM bit = 0 | CMRR | 95 | 100 | - | dB | $\mathrm{V}_{\text {ID }}=1 \mathrm{~V} / \mathrm{Gain}(\mathrm{DC})$ |
|  | $\begin{aligned} & \text { Gain = } 16 \text { to } 32, \\ & \text { OPCR.DSADLVM bit = } 0 \end{aligned}$ |  | 110 | 120 | - |  |  |
|  | $\begin{aligned} & \text { Gain = } 64 \text { to } 128 \text {, } \\ & \text { OPCR.DSADLVM bit }=0 \end{aligned}$ |  | 120 | 130 | - |  |  |
|  | Gain = 1 to 8 (PGA enabled), OPCR.DSADLVM bit = 1 |  | 80 | 100 | - |  |  |
|  | $\begin{aligned} & \text { Gain = } 16 \text { to 32, } \\ & \text { OPCR.DSADLVM bit = } 1 \end{aligned}$ |  | 88 | 120 | - |  |  |
|  | $\begin{aligned} & \text { Gain = } 64 \text { to } 128 \text {, } \\ & \text { OPCR.DSADLVM bit = } \end{aligned}$ |  | 100 | 130 | - |  |  |
|  | $\text { Gain = } 1$ <br> (PGA disabled, BUF disabled) |  | 60 | 88 | - |  | $\mathrm{V}_{\mathrm{ID}}=1 \mathrm{~V}$ (DC) |
|  | $\text { Gain = } 1$ <br> (PGA disabled, BUF enabled) |  | - | 78 | - |  |  |
| Normal mode rejection ratio | External clock, $50 \mathrm{~Hz}, 60 \mathrm{~Hz}$ | NMRR | 120 | - | - | dB | $\begin{aligned} & 10 \mathrm{SPS}, 50 \pm 1 \mathrm{~Hz}, \\ & 60 \pm 1 \mathrm{~Hz} \end{aligned}$ |
|  |  |  | 75 | - | - |  | $\begin{aligned} & 54 \mathrm{SPS}, 50 \pm 1 \mathrm{~Hz} \\ & 60 \pm 1 \mathrm{~Hz} \end{aligned}$ |
|  | External clock, 50 Hz |  | 120 | - | - |  | 50SPS, $50 \pm 1 \mathrm{~Hz}$ |
|  | External clock, 60 Hz |  | 120 | - | - |  | 60 SPS, $60 \pm 1 \mathrm{~Hz}$ |
|  | $\begin{aligned} & \text { Internal clock (HOCO), } \\ & 50 \mathrm{~Hz}, 60 \mathrm{~Hz} \end{aligned}$ |  | 110 | - | - |  | $\begin{aligned} & 10 \mathrm{SPS}, 50 \pm 1 \mathrm{~Hz} \\ & 60 \pm 1 \mathrm{~Hz} \end{aligned}$ |
|  |  |  | 70 | - | - |  | $\begin{aligned} & 54 \mathrm{SPS}, 50 \pm 1 \mathrm{~Hz} \\ & 60 \pm 1 \mathrm{~Hz} \end{aligned}$ |
|  | Internal clock (HOCO), 50 Hz |  | 110 | - | - |  | 50 SPS, $50 \pm 1 \mathrm{~Hz}$ |
|  | Internal clock (HOCO), 60 Hz |  | 110 | - | - |  | 60 SPS, $60 \pm 1 \mathrm{~Hz}$ |
| Burnout current |  | $\mathrm{I}_{\mathrm{BO}}$ | 0.5, 2, 4, 20 |  |  | $\mu \mathrm{A}$ |  |
| Modulator clock | Normal mode | $\mathrm{f}_{\text {MOD }}$ | 430 | 500 | 570 | kHz |  |
|  | Low power mode |  | 107.5 | 125.0 | 142.5 |  |  |

Table 2.53 Typical Noise Characteristics (Normal Mode)
Conditions: $\quad \mathrm{AVCCO}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{MOD}}=500 \mathrm{kHz}, \mathrm{V}_{\mathrm{ID}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=2.5 \mathrm{~V}$

| $\begin{gathered} \mathrm{f}_{\mathrm{DR}} \\ (\mathrm{SPS}) \end{gathered}$ | OSR | $\begin{aligned} & \text { Gain = } 1 \\ & \text { (Bypass) } \end{aligned}$ | $\begin{gathered} \hline \text { Gain }=1 \\ \text { (BUF) } \end{gathered}$ | $\begin{gathered} \text { Gain = } 1 \\ (\text { PGA }) \end{gathered}$ | Gain $=2$ | Gain $=4$ | Gain $=8$ | Gain $=16$ | Gain $=32$ | Gain $=64$ | Gain $=128$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 7.6 | 65536 | $\begin{aligned} & \hline 0.383 \\ & (2.39) \end{aligned}$ | $\begin{aligned} & \hline 0.524 \\ & (2.69) \end{aligned}$ | $\begin{aligned} & \hline 0.601 \\ & (3.89) \end{aligned}$ | $\begin{aligned} & \hline 0.563 \\ & (3.59) \end{aligned}$ | $\begin{aligned} & \hline 0.284 \\ & (2.02) \end{aligned}$ | $\begin{aligned} & \hline 0.166 \\ & (1.08) \end{aligned}$ | $\begin{aligned} & \hline 0.097 \\ & (0.60) \end{aligned}$ | $\begin{aligned} & \hline 0.052 \\ & (0.34) \end{aligned}$ | $\begin{aligned} & \hline 0.036 \\ & (0.28) \end{aligned}$ | $\begin{aligned} & \hline 0.029 \\ & (0.20) \end{aligned}$ |
| 10 | 50048 | $\begin{aligned} & 0.426 \\ & (2.64) \end{aligned}$ | $\begin{aligned} & \hline 0.671 \\ & (3.96) \end{aligned}$ | $\begin{aligned} & 0.680 \\ & (4.40) \end{aligned}$ | $\begin{aligned} & 0.618 \\ & (4.18) \end{aligned}$ | $\begin{aligned} & 0.322 \\ & (2.53) \end{aligned}$ | $\begin{aligned} & 0.185 \\ & (1.15) \end{aligned}$ | $\begin{aligned} & 0.108 \\ & (0.71) \end{aligned}$ | $\begin{aligned} & 0.056 \\ & (0.40) \end{aligned}$ | $\begin{aligned} & \hline 0.041 \\ & (0.27) \end{aligned}$ | $\begin{aligned} & 0.033 \\ & (0.20) \end{aligned}$ |
| 50 | 9984 | $\begin{aligned} & \hline 0.878 \\ & (5.42) \end{aligned}$ | $\begin{aligned} & 1.117 \\ & (7.59) \end{aligned}$ | $\begin{aligned} & 1.308 \\ & (9.76) \end{aligned}$ | $\begin{aligned} & 1.196 \\ & (7.59) \end{aligned}$ | $\begin{aligned} & 0.667 \\ & (5.15) \end{aligned}$ | $\begin{aligned} & 0.369 \\ & (2.51) \end{aligned}$ | $\begin{aligned} & 0.230 \\ & (1.69) \end{aligned}$ | $\begin{aligned} & \hline 0.121 \\ & (0.92) \end{aligned}$ | $\begin{aligned} & 0.084 \\ & (0.61) \end{aligned}$ | $\begin{aligned} & 0.072 \\ & (0.52) \end{aligned}$ |
| 54 | 9216 | $\begin{aligned} & \hline 0.929 \\ & (6.35) \end{aligned}$ | $\begin{aligned} & 1.225 \\ & (9.71) \end{aligned}$ | $\begin{aligned} & \hline 1.359 \\ & (10.5) \end{aligned}$ | $\begin{aligned} & 1.254 \\ & (9.52) \end{aligned}$ | $\begin{aligned} & \hline 0.702 \\ & (4.85) \end{aligned}$ | $\begin{aligned} & \hline 0.392 \\ & (2.85) \end{aligned}$ | $\begin{aligned} & \hline 0.240 \\ & (1.70) \end{aligned}$ | $\begin{aligned} & \hline 0.127 \\ & (0.88) \end{aligned}$ | $\begin{aligned} & \hline 0.090 \\ & (0.59) \end{aligned}$ | $\begin{aligned} & \hline 0.076 \\ & (0.51) \end{aligned}$ |
| 60 | 8320 | $\begin{aligned} & 0.973 \\ & (7.31) \end{aligned}$ | $\begin{aligned} & 1.279 \\ & (8.99) \end{aligned}$ | $\begin{aligned} & 1.450 \\ & (10.7) \end{aligned}$ | $\begin{aligned} & 1.345 \\ & (9.27) \end{aligned}$ | $\begin{aligned} & 0.723 \\ & (4.50) \end{aligned}$ | $\begin{aligned} & 0.426 \\ & (3.30) \end{aligned}$ | $\begin{aligned} & 0.258 \\ & (1.48) \end{aligned}$ | $\begin{aligned} & 0.129 \\ & (1.07) \end{aligned}$ | $\begin{aligned} & 0.093 \\ & (0.59) \end{aligned}$ | $\begin{aligned} & 0.080 \\ & (0.58) \end{aligned}$ |
| 100 | 4992 | $\begin{aligned} & 1.228 \\ & (8.67) \end{aligned}$ | $\begin{aligned} & 1.673 \\ & (11.4) \end{aligned}$ | $\begin{aligned} & 1.873 \\ & (13.0) \end{aligned}$ | $\begin{aligned} & 1.673 \\ & (9.76) \end{aligned}$ | $\begin{aligned} & \hline 0.904 \\ & (5.96) \end{aligned}$ | $\begin{aligned} & \hline 0.536 \\ & (3.46) \end{aligned}$ | $\begin{aligned} & \hline 0.327 \\ & (2.41) \end{aligned}$ | $\begin{aligned} & \hline 0.172 \\ & (1.19) \end{aligned}$ | $\begin{aligned} & \hline 0.128 \\ & (0.96) \end{aligned}$ | $\begin{aligned} & \hline 0.100 \\ & (0.68) \end{aligned}$ |
| 195 | 2560 | $\begin{aligned} & 1.681 \\ & (12.7) \end{aligned}$ | $\begin{aligned} & 2.206 \\ & (18.6) \end{aligned}$ | $\begin{aligned} & 2.530 \\ & (16.7) \end{aligned}$ | $\begin{aligned} & \hline 2.378 \\ & (16.7) \end{aligned}$ | $\begin{aligned} & \hline 1.277 \\ & (8.45) \end{aligned}$ | $\begin{aligned} & 0.710 \\ & (4.65) \end{aligned}$ | $\begin{aligned} & 0.460 \\ & (3.15) \end{aligned}$ | $\begin{aligned} & \hline 0.238 \\ & (1.55) \end{aligned}$ | $\begin{aligned} & \hline 0.176 \\ & (1.16) \end{aligned}$ | $\begin{aligned} & 0.139 \\ & (0.90) \end{aligned}$ |
| 488 | 1024 | $\begin{aligned} & 2.697 \\ & (17.3) \end{aligned}$ | $\begin{aligned} & 3.311 \\ & (22.4) \end{aligned}$ | $\begin{aligned} & 3.954 \\ & (29.3) \end{aligned}$ | $\begin{aligned} & 3.881 \\ & (27.4) \end{aligned}$ | $\begin{aligned} & 2.007 \\ & (13.5) \end{aligned}$ | $\begin{aligned} & 1.175 \\ & (8.52) \end{aligned}$ | $\begin{aligned} & 0.723 \\ & (4.73) \end{aligned}$ | $\begin{aligned} & 0.355 \\ & (2.28) \end{aligned}$ | $\begin{aligned} & 0.264 \\ & (1.80) \end{aligned}$ | $\begin{aligned} & 0.231 \\ & (1.55) \end{aligned}$ |
| 977 | 512 | $\begin{aligned} & 3.691 \\ & (27.5) \end{aligned}$ | $\begin{aligned} & 4.740 \\ & (29.0) \end{aligned}$ | $\begin{aligned} & 5.758 \\ & (36.5) \end{aligned}$ | $\begin{aligned} & 5.442 \\ & (35.7) \end{aligned}$ | $\begin{aligned} & 2.871 \\ & (20.0) \end{aligned}$ | $\begin{aligned} & 1.656 \\ & (12.0) \end{aligned}$ | $\begin{aligned} & 1.025 \\ & (6.67) \end{aligned}$ | $\begin{aligned} & 0.522 \\ & (3.53) \end{aligned}$ | $\begin{aligned} & 0.389 \\ & (2.57) \end{aligned}$ | $\begin{aligned} & \hline 0.321 \\ & (2.21) \end{aligned}$ |
| 1953 | 256 | $\begin{aligned} & 5.734 \\ & (35.3) \end{aligned}$ | $\begin{aligned} & 6.572 \\ & (42.5) \end{aligned}$ | $\begin{aligned} & \hline 8.535 \\ & (55.3) \end{aligned}$ | $\begin{aligned} & 7.438 \\ & (48.9) \end{aligned}$ | $\begin{aligned} & 4.130 \\ & (28.2) \end{aligned}$ | $\begin{aligned} & 2.308 \\ & (15.8) \end{aligned}$ | $\begin{aligned} & 1.434 \\ & (9.34) \end{aligned}$ | $\begin{aligned} & 0.768 \\ & (4.85) \end{aligned}$ | $\begin{aligned} & 0.567 \\ & (4.05) \end{aligned}$ | $\begin{aligned} & 0.476 \\ & (2.71) \end{aligned}$ |
| 3906 | 128 | $\begin{aligned} & 7.446 \\ & (51.1) \end{aligned}$ | $\begin{aligned} & 9.607 \\ & (65.8) \end{aligned}$ | $\begin{aligned} & 12.32 \\ & (70.0) \end{aligned}$ | $\begin{aligned} & 11.15 \\ & (76.5) \end{aligned}$ | $\begin{aligned} & 5.778 \\ & (38.6) \end{aligned}$ | $\begin{aligned} & 3.476 \\ & (27.2) \end{aligned}$ | $\begin{aligned} & 2.237 \\ & (14.7) \end{aligned}$ | $\begin{aligned} & 1.162 \\ & (7.83) \end{aligned}$ | $\begin{aligned} & 0.831 \\ & (5.98) \end{aligned}$ | $\begin{aligned} & 0.669 \\ & (4.21) \end{aligned}$ |
| 7813 | 64 | $\begin{aligned} & 13.60 \\ & (102) \end{aligned}$ | $\begin{aligned} & 15.91 \\ & (110) \end{aligned}$ | $\begin{aligned} & 21.39 \\ & (143) \end{aligned}$ | $\begin{aligned} & 19.22 \\ & (120) \end{aligned}$ | $\begin{aligned} & 10.43 \\ & (67.6) \end{aligned}$ | $\begin{aligned} & 5.971 \\ & (39.0) \end{aligned}$ | $\begin{aligned} & \hline 3.760 \\ & (26.4) \end{aligned}$ | $\begin{aligned} & 2.161 \\ & (13.9) \end{aligned}$ | $\begin{aligned} & 1.482 \\ & (11.0) \end{aligned}$ | $\begin{aligned} & 1.112 \\ & (6.96) \end{aligned}$ |
| 15625 | 32 | $\begin{aligned} & 120.5 \\ & (644) \end{aligned}$ | $\begin{aligned} & 117.5 \\ & (720) \end{aligned}$ | $\begin{aligned} & 112.5 \\ & (735) \end{aligned}$ | $\begin{aligned} & 67.81 \\ & (347) \end{aligned}$ | $\begin{aligned} & 36.42 \\ & (218) \end{aligned}$ | $\begin{aligned} & 17.96 \\ & (109) \end{aligned}$ | $\begin{aligned} & 9.766 \\ & (58.7) \end{aligned}$ | $\begin{aligned} & 5.812 \\ & (37.6) \end{aligned}$ | $\begin{aligned} & 3.726 \\ & (22.2) \end{aligned}$ | $\begin{aligned} & 2.498 \\ & (16.9) \end{aligned}$ |

Note: "Bypass" indicates the state where both PGA and BUF are disabled, "BUF" indicates the state where PGA is disabled and BUF is enabled, and "PGA" indicates the state where PGA is enabled.
Note: $\quad$ The upper rows indicate RMS noise ( $\mu \mathrm{V}_{\mathrm{RMS}}$ ) and the lower rows (in parentheses) indicate peak-to-peak noise ( $\mu \mathrm{V}_{\mathrm{PP}}$ ).

Table 2.54 Effective Resolution (Normal Mode)
Conditions: $\quad \mathrm{AVCCO}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{MOD}}=500 \mathrm{kHz}, \mathrm{V}_{\mathrm{ID}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=2.5 \mathrm{~V}$

| $\begin{gathered} \hline \mathrm{f}_{\mathrm{DR}} \\ (\mathrm{SPS}) \end{gathered}$ | OSR | $\begin{aligned} & \hline \text { Gain = } 1 \\ & \text { (Bypass) } \end{aligned}$ | $\begin{gathered} \hline \text { Gain }=1 \\ \text { (BUF) } \end{gathered}$ | $\begin{gathered} \hline \text { Gain =1 } \\ (\mathrm{PGA}) \end{gathered}$ | Gain $=2$ | Gain $=4$ | Gain $=8$ | Gain $=16$ | Gain $=32$ | Gain $=64$ | Gain $=128$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 7.6 | 65536 | $\begin{gathered} \hline 23.6 \\ (21.0) \end{gathered}$ | $\begin{gathered} \hline 23.1 \\ (20.8) \end{gathered}$ | $\begin{gathered} \hline 23.0 \\ (20.3) \end{gathered}$ | $\begin{gathered} 22.1 \\ (19.4) \end{gathered}$ | $\begin{gathered} \hline 22.1 \\ (19.2) \end{gathered}$ | $\begin{gathered} \hline 21.8 \\ (19.1) \end{gathered}$ | $\begin{gathered} \hline 21.6 \\ (19.0) \end{gathered}$ | $\begin{gathered} \hline 21.5 \\ (18.8) \end{gathered}$ | $\begin{gathered} \hline 21.0 \\ (18.1) \end{gathered}$ | $\begin{gathered} \hline 20.4 \\ (17.6) \end{gathered}$ |
| 10 | 50048 | $\begin{gathered} 23.5 \\ (20.9) \end{gathered}$ | $\begin{gathered} 22.8 \\ (20.2) \end{gathered}$ | $\begin{gathered} 22.8 \\ (20.1) \end{gathered}$ | $\begin{gathered} 22.0 \\ (19.2) \end{gathered}$ | $\begin{gathered} 21.9 \\ (18.9) \end{gathered}$ | $\begin{gathered} 21.7 \\ (19.1) \end{gathered}$ | $\begin{gathered} 21.5 \\ (18.7) \end{gathered}$ | $\begin{gathered} 21.4 \\ (18.6) \end{gathered}$ | $\begin{gathered} 20.9 \\ (18.2) \end{gathered}$ | $\begin{gathered} 20.2 \\ (17.6) \end{gathered}$ |
| 50 | 9984 | $\begin{gathered} \hline 22.4 \\ (19.8) \end{gathered}$ | $\begin{gathered} \hline 22.0 \\ (19.3) \end{gathered}$ | $\begin{gathered} \hline 21.9 \\ (19.0) \end{gathered}$ | $\begin{gathered} \hline 21.0 \\ (18.3) \end{gathered}$ | $\begin{gathered} 20.8 \\ (17.9) \end{gathered}$ | $\begin{gathered} 20.7 \\ (17.9) \end{gathered}$ | $\begin{gathered} 20.4 \\ (17.5) \end{gathered}$ | $\begin{gathered} 20.3 \\ (17.4) \end{gathered}$ | $\begin{gathered} 19.8 \\ (17.0) \end{gathered}$ | $\begin{gathered} \hline 19.0 \\ (16.2) \end{gathered}$ |
| 54 | 9216 | $\begin{gathered} \hline 22.4 \\ (19.6) \end{gathered}$ | $\begin{gathered} \hline 21.9 \\ (18.9) \end{gathered}$ | $\begin{gathered} \hline 21.8 \\ (18.9) \end{gathered}$ | $\begin{gathered} 20.9 \\ (18.0) \end{gathered}$ | $\begin{gathered} \hline 20.8 \\ (18.0) \end{gathered}$ | $\begin{gathered} \hline 20.6 \\ (17.7) \end{gathered}$ | $\begin{gathered} \hline 20.3 \\ (17.5) \end{gathered}$ | $\begin{gathered} \hline 20.2 \\ (17.5) \end{gathered}$ | $\begin{gathered} \hline 19.7 \\ (17.0) \end{gathered}$ | $\begin{gathered} \hline 19.0 \\ (16.2) \end{gathered}$ |
| 60 | 8320 | $\begin{gathered} 22.3 \\ (19.4) \end{gathered}$ | $\begin{gathered} 21.8 \\ (19.0) \end{gathered}$ | $\begin{gathered} 21.7 \\ (18.8) \end{gathered}$ | $\begin{gathered} 20.8 \\ (18.0) \end{gathered}$ | $\begin{gathered} 20.7 \\ (18.1) \end{gathered}$ | $\begin{gathered} 20.5 \\ (17.5) \end{gathered}$ | $\begin{gathered} 20.2 \\ (17.7) \end{gathered}$ | $\begin{gathered} 20.2 \\ (17.2) \end{gathered}$ | $\begin{gathered} 19.7 \\ (17.0) \end{gathered}$ | $\begin{gathered} 18.9 \\ (16.1) \end{gathered}$ |
| 100 | 4992 | $\begin{gathered} \hline 22.0 \\ (19.1) \end{gathered}$ | $\begin{gathered} \hline 21.5 \\ (18.7) \end{gathered}$ | $\begin{gathered} \hline 21.4 \\ (18.6) \end{gathered}$ | $\begin{gathered} \hline 20.5 \\ (18.0) \end{gathered}$ | $\begin{gathered} \hline 20.4 \\ (17.7) \end{gathered}$ | $\begin{gathered} 20.2 \\ (17.5) \end{gathered}$ | $\begin{gathered} \hline 19.9 \\ (17.0) \end{gathered}$ | $\begin{gathered} \hline 19.8 \\ (17.0) \end{gathered}$ | $\begin{gathered} \hline 19.2 \\ (16.3) \end{gathered}$ | $\begin{gathered} \hline 18.6 \\ (15.8) \end{gathered}$ |
| 195 | 2560 | $\begin{gathered} \hline 21.5 \\ (18.6) \end{gathered}$ | $\begin{gathered} 21.1 \\ (18.0) \end{gathered}$ | $\begin{gathered} \hline 21.0 \\ (18.2) \end{gathered}$ | $\begin{gathered} 20.0 \\ (17.2) \end{gathered}$ | $\begin{gathered} \hline 19.9 \\ (17.2) \end{gathered}$ | $\begin{gathered} \hline 19.8 \\ (17.0) \end{gathered}$ | $\begin{gathered} \hline 19.4 \\ (16.6) \end{gathered}$ | $\begin{gathered} 19.3 \\ (16.6) \end{gathered}$ | $\begin{gathered} 18.8 \\ (16.0) \end{gathered}$ | $\begin{gathered} 18.1 \\ (15.4) \end{gathered}$ |
| 488 | 1024 | $\begin{gathered} 20.8 \\ (18.1) \end{gathered}$ | $\begin{gathered} 20.5 \\ (17.7) \end{gathered}$ | $\begin{gathered} 20.3 \\ (17.4) \end{gathered}$ | $\begin{gathered} 19.3 \\ (16.5) \end{gathered}$ | $\begin{gathered} 19.3 \\ (16.5) \end{gathered}$ | $\begin{gathered} 19.0 \\ (16.2) \end{gathered}$ | $\begin{gathered} 18.7 \\ (16.0) \end{gathered}$ | $\begin{gathered} 18.8 \\ (16.1) \end{gathered}$ | $\begin{gathered} 18.2 \\ (15.4) \end{gathered}$ | $\begin{gathered} 17.4 \\ (14.6) \end{gathered}$ |
| 977 | 512 | $\begin{gathered} \hline 20.4 \\ (17.5) \end{gathered}$ | $\begin{gathered} 20.0 \\ (17.3) \end{gathered}$ | $\begin{gathered} 19.7 \\ (17.1) \end{gathered}$ | $\begin{gathered} \hline 18.8 \\ (16.1) \end{gathered}$ | $\begin{gathered} \hline 18.7 \\ (15.9) \end{gathered}$ | $\begin{gathered} \hline 18.5 \\ (15.7) \end{gathered}$ | $\begin{gathered} \hline 18.2 \\ (15.5) \end{gathered}$ | $\begin{gathered} 18.2 \\ (15.4) \end{gathered}$ | $\begin{gathered} \hline 17.6 \\ (14.9) \end{gathered}$ | $\begin{gathered} \hline 16.9 \\ (14.1) \end{gathered}$ |
| 1953 | 256 | $\begin{gathered} \hline 19.7 \\ (17.1) \end{gathered}$ | $\begin{gathered} 19.5 \\ (16.8) \end{gathered}$ | $\begin{gathered} 19.2 \\ (16.5) \end{gathered}$ | $\begin{gathered} \hline 18.4 \\ (15.6) \end{gathered}$ | $\begin{gathered} \hline 18.2 \\ (15.4) \end{gathered}$ | $\begin{gathered} 18.1 \\ (15.3) \end{gathered}$ | $\begin{gathered} \hline 17.7 \\ (15.0) \end{gathered}$ | $\begin{gathered} \hline 17.6 \\ (15.0) \end{gathered}$ | $\begin{gathered} 17.1 \\ (14.2) \end{gathered}$ | $\begin{gathered} 16.3 \\ (13.8) \end{gathered}$ |
| 3906 | 128 | $\begin{gathered} 19.4 \\ (16.6) \end{gathered}$ | $\begin{gathered} 18.9 \\ (16.2) \end{gathered}$ | $\begin{gathered} 18.6 \\ (16.1) \end{gathered}$ | $\begin{gathered} 17.8 \\ (15.0) \end{gathered}$ | $\begin{gathered} 17.7 \\ (15.0) \end{gathered}$ | $\begin{gathered} 17.5 \\ (14.5) \end{gathered}$ | $\begin{gathered} 17.1 \\ (14.4) \end{gathered}$ | $\begin{gathered} 17.0 \\ (14.3) \end{gathered}$ | $\begin{gathered} 16.5 \\ (13.7) \end{gathered}$ | $\begin{gathered} 15.8 \\ (13.2) \end{gathered}$ |
| 7813 | 64 | $\begin{gathered} \hline 18.5 \\ (15.6) \end{gathered}$ | $\begin{gathered} \hline 18.2 \\ (15.4) \end{gathered}$ | $\begin{gathered} 17.8 \\ (15.1) \end{gathered}$ | $\begin{gathered} 17.0 \\ (14.3) \end{gathered}$ | $\begin{gathered} 16.9 \\ (14.2) \end{gathered}$ | $\begin{gathered} \hline 16.7 \\ (14.0) \end{gathered}$ | $\begin{gathered} 16.3 \\ (13.5) \end{gathered}$ | $\begin{gathered} \hline 16.1 \\ (13.5) \end{gathered}$ | $\begin{gathered} 15.7 \\ (12.8) \end{gathered}$ | $\begin{gathered} 15.1 \\ (12.5) \end{gathered}$ |
| 15625 | 32 | $\begin{gathered} \hline 15.3 \\ (12.9) \end{gathered}$ | $\begin{gathered} 15.3 \\ (12.7) \end{gathered}$ | $\begin{gathered} \hline 15.4 \\ (12.7) \end{gathered}$ | $\begin{gathered} 15.2 \\ (12.8) \end{gathered}$ | $\begin{gathered} 15.1 \\ (12.5) \end{gathered}$ | $\begin{gathered} 15.1 \\ (12.5) \end{gathered}$ | $\begin{gathered} 15.0 \\ (12.4) \end{gathered}$ | $\begin{gathered} \hline 14.7 \\ (12.0) \end{gathered}$ | $\begin{gathered} \hline 14.4 \\ (11.8) \end{gathered}$ | $\begin{gathered} 13.9 \\ (11.2) \end{gathered}$ |

Effective resolution $=\log _{2}$ (full-scale voltage/RMS noise)
Noise-free resolution $=\log _{2}$ (full-scale voltage/peak-to-peak noise)
Note: "Bypass" indicates the state where both PGA and BUF are disabled, "BUF" indicates the state where PGA is disabled and BUF is enabled, and "PGA" indicates the state where PGA is enabled.
Note: The upper rows indicate effective resolution (bits) and the lower rows (in parentheses) indicate noise-free resolution (bits).

Table 2.55 Typical Noise Characteristics (Low Power Mode)
Conditions: $\mathrm{AVCCO}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{MOD}}=125 \mathrm{kHz}, \mathrm{V}_{\mathrm{ID}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=2.5 \mathrm{~V}$

| $\begin{gathered} \hline \mathrm{f}_{\mathrm{DR}} \\ (\mathrm{SPS}) \end{gathered}$ | OSR | $\begin{aligned} & \hline \text { Gain }=1 \\ & \text { (Bypass) } \\ & \hline \end{aligned}$ | $\begin{gathered} \hline \text { Gain }=1 \\ \text { (BUF) } \end{gathered}$ | $\begin{gathered} \text { Gain = } 1 \\ \text { (PGA) } \end{gathered}$ | Gain $=2$ | Gain $=4$ | Gain $=8$ | Gain $=16$ | Gain $=32$ | Gain $=64$ | Gain $=128$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1.9 | 65536 | $\begin{aligned} & \hline 0.463 \\ & (3.29) \end{aligned}$ | $\begin{aligned} & \hline 0.640 \\ & (4.19) \end{aligned}$ | $\begin{aligned} & \hline 0.892 \\ & (5.38) \end{aligned}$ | $\begin{aligned} & \hline 0.708 \\ & (4.63) \end{aligned}$ | $\begin{aligned} & \hline 0.444 \\ & (2.62) \end{aligned}$ | $\begin{aligned} & \hline 0.245 \\ & (1.72) \end{aligned}$ | $\begin{aligned} & \hline 0.140 \\ & (0.90) \end{aligned}$ | $\begin{aligned} & \hline 0.070 \\ & (0.47) \end{aligned}$ | $\begin{aligned} & \hline 0.048 \\ & (0.34) \end{aligned}$ | $\begin{aligned} & \hline 0.038 \\ & (0.25) \end{aligned}$ |
| 10 | 12512 | $\begin{aligned} & 1.053 \\ & (7.03) \end{aligned}$ | $\begin{aligned} & 1.313 \\ & (8.79) \end{aligned}$ | $\begin{aligned} & 1.596 \\ & (11.4) \end{aligned}$ | $\begin{aligned} & 1.492 \\ & (10.6) \end{aligned}$ | $\begin{aligned} & 0.797 \\ & (5.27) \end{aligned}$ | $\begin{aligned} & 0.437 \\ & (2.86) \end{aligned}$ | $\begin{aligned} & 0.286 \\ & (1.79) \end{aligned}$ | $\begin{aligned} & 0.143 \\ & (1.00) \end{aligned}$ | $\begin{aligned} & 0.109 \\ & (0.72) \end{aligned}$ | $\begin{aligned} & 0.085 \\ & (0.61) \end{aligned}$ |
| 50 | 2496 | $\begin{aligned} & \hline 2.412 \\ & (15.7) \end{aligned}$ | $\begin{aligned} & 2.883 \\ & (18.4) \end{aligned}$ | $\begin{aligned} & \hline 3.390 \\ & (21.7) \end{aligned}$ | $\begin{aligned} & \hline 3.093 \\ & (22.5) \end{aligned}$ | $\begin{aligned} & 1.669 \\ & (11.0) \end{aligned}$ | $\begin{aligned} & 0.954 \\ & (5.96) \end{aligned}$ | $\begin{aligned} & \hline 0.592 \\ & (3.86) \end{aligned}$ | $\begin{aligned} & \hline 0.317 \\ & (2.35) \end{aligned}$ | $\begin{aligned} & \hline 0.228 \\ & (1.69) \end{aligned}$ | $\begin{aligned} & \hline 0.187 \\ & (1.22) \end{aligned}$ |
| 54 | 2304 | $\begin{aligned} & 2.558 \\ & (19.4) \end{aligned}$ | $\begin{aligned} & 3.098 \\ & (20.5) \end{aligned}$ | $\begin{aligned} & \hline 3.544 \\ & (23.9) \end{aligned}$ | $\begin{aligned} & 3.139 \\ & (19.4) \end{aligned}$ | $\begin{aligned} & 1.719 \\ & (11.3) \end{aligned}$ | $\begin{aligned} & 0.962 \\ & (6.39) \end{aligned}$ | $\begin{aligned} & \hline 0.637 \\ & (3.92) \end{aligned}$ | $\begin{aligned} & \hline 0.333 \\ & (2.12) \end{aligned}$ | $\begin{aligned} & 0.242 \\ & (1.81) \end{aligned}$ | $\begin{aligned} & \hline 0.199 \\ & (1.39) \end{aligned}$ |
| 60 | 2080 | $\begin{aligned} & 2.491 \\ & (16.3) \end{aligned}$ | $\begin{aligned} & \hline 3.230 \\ & (20.8) \end{aligned}$ | $\begin{aligned} & \hline 3.598 \\ & (26.4) \end{aligned}$ | $\begin{aligned} & \hline 3.348 \\ & (25.0) \end{aligned}$ | $\begin{aligned} & 1.810 \\ & (13.6) \end{aligned}$ | $\begin{aligned} & 1.024 \\ & (7.38) \end{aligned}$ | $\begin{aligned} & 0.645 \\ & (4.50) \end{aligned}$ | $\begin{aligned} & \hline 0.346 \\ & (2.30) \end{aligned}$ | $\begin{aligned} & 0.257 \\ & (1.88) \end{aligned}$ | $\begin{aligned} & 0.207 \\ & (1.37) \end{aligned}$ |
| 100 | 1248 | $\begin{aligned} & 3.237 \\ & (21.7) \end{aligned}$ | $\begin{aligned} & 3.843 \\ & (26.6) \end{aligned}$ | $\begin{aligned} & 4.794 \\ & (32.5) \end{aligned}$ | $\begin{aligned} & 4.274 \\ & (27.1) \end{aligned}$ | $\begin{aligned} & 2.319 \\ & (15.3) \end{aligned}$ | $\begin{aligned} & 1.357 \\ & (9.35) \end{aligned}$ | $\begin{aligned} & 0.872 \\ & (6.37) \end{aligned}$ | $\begin{aligned} & 0.454 \\ & (2.98) \end{aligned}$ | $\begin{aligned} & \hline 0.338 \\ & (2.29) \end{aligned}$ | $\begin{aligned} & 0.268 \\ & (1.83) \end{aligned}$ |
| 195 | 640 | $\begin{aligned} & \hline 4.663 \\ & (37.7) \end{aligned}$ | $\begin{aligned} & \hline 5.666 \\ & (37.7) \end{aligned}$ | $\begin{aligned} & \hline 6.826 \\ & (46.5) \end{aligned}$ | $\begin{aligned} & \hline 5.799 \\ & (39.7) \end{aligned}$ | $\begin{aligned} & \hline 3.245 \\ & (21.3) \end{aligned}$ | $\begin{aligned} & \hline 1.930 \\ & (12.9) \end{aligned}$ | $\begin{aligned} & \hline 1.164 \\ & (7.50) \end{aligned}$ | $\begin{aligned} & \hline 0.627 \\ & (4.61) \end{aligned}$ | $\begin{aligned} & \hline 0.474 \\ & (3.31) \end{aligned}$ | $\begin{aligned} & \hline 0.371 \\ & (2.68) \end{aligned}$ |
| 488 | 256 | $\begin{aligned} & 7.451 \\ & (46.6) \end{aligned}$ | $\begin{aligned} & 9.151 \\ & (62.5) \end{aligned}$ | $\begin{aligned} & 10.30 \\ & (70.9) \end{aligned}$ | $\begin{aligned} & 9.404 \\ & (59.6) \end{aligned}$ | $\begin{aligned} & 5.216 \\ & (35.7) \end{aligned}$ | $\begin{aligned} & 2.934 \\ & (20.2) \end{aligned}$ | $\begin{aligned} & 1.869 \\ & (13.6) \end{aligned}$ | $\begin{aligned} & 1.006 \\ & (6.13) \end{aligned}$ | $\begin{aligned} & 0.729 \\ & (5.46) \end{aligned}$ | $\begin{aligned} & \hline 0.599 \\ & (4.56) \end{aligned}$ |
| 977 | 128 | $\begin{aligned} & 10.37 \\ & (72.4) \end{aligned}$ | $\begin{aligned} & \hline 13.13 \\ & (83.1) \end{aligned}$ | $\begin{gathered} 15.63 \\ (111) \end{gathered}$ | $\begin{aligned} & 13.71 \\ & (93.3) \end{aligned}$ | $\begin{aligned} & \hline 7.605 \\ & (63.0) \end{aligned}$ | $\begin{aligned} & 4.383 \\ & (30.3) \end{aligned}$ | $\begin{aligned} & \hline 2.796 \\ & (18.0) \end{aligned}$ | $\begin{aligned} & \hline 1.510 \\ & (9.78) \end{aligned}$ | $\begin{aligned} & 1.099 \\ & (7.60) \end{aligned}$ | $\begin{aligned} & \hline 0.908 \\ & (7.23) \end{aligned}$ |
| 1953 | 64 | $\begin{aligned} & 16.80 \\ & (117) \end{aligned}$ | $\begin{aligned} & 19.92 \\ & (153) \end{aligned}$ | $\begin{aligned} & 25.41 \\ & (177) \end{aligned}$ | $\begin{aligned} & 22.23 \\ & (138) \end{aligned}$ | $\begin{aligned} & 12.30 \\ & (94.9) \end{aligned}$ | $\begin{aligned} & \hline 7.226 \\ & (50.9) \end{aligned}$ | $\begin{aligned} & 4.520 \\ & (30.6) \end{aligned}$ | $\begin{aligned} & \hline 2.531 \\ & (16.2) \end{aligned}$ | $\begin{aligned} & 1.927 \\ & (13.6) \end{aligned}$ | $\begin{aligned} & \hline 1.499 \\ & (11.1) \end{aligned}$ |
| 3906 | 32 | $\begin{aligned} & 120.9 \\ & (720) \end{aligned}$ | $\begin{aligned} & 120.4 \\ & (761) \end{aligned}$ | $\begin{aligned} & 126.6 \\ & (634) \end{aligned}$ | $\begin{aligned} & 73.29 \\ & (507) \end{aligned}$ | $\begin{aligned} & 36.82 \\ & (216) \end{aligned}$ | $\begin{aligned} & 19.83 \\ & (124) \end{aligned}$ | $\begin{aligned} & 11.22 \\ & (78.4) \end{aligned}$ | $\begin{aligned} & 6.332 \\ & (39.1) \end{aligned}$ | $\begin{aligned} & 4.427 \\ & (27.3) \end{aligned}$ | $\begin{aligned} & 3.143 \\ & (20.0) \end{aligned}$ |

Note: "Bypass" indicates the state where both PGA and BUF are disabled, "BUF" indicates the state where PGA is disabled and BUF is enabled, and "PGA" indicates the state where PGA is enabled.
Note: The upper rows indicate RMS noise ( $\mu \mathrm{V}_{\mathrm{RMS}}$ ) and the lower rows (in parentheses) indicate peak-to-peak noise ( $\mu \mathrm{V}_{\mathrm{PP}}$ ).

Table 2.56 Effective Resolution (Low Power Mode)
Conditions: $\quad \mathrm{AVCCO}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C}, \mathrm{f}_{\mathrm{MOD}}=125 \mathrm{kHz}, \mathrm{V}_{\mathrm{ID}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=2.5 \mathrm{~V}$

| $\begin{gathered} \hline \mathrm{f}_{\mathrm{DR}} \\ (\mathrm{SPS}) \end{gathered}$ | OSR | Gain = 1 <br> (Bypass) | $\begin{gathered} \text { Gain =1 } \\ \text { (BUF) } \end{gathered}$ | $\begin{gathered} \text { Gain = } \\ \text { (PGA) } \end{gathered}$ | Gain $=2$ | Gain $=4$ | Gain $=8$ | Gain = 16 | Gain $=32$ | Gain $=64$ | Gain $=128$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| 1.9 | 65536 | $\begin{gathered} \hline 23.4 \\ (20.5) \end{gathered}$ | $\begin{gathered} \hline 22.8 \\ (20.1) \end{gathered}$ | $\begin{gathered} 22.4 \\ (19.8) \end{gathered}$ | $\begin{gathered} \hline 21.8 \\ (19.0) \end{gathered}$ | $\begin{gathered} \hline 21.4 \\ (18.9) \end{gathered}$ | $\begin{gathered} 21.3 \\ (18.5) \end{gathered}$ | $\begin{gathered} \hline 21.1 \\ (18.4) \end{gathered}$ | $\begin{gathered} 21.1 \\ (18.4) \end{gathered}$ | $\begin{gathered} 20.6 \\ (17.8) \end{gathered}$ | $\begin{gathered} 20.0 \\ (17.3) \end{gathered}$ |
| 10 | 12512 | $\begin{gathered} 22.2 \\ (19.4) \end{gathered}$ | $\begin{gathered} 21.8 \\ (19.1) \end{gathered}$ | $\begin{gathered} 21.6 \\ (18.7) \end{gathered}$ | $\begin{gathered} 20.7 \\ (17.9) \end{gathered}$ | $\begin{gathered} 20.6 \\ (17.9) \end{gathered}$ | $\begin{gathered} 20.5 \\ (17.7) \end{gathered}$ | $\begin{gathered} 20.1 \\ (17.4) \end{gathered}$ | $\begin{gathered} 20.1 \\ (17.3) \end{gathered}$ | $\begin{gathered} 19.5 \\ (16.7) \end{gathered}$ | $\begin{gathered} 18.8 \\ (16.0) \end{gathered}$ |
| 50 | 2496 | $\begin{gathered} \hline 21.0 \\ (18.3) \end{gathered}$ | $\begin{gathered} \hline 20.7 \\ (18.0) \end{gathered}$ | $\begin{gathered} \hline 20.5 \\ (17.8) \end{gathered}$ | $\begin{gathered} \hline 19.6 \\ (16.8) \end{gathered}$ | $\begin{gathered} \hline 19.5 \\ (16.8) \end{gathered}$ | $\begin{gathered} 19.3 \\ (16.7) \end{gathered}$ | $\begin{gathered} \hline 19.0 \\ (16.3) \end{gathered}$ | $\begin{gathered} \hline 18.9 \\ (16.0) \end{gathered}$ | $\begin{gathered} \hline 18.4 \\ (15.5) \end{gathered}$ | $\begin{gathered} \hline 17.7 \\ (15.0) \end{gathered}$ |
| 54 | 2304 | $\begin{gathered} \hline 20.9 \\ (18.0) \end{gathered}$ | $\begin{gathered} 20.6 \\ (17.8) \end{gathered}$ | $\begin{gathered} 20.4 \\ (17.7) \end{gathered}$ | $\begin{gathered} \hline 19.6 \\ (17.0) \end{gathered}$ | $\begin{gathered} \hline 19.5 \\ (16.8) \end{gathered}$ | $\begin{gathered} 19.3 \\ (16.6) \end{gathered}$ | $\begin{gathered} \hline 18.9 \\ (16.3) \end{gathered}$ | $\begin{gathered} 18.8 \\ (16.2) \end{gathered}$ | $\begin{gathered} 18.3 \\ (15.4) \end{gathered}$ | $\begin{gathered} \hline 17.6 \\ (14.8) \end{gathered}$ |
| 60 | 2080 | $\begin{gathered} 20.9 \\ (18.2) \end{gathered}$ | $\begin{gathered} 20.5 \\ (17.8) \end{gathered}$ | $\begin{gathered} 20.4 \\ (17.5) \end{gathered}$ | $\begin{gathered} 19.5 \\ (16.6) \end{gathered}$ | $\begin{gathered} 19.4 \\ (16.5) \end{gathered}$ | $\begin{gathered} 19.2 \\ (16.4) \end{gathered}$ | $\begin{gathered} 18.9 \\ (16.1) \end{gathered}$ | $\begin{gathered} 18.8 \\ (16.1) \end{gathered}$ | $\begin{gathered} 18.2 \\ (15.3) \end{gathered}$ | $\begin{gathered} 17.5 \\ (14.8) \end{gathered}$ |
| 100 | 1248 | $\begin{gathered} 20.6 \\ (17.8) \end{gathered}$ | $\begin{gathered} 20.3 \\ (17.5) \end{gathered}$ | $\begin{gathered} \hline 20.0 \\ (17.2) \end{gathered}$ | $\begin{gathered} 19.2 \\ (16.5) \end{gathered}$ | $\begin{gathered} \hline 19.0 \\ (16.3) \end{gathered}$ | $\begin{gathered} \hline 18.8 \\ (16.0) \\ \hline \end{gathered}$ | $\begin{gathered} \hline 18.5 \\ (15.6) \\ \hline \end{gathered}$ | $\begin{gathered} \hline 18.4 \\ (15.7) \end{gathered}$ | $\begin{gathered} \hline 17.8 \\ (15.1) \end{gathered}$ | $\begin{gathered} \hline 17.2 \\ (14.4) \end{gathered}$ |
| 195 | 640 | $\begin{gathered} 20.0 \\ (17.0) \end{gathered}$ | $\begin{gathered} \hline 19.7 \\ (17.0) \end{gathered}$ | $\begin{gathered} 19.5 \\ (16.7) \end{gathered}$ | $\begin{gathered} \hline 18.7 \\ (15.9) \end{gathered}$ | $\begin{gathered} \hline 18.6 \\ (15.8) \end{gathered}$ | $\begin{gathered} \hline 18.3 \\ (15.6) \end{gathered}$ | $\begin{gathered} 18.0 \\ (15.4) \end{gathered}$ | $\begin{gathered} \hline 17.9 \\ (15.1) \end{gathered}$ | $\begin{gathered} 17.3 \\ (14.5) \end{gathered}$ | $\begin{gathered} \hline 16.7 \\ (13.8) \end{gathered}$ |
| 488 | 256 | $\begin{gathered} 19.4 \\ (16.7) \end{gathered}$ | $\begin{gathered} 19.0 \\ (16.2) \end{gathered}$ | $\begin{gathered} 18.9 \\ (16.1) \end{gathered}$ | $\begin{gathered} 18.0 \\ (15.4) \end{gathered}$ | $\begin{gathered} 17.9 \\ (15.1) \end{gathered}$ | $\begin{gathered} 17.7 \\ (14.9) \end{gathered}$ | $\begin{gathered} 17.4 \\ (14.5) \end{gathered}$ | $\begin{gathered} 17.3 \\ (14.6) \end{gathered}$ | $\begin{gathered} 16.7 \\ (13.8) \end{gathered}$ | $\begin{gathered} 16.0 \\ (13.1) \end{gathered}$ |
| 977 | 128 | $\begin{gathered} 18.9 \\ (16.1) \end{gathered}$ | $\begin{gathered} \hline 18.5 \\ (15.8) \end{gathered}$ | $\begin{gathered} \hline 18.3 \\ (15.4) \end{gathered}$ | $\begin{gathered} \hline 17.5 \\ (14.7) \end{gathered}$ | $\begin{gathered} \hline 17.3 \\ (14.3) \end{gathered}$ | $\begin{gathered} \hline 17.1 \\ (14.3) \end{gathered}$ | $\begin{gathered} \hline 16.8 \\ (14.1) \end{gathered}$ | $\begin{gathered} \hline 16.7 \\ (14.0) \end{gathered}$ | $\begin{gathered} \hline 16.1 \\ (13.3) \end{gathered}$ | $\begin{gathered} 15.4 \\ (12.4) \end{gathered}$ |
| 1953 | 64 | $\begin{gathered} 18.2 \\ (15.4) \end{gathered}$ | $\begin{gathered} \hline 17.9 \\ (14.9) \end{gathered}$ | $\begin{gathered} \hline 17.6 \\ (14.8) \end{gathered}$ | $\begin{gathered} \hline 16.8 \\ (14.2) \end{gathered}$ | $\begin{gathered} \hline 16.6 \\ (13.7) \end{gathered}$ | $\begin{gathered} \hline 16.4 \\ (13.6) \end{gathered}$ | $\begin{gathered} \hline 16.1 \\ (13.3) \end{gathered}$ | $\begin{gathered} \hline 15.9 \\ (13.2) \end{gathered}$ | $\begin{gathered} 15.3 \\ (12.5) \end{gathered}$ | $\begin{gathered} \hline 14.7 \\ (11.8) \end{gathered}$ |
| 3906 | 32 | $\begin{gathered} 15.3 \\ (12.8) \end{gathered}$ | $\begin{gathered} 15.3 \\ (12.6) \end{gathered}$ | $\begin{gathered} 15.3 \\ (12.9) \end{gathered}$ | $\begin{gathered} 15.1 \\ (12.3) \end{gathered}$ | $\begin{gathered} 15.1 \\ (12.5) \end{gathered}$ | $\begin{gathered} 14.9 \\ (12.3) \end{gathered}$ | $\begin{gathered} 14.8 \\ (12.0) \end{gathered}$ | $\begin{gathered} 14.6 \\ (12.0) \end{gathered}$ | $\begin{gathered} 14.1 \\ (11.5) \end{gathered}$ | $\begin{gathered} 13.6 \\ (10.9) \end{gathered}$ |

Effective resolution $=\log _{2}$ (full-scale voltage/RMS noise)
Noise-free resolution $=\log _{2}$ (full-scale voltage/peak-to-peak noise)
Note: "Bypass" indicates the state where both PGA and BUF are disabled, "BUF" indicates the state where PGA is disabled and BUF is enabled, and "PGA" indicates the state where PGA is enabled.
Note: The upper rows indicate effective resolution (bits) and the lower rows (in parentheses) indicate noise-free resolution (bits).

Table 2.57 24-Bit Delta-Sigma AID Converter Analog Input Characteristics
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC} \leq 5.5 \mathrm{~V}, 2.7 \mathrm{~V} \leq \mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Differential input voltage range | Gain = 1 (PGA disabled) | $\mathrm{V}_{\text {IDR }}$ | - $\mathrm{V}_{\text {REF }}$ | - | $+\mathrm{V}_{\text {REF }}$ | V | $\begin{aligned} & \mathrm{V}_{\text {REF }}=\mathrm{V}_{\text {(REFnP) }} \\ & -\mathrm{V}_{\text {(REFNN }} \\ & (\mathrm{n}=0,1) \text {, or } \\ & \mathrm{V}_{\text {REF }}=\mathrm{V}_{\text {REFOUT }} \end{aligned}$ |
|  | Gain = 1 (PGA enabled) |  | Whichever is greater of the values of $-V_{\text {REF }}$ and $-(\mathrm{AVCCO}-\mathrm{AVSSO}$ $-0.5 \mathrm{~V})$ | - | Whichever is smaller of the values of $+V_{\text {REF }}$ and $+($ AVCCO - AVSSO $-0.5 \mathrm{~V})$ |  |  |
|  | Gain $\geq 2$ |  | - $\mathrm{V}_{\text {REF }} /$ Gain | - | + $\mathrm{V}_{\text {REF }} /$ Gain |  |  |
| Absolute input voltage range | Gain = 1 (PGA disabled, BUF disabled) | V | AVSSO - 0.05 | - | AVCC0 + 0.05 | V |  |
|  | Gain = 1 (PGA disabled, BUF enabled) |  | AVSS0 + 0.1 | - | AVCCO - 0.1 |  |  |
|  | Gain = 1 to 128 <br> (PGA enabled) |  | AVSS0-0.05 | - | AVCCO + 0.05 |  |  |
| Input bias current | Gain = 1 to 128 (PGA enabled) | $\mathrm{I}_{\mathrm{B}}$ | - | $\pm 5$ | $\pm 25$ | nA | Figure 2.96$\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ |
|  | Gain = 1 (PGA disabled, BUF disabled), OPCR.DSADLVM = 0 |  | - | $\pm 1$ | $\pm 5$ |  |  |
|  | Gain = 1 (PGA disabled, BUF enabled) |  | - | $\pm 1$ | $\pm 5$ |  |  |
|  | Gain = 1 (PGA disabled, BUF disabled), OPCR.DSADLVM = 1 |  | - | $\pm 1.5$ | $\pm 3.0$ | $\mu \mathrm{A}$ |  |
| Input offset current | Gain = 1 to 128 <br> (PGA enabled) | $\mathrm{I}_{10}$ | - | $\pm 3$ | $\pm 10$ | nA | Figure 2.97$\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ |
|  | Gain = 1 (PGA disabled, BUF enabled) |  | - | $\pm 0.5$ | $\pm 2.0$ |  |  |
|  | Gain = 1 (PGA disabled, BUF disabled) |  | - | 5 | 10 | $\mu \mathrm{A} / \mathrm{V}$ |  |
| Input bias current drift | Gain = 1 to 16 <br> (PGA enabled) | $\mathrm{dl}_{1 \mathrm{~B}}$ | - | 50 | 180 | $\mathrm{pA} /{ }^{\circ} \mathrm{C}$ |  |
|  | Gain $=32$ to 128 |  | - | 70 | 200 |  |  |
|  | Gain = 1 (PGA disabled, BUF enabled) |  | - | 50 | 100 |  |  |
|  | Gain = 1 (PGA disabled, BUF disabled), <br> OPCR.DSADLVM = 0 |  | - | 50 | 100 |  |  |
|  | Gain = 1 (PGA disabled, BUF disabled), <br> OPCR.DSADLVM = 1 |  | - | 300 | 500 |  |  |
| Input offset current drift | Gain = 1 to 128 (PGA enabled) | $\mathrm{dl}_{1 \mathrm{O}}$ | - | 50 | 200 | $\mathrm{pA} /{ }^{\circ} \mathrm{C}$ |  |
|  | Gain = 1 (PGA disabled, BUF enabled) |  | - | 45 | 80 |  |  |
|  | Gain = 1 (PGA disabled, BUF disabled) |  | - | 170 | 350 | $\mathrm{pA} / \mathrm{V} /{ }^{\circ} \mathrm{C}$ |  |



Figure 2.75 Noise Histogram (AVCC0 $=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=$ $25^{\circ} \mathrm{C}$, Normal Mode, Gain $=128, \mathrm{f}_{\mathrm{DR}}=7.6$ $\mathrm{SPS}, \mathrm{V}_{\mathrm{ID}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=2.5 \mathrm{~V}$ )


Figure 2.77 Noise Histogram (AVCCO = 5.0 V, T ${ }_{\mathrm{a}}=$ $25^{\circ} \mathrm{C}$, Normal Mode, Gain $=16, \mathrm{f}_{\mathrm{DR}}=7.6$ SPS, $\mathrm{V}_{\mathrm{ID}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=2.5 \mathrm{~V}$ )


Figure 2.79 Noise Histogram (AVCCO = $5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=$ $25^{\circ} \mathrm{C}$, Normal Mode, Gain = 1 (PGA disabled, BUF disabled), $\mathrm{f}_{\mathrm{DR}}=7.6 \mathrm{SPS}$, $\mathrm{V}_{\mathrm{ID}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=2.5 \mathrm{~V}$ )


Figure 2.76 Plot of Noise (AVCCO $=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$, Normal Mode, Gain $=128, \mathrm{f}_{\mathrm{DR}}=7.6$ SPS, $\mathrm{V}_{\mathrm{ID}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=2.5 \mathrm{~V}$ )


Figure 2.78 Plot of Noise (AVCCO $=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$, Normal Mode, Gain $=16, \mathrm{f}_{\mathrm{DR}}=7.6$ SPS,
$\mathrm{V}_{\mathrm{ID}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=2.5 \mathrm{~V}$ )


Figure 2.80 Plot of Noise (AVCCO $=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$, Normal Mode, Gain = 1 (PGA disabled, BUF disabled), $\mathrm{f}_{\mathrm{DR}}=7.6 \mathrm{SPS}, \mathrm{V}_{\mathrm{ID}}=0 \mathrm{~V}$,
$\mathrm{V}_{\text {REF }}=2.5 \mathrm{~V}$ )


Figure 2.81 Noise Histogram (AVCC0 $=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=$ $25^{\circ} \mathrm{C}$, Low Power Mode, Gain = 128, $\mathrm{f}_{\mathrm{DR}}=$ 1.9 SPS, $\mathrm{V}_{\mathrm{ID}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=2.5 \mathrm{~V}$ )


Figure 2.83 Noise Histogram (AVCC0 $=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=$ $25^{\circ} \mathrm{C}$, Low Power Mode, Gain $=16, \mathrm{f}_{\mathrm{DR}}=$ 1.9 SPS, $\mathrm{V}_{\mathrm{ID}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=2.5 \mathrm{~V}$ )


Figure 2.85 Noise Histogram (AVCC0 $=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=$ $25^{\circ} \mathrm{C}$, Low Power Mode, Gain = 1 (PGA disabled, BUF disabled), $\mathrm{f}_{\mathrm{DR}}=1.9 \mathrm{SPS}$, $\mathrm{V}_{\mathrm{ID}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=2.5 \mathrm{~V}$ )


Figure 2.82 Plot of Noise (AVCCO $=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$, Low Power Mode, Gain =128, $\mathrm{f}_{\mathrm{DR}}=1.9$ SPS, $\mathrm{V}_{\mathrm{ID}}=0 \mathrm{~V}, \mathrm{~V}_{\text {REF }}=2.5 \mathrm{~V}$ )


Figure 2.84 Plot of Noise (AVCCO $=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$, Low Power Mode, Gain = 16, $\mathrm{f}_{\mathrm{DR}}=1.9$ SPS, $\mathrm{V}_{\mathrm{ID}}=0 \mathrm{~V}, \mathrm{~V}_{\text {REF }}=2.5 \mathrm{~V}$ )


Figure 2.86 Plot of Noise (AVCCO $=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$, Low Power Mode, Gain = 1 (PGA disabled, BUF disabled), $\mathrm{f}_{\mathrm{DR}}=1.9 \mathrm{SPS}$, $\mathrm{V}_{\mathrm{ID}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=2.5 \mathrm{~V}$ )


Figure 2.87 Data Rate Dependence of RMS Noise (AVCCO $=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$, Normal Mode, $\mathrm{V}_{\mathrm{ID}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=2.5 \mathrm{~V}$ )


Figure 2.89 Data Rate Dependence of RMS Noise (AVCCO $=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$, Low Power Mode, $\mathrm{V}_{\mathrm{ID}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=2.5 \mathrm{~V}$ )


Figure 2.91 Input Voltage Dependence of RMS Noise (AVCCO $=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$, Normal Mode, $\mathrm{f}_{\mathrm{DR}}=122 \mathrm{SPS}, \mathrm{V}_{\mathrm{REF}}=2.5 \mathrm{~V}$ )


Figure 2.88 Data Rate Dependence of Effective Resolution (AVCCO $=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$, Normal Mode, $\mathrm{V}_{\mathrm{ID}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=2.5 \mathrm{~V}$ )


Figure 2.90 Data Rate Dependence of Effective Resolution (AVCCO $=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$, Low Power Mode, $\mathrm{V}_{\mathrm{ID}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=2.5 \mathrm{~V}$ )


Figure 2.92 Input Voltage Dependence of Integral Non-Linearity (AVCC0 $=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$, Normal Mode, Gain $=2$, OPCR.DSADLVM bit $=0, \mathrm{~V}_{\text {REF }}=2.5 \mathrm{~V}$ )


Figure 2.94 Temperature Dependence of Offset Error (AVCCO $=5.0 \mathrm{~V}, \mathrm{~V}_{\mathrm{ID}}=0 \mathrm{~V}, \mathrm{~V}_{\mathrm{REF}}=$ 2.5V)


Figure 2.96 Temperature Dependence of Analog Input Bias Current (AVCC0 = 5.0 V)


Figure 2.93 Input Voltage Dependence of Integral Non-Linearity (AVCC0 $=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$, Normal Mode, Gain = 1 (PGA disabled, BUF disabled), OPCR.DSADLVM bit $=0$, $\mathrm{V}_{\text {REF }}=2.5 \mathrm{~V}$ )


Figure 2.95 Temperature Dependence of Gain Error (AVCC0 $=5.0 \mathrm{~V}, \mathrm{OPCR} . \mathrm{DSADLVM}$ bit $=0$, $\mathrm{V}_{\mathrm{REF}}=2.5 \mathrm{~V}$ )


Figure 2.97 Temperature Dependence of Analog Input Offset Current (AVCCO = 5.0 V)

### 2.10 Analog Front End Characteristics

Table 2.58 Voltage Reference Characteristics
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC} \leq 5.5 \mathrm{~V}, 2.7 \mathrm{~V} \leq \mathrm{AVCCO} \leq 5.5 \mathrm{~V}$, $\mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output voltage | $\mathrm{V}_{\text {REFOUT }}$ | - | 2.5 | - | V | Figure 2.98 |
| Initial accuracy | - | - | - | $\pm 0.1$ | \% | Figure 2.99 $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ |
| Temperature drift | - | - | 4 | 10 | ppm $/{ }^{\circ} \mathrm{C}$ | $\mathrm{T}_{\mathrm{a}}=-40$ to $+85^{\circ} \mathrm{C}$ |
|  |  | - | 5 | 12 |  | $\mathrm{T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$ |
| Load current | $\mathrm{I}_{\mathrm{L}}$ | - | - | $\pm 10$ | mA |  |
| Load regulation | - | - | -35 | -50 | $\mu \mathrm{V} / \mathrm{mA}$ | $\begin{aligned} & \text { Figure } 2.100 \\ & \mathrm{I}_{\mathrm{L}}=0 \text { to }+10 \mathrm{~mA} \end{aligned}$ |
|  |  | - | 250 | 400 |  | $\mathrm{I}_{\mathrm{L}}=-10$ to 0 mA |
| Power supply rejection ratio | PSRR | 70 | 80 | - | dB | DC |

Table 2.59 Bias Voltage Generator Characteristics
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC} \leq 5.5 \mathrm{~V}, 2.7 \mathrm{~V} \leq \mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item | Symbol | Min. | Map. | Unit | Test <br> Conditions |  |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Output voltage | $\mathrm{V}_{\text {BIAS }}$ | (AVCC0 + AVSSO)/2 <br> -0.02 | (AVCC0 + AVSSO)/2 | $(\mathrm{AVCC0}+\mathrm{AVSSO}) / 2$ <br> +0.02 | V |  |
| Startup time | $\mathrm{t}_{\text {START }}$ | - | - | 20 | $\mu \mathrm{~s} / \mathrm{nF}$ |  |

Table 2.60 Temperature Sensor Characteristics
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC} \leq 5.5 \mathrm{~V}, 2.7 \mathrm{~V} \leq \mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Accuracy |  | - | - | - | $\pm 5$ | ${ }^{\circ} \mathrm{C}$ | Figure 2.101 |
| Voltage sensitivity coefficient | Second-order | TC ${ }_{\text {SNS }}$ | - | $-6.2 \times 10^{-13}$ | - | ${ }^{\circ} \mathrm{C} / \mathrm{LSB}{ }^{2}$ |  |
|  | First-order |  | - | $7.5 \times 10^{-5}$ | - | ${ }^{\circ} \mathrm{C} / \mathrm{LSB}$ |  |
| Output code |  | - | - | $\begin{aligned} & \text { 3D4F50h } \\ & \text { (4018000) } \end{aligned}$ | - | - |  |

Table 2.61 Excitation Current Source Characteristics
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC} \leq 5.5 \mathrm{~V}, 2.7 \mathrm{~V} \leq \mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output current | 2 channels mode | IEXC | 50, 100, 250, 500, 750, 1000 |  |  | $\mu \mathrm{A}$ | Figure 2.102 |
|  | 4 channels mode |  | 50, 100, 250, 500 |  |  |  |  |
| Initial accuracy |  | - | - | $\pm 1$ | $\pm 5$ | \% | Figure 2.103 $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ |
| Temperature drift |  | - | - | 25 | 60 | $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ |  |
| Current matching |  | - | - | $\pm 0.2$ | $\pm 2.0$ | \% | Figure 2.104, Figure 2.105 $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ |
| Drift matching |  | - | - | 5 | 30 | $\mathrm{ppm} /{ }^{\circ} \mathrm{C}$ | Matching between IEXC0 and IEXC1 Matching between IEXC2 and IEXC3 |
| Line regulation |  | - | - | 0.05 | 0.30 | \%/V |  |
| Load regulation |  | - | - | 0.1 | 0.5 | \%/V |  |
| Compliance voltage |  | $\mathrm{V}_{\text {COMP }}$ | AVSSO - 0.05 | - | AVCCO - 0.5 | V | Figure 2.106 <br> Output current error = $-2.0 \%$ |

Table 2.62 External Reference Input Characteristics
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC} \leq 5.5 \mathrm{~V}, 2.7 \mathrm{~V} \leq \mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Differential input voltage range |  | $V_{\text {REF }}$ | 1 | 2.5 | AVCCO | V | $\mathrm{V}_{\text {REF }}$ |
| Absolute input voltage range | Reference buffer disabled | $V_{\text {(REFOP) }}$, <br> $V_{\text {(REF1P), }}$ <br> $V_{\text {(REFON) }}$, <br> $V_{\text {(REF1N) }}$ | AVSS0 - 0.05 | - | AVCCO + 0.05 | V |  |
|  | Reference buffer enabled |  | AVSS0 + 0.1 | - | AVCC0 - 0.1 |  |  |
| Input current | Reference buffer disabled | $\mathrm{I}_{\mathrm{b}}$ | - | 7 | 15 | $\mu \mathrm{A} / \mathrm{V}$ | Figure 2.107 $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ |
|  | Reference buffer enabled |  | - | $\pm 1$ | $\pm 3$ | nA | Figure 2.108 $\mathrm{T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ |
| Input current drift | Reference buffer disabled | $\mathrm{dl}_{\mathrm{b}}$ | - | 0.8 | 1.5 | $n \mathrm{~A} / \mathrm{V} /{ }^{\circ} \mathrm{C}$ | $\mathrm{T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$ |
|  | Reference buffer enabled |  | - | 18 | 60 | $\mathrm{pA} /{ }^{\circ} \mathrm{C}$ | $\mathrm{T}_{\mathrm{a}}=-40$ to $+85^{\circ} \mathrm{C}$ |
|  |  |  | - | 30 | 150 | $\mathrm{pA} /{ }^{\circ} \mathrm{C}$ | $\mathrm{T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$ |
| Common mode rejection ratio | Reference buffer disabled | CMRR | 70 | 90 | - | dB |  |
|  | Reference buffer enabled |  | 70 | 80 | - |  |  |

Table 2.63 Low Side Switch Characteristics
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC} \leq 5.5 \mathrm{~V}, 2.7 \mathrm{~V} \leq \mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| On-state resistance | $\mathrm{R}_{\mathrm{ON}}$ | - | - | 10 | $\Omega$ |  |
| Off-state leakage current | $\mathrm{I}_{\mathrm{Ikg}}$ | - | - | 0.1 | $\mu \mathrm{~A}$ |  |
| Allowable current | $\mathrm{I}_{\text {LIMIT }}$ | - | - | 30 | mA |  |

Table 2.64 Low Power-Supply Voltage Detector Characteristics
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC} \leq 5.5 \mathrm{~V}, 2.7 \mathrm{~V} \leq \mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item |  | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Detection voltage (LVDETO) | DETOLVL $=0$ | $\mathrm{V}_{\text {DETO }}$ | 1.88 | 2.00 | 2.12 | V | Negative-going AVCCO |
|  | DETOLVL = 1 |  | 1.74 | 1.86 | 1.98 |  |  |
| Non-responsive period (LVDETO) |  | $\mathrm{t}_{\text {DETO }}$ | - | - | 20 | $\mu \mathrm{s}$ |  |
| Detection voltage (LVDET1) | DET1LVL[1:0] = 00b | $\mathrm{V}_{\text {DET1 }}$ | 2.75 | 2.91 | 3.07 | V | Negative-going AVCCO |
|  | DET1LVL[1:0] = 01b |  | 2.65 | 2.82 | 2.99 |  |  |
|  | DET1LVL[1:0] = 10b |  | 3.60 | 3.80 | 4.00 |  |  |
|  | DET1LVL[1:0] = 11b |  | 3.50 | 3.70 | 3.90 |  |  |
| Non-responsive period (LVDET1) |  | $\mathrm{t}_{\text {DET1 }}$ | - | - | 20 | $\mu \mathrm{s}$ |  |

Table 2.65 Input Voltage Fault Detector Characteristics
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC} \leq 5.5 \mathrm{~V}, 2.7 \mathrm{~V} \leq \mathrm{AVCCO} \leq 5.5 \mathrm{~V}$, $\mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Upper detection level for the analog <br> input voltage | $\mathrm{V}_{\text {IDETH }}$ | AVCC0 +0.05 | AVCC0 + 0.2 | - | V |  |
| Lower detection level for the analog <br> input voltage | $\mathrm{V}_{\text {IDETL }}$ | - | AVSS0 -0.2 | AVSSO -0.05 | V |  |
| Non-responsive period | $\mathrm{t}_{\text {IDET }}$ | - | - | 20 | $\mu \mathrm{~S}$ |  |

Table 2.66 Reference Voltage Fault Detector Characteristics
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC} \leq 5.5 \mathrm{~V}, 2.7 \mathrm{~V} \leq \mathrm{AVCCO} \leq 5.5 \mathrm{~V}, \mathrm{VSS}=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Detection level for external reference <br> voltage differential | $\mathrm{V}_{\text {RDET }}$ | 0.70 | 0.85 | 1.00 | V |  |
| Upper detection level for the external <br> reference voltage | $\mathrm{V}_{\text {RDETH }}$ | $\mathrm{AVCC0}-0.5$ | $\mathrm{AVCC0}-0.4$ | - | V |  |
| Lower detection level for the external <br> reference voltage | $\mathrm{V}_{\text {RDETL }}$ | - | $\mathrm{AVSSO}+0.4$ | $\mathrm{AVSS} 0+0.5$ | V |  |
| Non-responsive period | $\mathrm{t}_{\text {RDET }}$ | - | - | 20 | $\mu \mathrm{~s}$ |  |

Table 2.67 Excitation Current Source Disconnect Detector Characteristics
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC} \leq 5.5 \mathrm{~V}, 2.7 \mathrm{~V} \leq \mathrm{AVCCO} \leq 5.5 \mathrm{~V}$, VSS $=\mathrm{AVSSO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$

| Item | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: | :---: |
| Detection level for disconnection of the <br> excitation current source | $\mathrm{V}_{\text {IEXCDET }}$ | AVCC0 -0.18 | $\mathrm{AVCC0}-0.06$ | - | V |  |
| Non-responsive period | $\mathrm{t}_{\text {IEXCDET }}$ | - | - | 20 | $\mu \mathrm{~s}$ |  |



Figure 2.98 Temperature Dependence of Output Voltage of Voltage Reference ( $\mathrm{AVCCO}=5.0 \mathrm{~V}$ )


Figure 2.100 Load Regulation of Voltage Reference ( $\mathrm{AVCCO}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ )


Figure 2.102 Temperature Dependence of Output Current of Excitation Current Source ( $\mathrm{AVCCO}=5.0 \mathrm{~V}$ )


Figure 2.99 Initial Accuracy of Voltage Reference (AVCCO = $5.0 \mathrm{~V}, 30$ samples)


Figure 2.101 Accuracy of Temperature Sensor ( $\mathrm{AVCCO}=5.0 \mathrm{~V}$ )


Figure 2.103 Initial Accuracy of Output Current of Excitation Current Source
(AVCCO $=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C}, \mathrm{IEXC}=250$
$\mu \mathrm{A}, 93$ samples)


Figure 2.104 Matching of Output Current of Excitation Current Source (AVCCO =5.0 V, $\mathrm{T}_{\mathrm{a}}=$ $25^{\circ} \mathrm{C}$, IEXC $=250 \mu \mathrm{~A}, 93$ samples)


Figure 2.106 IEXC Accuracy vs Compliance Voltage ( $\mathrm{AVCCO}=5.0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=25^{\circ} \mathrm{C}$ )


Figure 2.107 Temperature Dependence of External Reference Input Current (AVCC0 = 5.0 V , Reference Buffer Disabled)


Figure 2.105 Temperature Dependence of Matching of Output Current of Excitation Current Source (AVCCO = 5.0 V)


Figure 2.108 Temperature Dependence of External Reference Input Current (AVCC0 = 5.0 V, Reference Buffer Enabled)

### 2.11 12-Bit A/D Conversion Characteristics



Figure 2.109 AVCCO to VREFH0 Voltage Range

Table 2.68 12-Bit A/D Conversion Characteristics (1)
Conditions: $2.7 \mathrm{~V} \leq \mathrm{VCC} \leq 5.5 \mathrm{~V}, 2.7 \mathrm{~V} \leq \mathrm{AVCCO} \leq 5.5 \mathrm{~V}, 2.7 \mathrm{~V} \leq \mathrm{VREFH} 0 \leq \mathrm{AVCCO}$, Reference voltage $=\mathrm{VREFH}$, $\mathrm{VSS}=\mathrm{AVSSO}=\mathrm{VREFLO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$, Source impedance $=0.3 \mathrm{k} \Omega$

| Item | Min. | Typ. | Max. | Unit | Test Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: |
| Frequency | 1 | - | 32 | MHz |  |
| Resolution | - | - | 12 | Bit |  |
| Conversion time*1 <br> (Operation at PCLKD $=32 \mathrm{MHz})$ | 1.41 | - | - | $\mu \mathrm{s}$ | ADCSR.ADHSC bit $=0$ <br> ADSSTRn $=0 \mathrm{Dh}$ |
| Analog input capacitance | Cs | - | - | 25 | pF |
| Analog input resistance | Rs | - | - | 2.5 | $\mathrm{k} \Omega$ |
| Analog input effective range | 0 | - | VREFHO | V |  |
| Offset error | - | $\pm 0.5$ | $\pm 4.5$ | LSB |  |
| Full-scale error | - | $\pm 0.75$ | $\pm 4.50$ | LSB |  |
| Quantization error | - | $\pm 0.5$ | - | LSB |  |
| Absolute accuracy | - | $\pm 1.25$ | $\pm 5.00$ | LSB |  |
| DNL differential nonlinearity error | - | $\pm 1.0$ | - | LSB |  |
| INL integral nonlinearity error | - | $\pm 1.0$ | $\pm 3.0$ | LSB |  |

Note: The characteristics apply when no pin functions other than A/D converter input are used. Absolute accuracy includes quantization errors. Offset error, full-scale error, DNL differential nonlinearity error, and INL integral nonlinearity error do not include quantization errors.
Note 1. The conversion time is the sum of the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Table 2.69 12-Bit A/D Conversion Characteristics (2)
Conditions: $2.4 \mathrm{~V} \leq \mathrm{VCC} \leq 5.5 \mathrm{~V}, 2.4 \mathrm{~V} \leq \mathrm{AVCCO} \leq 5.5 \mathrm{~V}, 2.4 \mathrm{~V} \leq \mathrm{VREFHO} \leq \mathrm{AVCCO}$, Reference voltage $=\mathrm{VREFH} 0$, $\mathrm{VSS}=\mathrm{AVSSO}=\mathrm{VREFLO}=0 \mathrm{~V}, \mathrm{~T}_{\mathrm{a}}=-40$ to $+105^{\circ} \mathrm{C}$, Source impedance $=1.3 \mathrm{k} \Omega$

| Item | Min. | Typ. | Max. | Unit | Test Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: |
| Frequency | 1 | - | 16 | MHz |  |
| Resolution | - | - | 12 | Bit |  |
| Conversion time*1 <br> (Operation at PCLKD $=16 \mathrm{MHz})$ | 2.82 | - | - | $\mu \mathrm{S}$ | ADCSR.ADHSC bit $=0$ <br> ADSSTRn $=0 \mathrm{Dh}$ |
| Analog input <br> capacitance | Cs | - | - | 25 | pF |
| Analog input <br> resistance | Rs capacitance included |  |  |  |  |
| Analog input effective range | - | - | 2.5 | kS |  |
| Offset error | - | - | VREFH0 | V |  |
| Full-scale error | - | $\pm 0.75$ | $\pm 4.50$ | LSB |  |
| Quantization error | - | $\pm 0.5$ | - | LSB |  |
| Absolute accuracy | - | $\pm 1.25$ | $\pm 5.00$ | LSB |  |
| DNL differential nonlinearity error | - | $\pm 1.0$ | - | LSB |  |
| INL integral nonlinearity error | - | $\pm 1.0$ | $\pm 4.5$ | LSB |  |

Note: The characteristics apply when no pin functions other than A/D converter input are used. Absolute accuracy includes quantization errors. Offset error, full-scale error, DNL differential nonlinearity error, and INL integral nonlinearity error do not include quantization errors.
Note 1. The conversion time is the sum of the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Table 2.70 12-Bit A/D Conversion Characteristics (3)
Conditions: $2.7 \mathrm{~V} \leq \mathrm{VCC} \leq 5.5 \mathrm{~V}, 2.7 \mathrm{~V} \leq \mathrm{AVCCO} \leq 5.5 \mathrm{~V}, 2.7 \mathrm{~V} \leq \mathrm{VREFHO} \leq \mathrm{AVCCO}$, Reference voltage $=\mathrm{VREFH} 0$, $\mathrm{VSS}=\mathrm{AVSSO}=\mathrm{VREFLO}=0 \mathrm{~V}, \mathrm{Ta}=-40$ to $+105^{\circ} \mathrm{C}$, Source impedance $=1.1 \mathrm{k} \Omega$

| Item | Min. | Typ. | Max. | Unit | Test Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: |
| Frequency | 1 | - | 27 | MHz |  |
| Resolution | - | - | 12 | Bit |  |
| Conversion time*1 <br> (Operation at PCLKD $=27 \mathrm{MHz}$ ) | Cs | - | - | $\mu \mathrm{s}$ | ADCSR.ADHSC bit $=1$ <br> ADSSTRn $=28 \mathrm{~h}$ |
| Analog input <br> capacitance | Rs | - | - | 25 | pF |
| Analog input <br> resistance | - | - | 2.5 | $\mathrm{k} \Omega$ |  |
| Analog input effective range | 0 | - | VREFH0 | V |  |
| Offset error | - | $\pm 0.5$ | $\pm 4.5$ | LSB |  |
| Full-scale error | - | $\pm 0.75$ | $\pm 4.50$ | LSB |  |
| Quantization error | - | $\pm 0.5$ | - | LSB |  |
| Absolute accuracy | - | $\pm 1.25$ | $\pm 5.00$ | LSB |  |
| DNL differential nonlinearity error | - | $\pm 1.0$ | - | LSB |  |
| INL integral nonlinearity error | - | $\pm 1.0$ | $\pm 3.0$ | LSB |  |

Note: The characteristics apply when no pin functions other than A/D converter input are used. Absolute accuracy includes quantization errors. Offset error, full-scale error, DNL differential nonlinearity error, and INL integral nonlinearity error do not include quantization errors.
Note 1. The conversion time is the sum of the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Table 2.71 12-Bit A/D Conversion Characteristics (4)
Conditions: $2.4 \mathrm{~V} \leq \mathrm{VCC} \leq 5.5 \mathrm{~V}, 2.4 \mathrm{~V} \leq \mathrm{AVCCO} \leq 5.5 \mathrm{~V}, 2.4 \mathrm{~V} \leq \mathrm{VREFHO} \leq \mathrm{AVCCO}$, Reference voltage $=\mathrm{VREFHO}$, $\mathrm{VSS}=\mathrm{AVSSO}=\mathrm{VREFLO}=0 \mathrm{~V}, \mathrm{Ta}=-40$ to $+105^{\circ} \mathrm{C}$, Source impedance $=2.2 \mathrm{k} \Omega$

| Item | Min. | Typ. | Max. | Unit | Test Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: |
| Frequency | 1 | - | 16 | MHz |  |
| Resolution | - | - | 12 | Bit |  |
| Conversion time*1 <br> (Operation at PCLKD $=16 \mathrm{MHz})$ | 5.06 | - | - | $\mu \mathrm{S}$ | ADCSR.ADHSC bit $=1$ <br> ADSSTRn $=28 \mathrm{~h}$ |
| Analog input <br> capacitance | Cs | - | - | 25 | pF |
| Analog input <br> resistance | Rs capacitance included |  |  |  |  |
| Analog input effective range | - | - | 2.5 | kS |  |
| Offset error | - | - | VREFH0 | V |  |
| Full-scale error | - | $\pm 0.5$ | $\pm 4.5$ | LSB |  |
| Quantization error | - | $\pm 0.5$ | - | LSB |  |
| Absolute accuracy | - | $\pm 1.25$ | $\pm 5.00$ | LSB |  |
| DNL differential nonlinearity error | - | $\pm 1.0$ | - | LSB |  |
| INL integral nonlinearity error | - | $\pm 1.0$ | $\pm 3.0$ | LSB |  |

Note: The characteristics apply when no pin functions other than A/D converter input are used. Absolute accuracy includes quantization errors. Offset error, full-scale error, DNL differential nonlinearity error, and INL integral nonlinearity error do not include quantization errors.
Note 1. The conversion time is the sum of the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated

Table 2.72 12-Bit A/D Conversion Characteristics (5)
Conditions: $1.8 \mathrm{~V} \leq \mathrm{VCC} \leq 5.5 \mathrm{~V}, 1.8 \mathrm{~V} \leq \mathrm{AVCCO} \leq 5.5 \mathrm{~V}, 1.8 \mathrm{~V} \leq \mathrm{VREFHO} \leq \mathrm{AVCCO}$, Reference voltage $=\mathrm{VREFHO}$, $\mathrm{VSS}=\mathrm{AVSSO}=\mathrm{VREFLO}=0 \mathrm{~V}, \mathrm{Ta}=-40$ to $+105^{\circ} \mathrm{C}$, Source impedance $=5 \mathrm{k} \Omega$

| Item | Min. | Typ. | Max. | Unit | Test Conditions |
| :--- | :---: | :---: | :---: | :---: | :---: |
| Frequency | 1 | - | 8 | MHz |  |
| Resolution | - | - | 12 | Bit |  |
| Conversion time*1 <br> (Operation at PCLKD $=8 \mathrm{MHz}$ ) | 10.13 | - | - | $\mu \mathrm{s}$ | ADCSR.ADHSC bit $=1$ <br> ADSSTRn $=28 \mathrm{~h}$ |
| Analog input <br> capacitance | Cs | - | - | 25 | pF |
| Analog input <br> resistance | Rs capacitance included |  |  |  |  |
| Analog input effective range | - | - | 2.5 | $\mathrm{k} \Omega$ |  |
| Offset error | - | - | $\pm 1.0$ | $\pm 7.5$ | LSB |
| Full-scale error | - | $\pm 1.5$ | $\pm 7.5$ | LSB |  |
| Quantization error | - | $\pm 0.5$ | - | LSB |  |
| Absolute accuracy | - | $\pm 3.0$ | $\pm 8.0$ | LSB |  |
| DNL differential nonlinearity error | - | $\pm 1.0$ | - | LSB |  |
| INL integral nonlinearity error | - | $\pm 1.25$ | $\pm 3.00$ | LSB |  |

Note: The characteristics apply when no pin functions other than A/D converter input are used. Absolute accuracy includes quantization errors. Offset error, full-scale error, DNL differential nonlinearity error, and INL integral nonlinearity error do not include quantization errors.
Note 1. The conversion time is the sum of the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Table 2.73 12-Bit A/D Converter Channel Classification

| Classification | Channel | Conditions | Remarks |
| :---: | :---: | :---: | :---: |
| Analog input channel | AN000 to AN005 | AVCC0 $=1.8$ to 5.5 V |  |



Figure 2.110 Equivalent Circuit


Figure 2.111 Illustration of A/D Converter Characteristic Terms

## Absolute accuracy

Absolute accuracy is the difference between output code based on the theoretical A/D conversion characteristics, and the actual $\mathrm{A} / \mathrm{D}$ conversion result. When measuring absolute accuracy, the voltage at the midpoint of the width of analog input voltage (1-LSB width), that can meet the expectation of outputting an equal code based on the theoretical A/D conversion characteristics, is used as an analog input voltage. For example, if 12-bit resolution is used and if reference voltage (VREFH0 $=3.072 \mathrm{~V}$ ), then 1-LSB width becomes 0.75 mV , and $0 \mathrm{mV}, 0.75 \mathrm{mV}, 1.5 \mathrm{mV}, \ldots$ are used as analog input voltages.
If analog input voltage is 6 mV , absolute accuracy $= \pm 5 \mathrm{LSB}$ means that the actual $\mathrm{A} / \mathrm{D}$ conversion result is in the range of 003 h to 00 Dh though an output code, 008 h , can be expected from the theoretical A/D conversion characteristics.

## Integral nonlinearity error (INL)

Integral nonlinearity error is the maximum deviation between the ideal line when the measured offset and full-scale errors are zeroed, and the actual output code.

## Differential nonlinearity error (DNL)

Differential nonlinearity error is the difference between 1-LSB width based on the ideal A/D conversion characteristics and the width of the actual output code.

## Offset error

Offset error is the difference between a transition point of the ideal first output code and the actual first output code.

## Full-scale error

Full-scale error is the difference between a transition point of the ideal last output code and the actual last output code.

### 2.12 Usage Notes

### 2.12.1 Connecting VCL Capacitor and Bypass Capacitors

This MCU integrates an internal voltage-down circuit, which is used for lowering the power supply voltage in the internal MCU automatically to the optimum level. A 4.7- $\mu \mathrm{F}$ capacitor needs to be connected between this internal voltage-down power supply (VCL pin) and the VSS pin. Figure 2.112 and Figure 2.113 shows how to connect external capacitors. Place an external capacitor close to the pins. Do not apply the power supply voltage to the VCL pin. Insert a multilayer ceramic capacitor as a bypass capacitor between each pair of the power supply pins. Implement a bypass capacitor as closer to the MCU power supply pins as possible. Use a recommended value of $0.1 \mu \mathrm{~F}$ as the capacitance of the capacitors. For the capacitors related to crystal oscillation, see section 9, Clock Generation Circuit in the User's Manual: Hardware. For the capacitors related to analog modules, also see section 33, Analog Front End (AFE), and section 35, 12-Bit A/D Converter (S12ADE) in the User's Manual: Hardware.
For notes on designing the printed circuit board, see the descriptions of the application note, the Hardware Design Guide (R01AN1411EJ). The latest version can be downloaded from the Renesas Electronics website.


Figure 2.112


Note: Do not apply the power supply voltage to the VCL pin
Use a 4.7- $\mu \mathrm{F}$ multilayer ceramic capacitor for the VCL pin and place it close to the pin A recommended value is shown for the capacitance of the bypass capacitors.

Figure 2.113 Connecting Capacitors (40 Pins)

## Appendix 1. Package Dimensions

Information on the latest version of the package dimensions or mountings has been displayed in "Packages" on Renesas Electronics Corporation website.

| JEITA Package Code | RENESAS Code | Previous Code | MASS[Typ.] |
| :---: | :---: | :---: | :---: |
| P-LFQFP48-7×7-0.50 | PLQP0048KB-B | - | 0.2 g |



Figure A 48-Pin LFQFP (PLQP0048KB-B)

| JEITA Package code | RENESAS code | Previous code | MASS(TYP.)[g] |
| :---: | :---: | :---: | :---: |
| P-HWQFN40-6x6-0.50 | PWQN0040KC-A | P40K8-50-4B4-5 | 0.09 |



| Referance <br> Symbol | Dimension in Millimeters |  |  |
| :---: | :---: | :---: | :---: |
|  | Min | Nom | Max |
| D | 5.95 | 6.00 | 6.05 |
| E | 5.95 | 6.00 | 6.05 |
| A | - | - | 0.80 |
| $\mathrm{~A}_{1}$ | 0.00 | - | - |
| b | 0.18 | 0.25 | 0.30 |
| e | - | 0.50 | - |
| Lp | 0.30 | 0.40 | 0.50 |
| x | - | - | 0.05 |
| y | - | - | 0.05 |
| $\mathrm{Z}_{\mathrm{D}}$ | - | 0.75 | - |
| $\mathrm{Z}_{\mathrm{E}}$ | - | 0.75 | - |
| $\mathrm{c}_{2}$ | 0.15 | 0.20 | 0.25 |
| $\mathrm{D}_{2}$ | - | 4.50 | - |
| $\mathrm{E}_{2}$ | - | 4.50 | - |

Figure B 40-Pin HWQFN (PWQN004OKC-A)

| JEITA Package code | RENESAS code | MASS(TYP.)[g] |
| :---: | :---: | :---: |
| P-HWQFN040-6x6-0.50 | PWQN0040KD-A | 0.08 |



| Reference <br> Symbol | Dimension in Millimeters |  |  |
| :---: | :---: | :---: | :---: |
|  | Min. | Nom. | Max. |
| A | - | - | 0.80 |
| $\mathrm{~A}_{1}$ | 0.00 | 0.02 | 0.05 |
| $\mathrm{~A}_{3}$ | 0.203 REF. |  |  |
| b | 0.18 | 0.25 | 0.30 |
| D | 6.00 BSC |  |  |
| E | 6.00 BSC |  |  |
| e | 0.50 BSC |  |  |
| L | 0.30 | 0.40 | 0.50 |
| K | 0.20 | - | - |
| $\mathrm{D}_{2}$ | 4.45 | 4.50 | 4.55 |
| $\mathrm{E}_{2}$ | 4.45 | 4.50 | 4.55 |
| aaa | 0.15 |  |  |
| bbb | 0.10 |  |  |
| ccc | 0.10 |  |  |
| ddd | 0.05 |  |  |
| eee | 0.08 |  |  |
| fff | 0.10 |  |  |

Figure C $40-$ Pin HWQFN (PWQN004OKD-A)

## REVISION HISTORY RX23E-A Group Datasheet

Classifications

- Items with Technical Update document number: Changes according to the corresponding issued Technical Update - Items without Technical Update document number: Minor changes that do not require Technical Update to be issued

| Rev. | Date | Description |  | Classification |
| :---: | :---: | :---: | :---: | :---: |
|  |  | Page | Summary |  |
| 1.00 | Aug 30, 2019 | - | First edition, issued |  |
| 1.10 | Oct 09, 2020 | 1. Overview |  |  |
|  |  | 7 | Table 1.3 List of Products, changed |  |
|  |  | 8 | Figure 1.1 How to Read the Product Part Number, changed |  |
|  |  | 2. Electrica | haracteristics |  |
|  |  | 51 to 63 | 2.4.5 Timing of On-Chip Peripheral Modules, Layout changed |  |

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## General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.
2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.
3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.
4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.
5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.
6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between $\mathrm{V}_{\text {IL }}$ (Max.) and $\mathrm{V}_{\mathrm{IH}}$ (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between $\mathrm{V}_{\text {IL }}$ (Max.) and $\mathrm{V}_{\text {IH }}$ (Min.).
7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.
8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a systemevaluation test for the given product.

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I/HF PIC32MZ2064DAB288-I/4J ATUC256L4U-AUT R5F56318CDBG\#U0 PIC32MX150F128C-I/TL PIC32MX170F256B-50IML
PIC32MX130F064C-ITL PIC32MX230F064D-IML PIC32MX154F128D-I/PT PIC32MX154F128B-V/SO AT32UC3L0128-AUT
PIC32MX254F128B-I/SO PIC32MX230F128H-I/MR PIC32MX150F128D-50I/TL PIC32MZ1064DAB288-I/4J PIC32MZ1064DAB169-I/HF ATUC64D4-Z1UT AT32UC3A3128S-CTUT ATUC128L3U-Z3UT ATUC64L3U-Z3UT MEC1428-SZ-C1 TMS320F28052FPNQ


[^0]:    Note 1. $\mathrm{t}_{\text {Pcyc }}$ : PCLK cycle

